Toshiba Personal Computer

TECRA R10

Maintenance Manual

First edition September 2008

TOSHIBA CORPORATION

File Number 960-708

[CONFIDENTIAL]

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Toshiba Personal Computer TECRA R10 Maintenance Manual

First edition September 2008

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Preface

This maintenance manual describes how to perform hardware service maintenance for the Toshiba Personal Computer TECRA R10.

The procedures described in this manual are intended to help service technicians isolate faulty Field Replaceable Units (FRUs) and replace them in the field.

SAFETY PRECAUTIONS

Four types of messages are used in this manual to bring important information to your attention. Each of these messages will be italicized and identified as shown below.

DANGER: "Danger" indicates the existence of a hazard that could result in death or serious bodily injury, if the safety instruction is not observed.

WARNING: "Warning" indicates the existence of a hazard that could result in bodily injury, if the safety instruction is not observed.

CAUTION: "Caution" indicates the existence of a hazard that could result in property damage, if the safety instruction is not observed.

NOTE: "Note" contains general information that relates to your safe maintenance service.

Improper repair of the computer may result in safety hazards. Toshiba requires service technicians and authorized dealers or service providers to ensure the following safety precautions are adhered to strictly.

- □ Be sure to fasten screws securely with the right screwdriver. If a screw is not fully fastened, it could come loose, creating a danger of a short circuit, which could cause overheating, smoke or fire.
- □ If you replace the battery pack or RTC battery, be sure to use only the same model battery or an equivalent battery recommended by Toshiba. Installation of the wrong battery can cause the battery to explode.

The manual is divided into the following parts:

- Chapter 1 Hardware Overview describes the TECRA R10 system unit and each FRU.
 Chapter 2 Troubleshooting Procedures explains how to diagnose and resolve FRU problems.
- Chapter 3 Test and Diagnostics describes how to perform test and diagnostic operations for maintenance service.
- Chapter 4 Replacement Procedures describes the removal and replacement of the FRUs.
- Appendices The appendices describe the following:
 - □ Handling the LCD module
 - □ Board layout
 - **D** Pin assignments
 - □ Keyboard scan/character codes
 - □ Key layout
 - □ Wiring diagrams
 - □ BIOS rewrite procedures
 - □ EC/KBC rewrite procedures
 - **Reliability**

Conventions

This manual uses the following formats to describe, identify, and highlight terms and operating procedures.

Acronyms

On the first appearance and whenever necessary for clarification acronyms are enclosed in parentheses following their definition. For example:

Read Only Memory (ROM)

Keys

Keys are used in the text to describe many operations. The key top symbol as it appears on the keyboard is printed in **boldface** type.

Key operation

Some operations require you to simultaneously use two or more keys. We identify such operations by the key top symbols separated by a plus (+) sign. For example, **Ctrl + Pause (Break)** means you must hold down **Ctrl** and at the same time press **Pause (Break)**. If three keys are used, hold down the first two and at the same time press the third.

User input

Text that you are instructed to type in is shown in the boldface type below:

DISKCOPY A: B:

The display

Text generated by the computer that appears on its display is presented in the type face below:

```
Format complete
System transferred
```

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1.1 Features

The Toshiba TECRA R10 Personal Computer uses extensive Large Scale Integration (LSI), and Complementary Metal-Oxide Semiconductor (CMOS) technology extensively to provide compact size, minimum weight, low power usage and high reliability. This computer incorporates the following features.

There some models and options. Refer to the Parts List for the configuration of each model and options.

□ Microprocessor

The Toshiba TECRA R10 computer is equipped with an Intel[®] CoreTM 2 Duo Processor. These processors incorporate a math co-processor, a 6MB L2 cache memory.

The PC comes in with one of the following speeds:

Intel[®] CoreTM 2 Duo Processor (Montevina Penryn)

• SP9400(2.40GHz/) /SP9300(2.26GHz)

These processors operate at 1066MHz bus clock (FSB).

□ Memory

Two DDR2-667/DDR2-800 SDRAM slots. Memory modules can be installed to provide a maximum of 4GB. Memory modules are available in 512MB, 1024MB and 2048MB sizes.

□ Chipset

The Toshiba TECRA R10 is Equipped with Intel Cantiga GS as North Bridge, Intel ICH9M-E(SFF) as South Bridge and R5C833 as Card Controller.

□ VGA Controller

The PC comes in with one of the following two types:

- The internal graphics controller in North Bridge is used.
- nVIDIA NB9M-NE is used.

□ HDD

The computer has a 2.5-inch SATA HDD. The following capacities are available.

• 80/120/160/200/250/320GB

SSD

Some models are equipped with a "Solid State Drive (SSD)" instead of a hard disk drive.

• 64GB,128GB

USB FDD

A 3.5-inch USB FDD accommodates 2HD (1.44MB) or 2DD (720KB) disks.

Optical Drive

A DVD Super Multi drive (double layer) can be installed.

Display

The PC comes in with one of the following two types:

- 14.1" WXGA-TFT color display, resolution 1,280×800
- 14.1" WXGA+TFT color display, resolution 1,440×900

Interface

To external monitor via - RGB connector

□ Keyboard

An-easy-to-use 85(US)/87(UK)-key keyboard provides a numeric keypad overlay for fast numeric data entry or for cursor and page control. The keyboard also includes two keys that have special functions in Microsoft[®] Windows[®] Vista. It supports software that uses a 101- or 102-key enhanced keyboard.

□ Touch pad

A Touch Pad and control buttons in the palm rest enable control of the on-screen pointer and scrolling of windows.

Batteries

The computer has two batteries: a rechargeable Lithium-Ion main battery pack and RTC battery (that backs up the Real Time Clock and CMOS memory.

□ Universal Serial Bus (USB2.0)

Two USB ports are provided. The ports comply with the USB2.0 standard, which enables data transfer speeds 40 times faster than USB1.1 standard. USB1.1 is also supported.

□ eSATA/USB combo

One eSATA/USB combo port, which complies to. The USB 2.0 standard is provided. This port has eSATA (External Serial ATA) function. A power supply is always supplied to one USB ports on the left side of a computer.

External monitor (RGB) port

The port enables connection of an external monitor, which is recognized automatically by Video Electronics Standards Association (VESA) Display Data Channel (DDC) 2B compatible functions.

□ ExpressCard slot

The internal ExpressCard slot is a Universal slot. This slot supports ExpressCard/54 and ExpressCard/34 modules.

□ SD/ SDHC memory card slot

One SD/ SDHC memory card slot. Data can be read and written by inserting each media to the slot.

□ Smart Card slot

This slot can accommodate a single Smart Card device. Some models are equipped with a Smart Card slot.

□ Fingerprint sensor

The computer is equipped with a fingerprint sensor and fingerprint authentication utility. They enable only person who has registered his/her fingerprint to use the computer.

Docking interface port

The docking interface port enables connection of an optional Express Port Replicator. It provides additional features as follows:

- RJ45 LAN jack
- External monitor port
- DC IN 15V jack
- Security lock slot
- Universal Serial Bus 2.0 port (four)
- DVI port

□ Sound system

The sound system is equipped with the following features:

- Stereo speakers
- Built-in microphone
- Digital volume control
- Stereo headphone jack
- External microphone jack

□ Internal LAN

The computer is equipped with LAN circuits that support Gigabit Ethernet LAN (1000 megabits per second, 1000BASE-T). It also supports Wakeup on LAN (WOL), AMT 4.0, and LED.

□ Wireless LAN

The computer is equipped with PCI-Ex Mini Card type wireless LAN board that supports 802.11 a/b/g or 802.11 a/b/g/n in the PCI-Ex Mini Card slot. This function can be switched on and off by a switch on the computer.

Bluetooth

Depending on the model, the computer is equipped with a dedicated Bluetooth module. This enables a communication to devices that support Bluetooth This Bluetooth Stack is based on the Bluetooth Version 1.1/1.2/2.0+EDR/2.1+EDR specification.

Web Camera

Web Camera Web Camera is a device that allows you to record video or take photographs with your computer.

Enables the transmission of video and use of video chat via the internet using specialized applications.

The effective pixel count for this web camera is 0.3 million (maximum photograph size: 640x480 pixels).

Some models are equipped with a Web Camera.

- 3G: PCI Express Mini Card slot 2.
 The computer (Some models) is equipped with PCI Express Mini Card type 3G card
- **TOSHIBA** Presentation button

This button switches the display between internal display, external display, simultaneous display and multi-monitor display.

D TOSHIBA Assist button

When this button is pressed during power-on, the PC is connected to "Toshiba Assist". When this button is pressed during power-off, the PC is turned on and connected to "Toshiba Assist".

□ Intel Turbo Memory (Robson): (Not used).

The front of the computer is shown in figure 1-1.

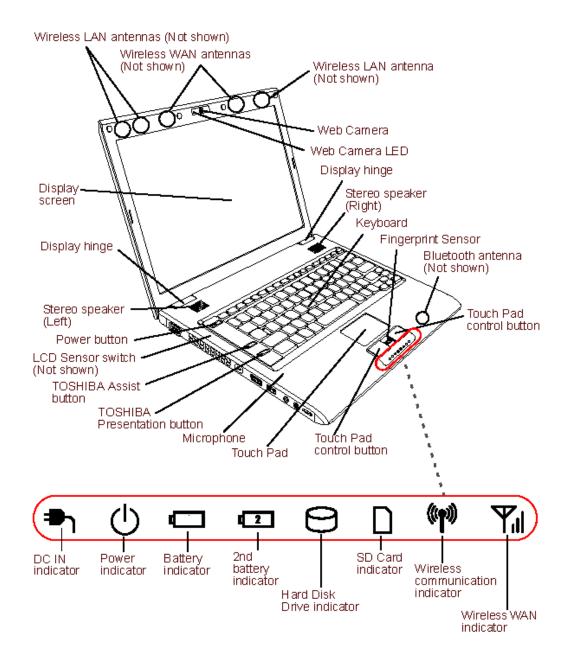
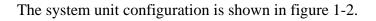


Figure 1-1 Front of the computer



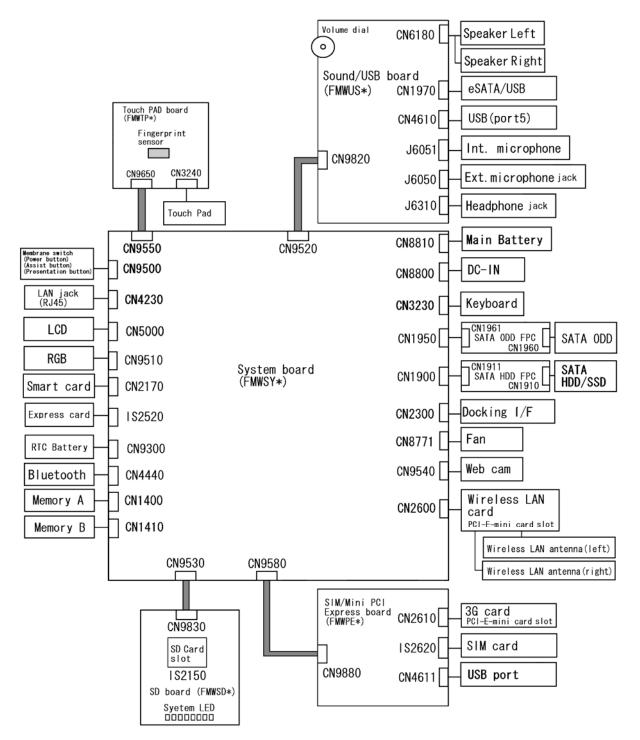
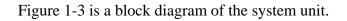


Figure 1-2 System unit configuration

1.2 System Unit Block Diagram



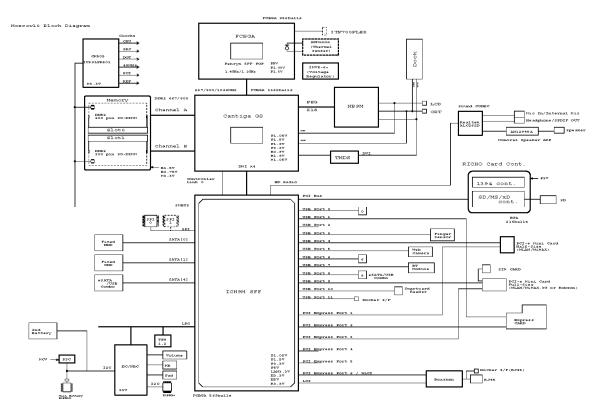


Figure 1-3 System unit block diagram

The system unit is composed of the following major components:

□ Microprocessor

The Toshiba TECRA R10 computer is equipped with an Intel[®] CoreTM 2 Duo Processor. These processors incorporate a math co-processor, a 6MB L2 cache memory.

The PC comes in with one of the following speeds:

Intel[®] CoreTM 2 Duo Processor (Montevina Penryn)

• SP9400(2.40GHz/) /SP9300(2.26GHz)

These processors operate at 1066MHz bus clock (FSB).

□ Memory

Two DDR2-667/DDR2-800 SDRAM slots. Memory modules can be installed to provide a maximum of 4GB. Memory modules are available in 512MB, 1024MB and 2048MB sizes.

- 200-pin small-size DIMM

- 1.8V operation
- DDR2-667/800 support
- BIOS ROM (Flash memory)
 - 8Mbit (512K×16-bit chip)

301KB used for Animation

288KB used for system BIOS

64KB used for VGA-BIOS

64KB used for Finger Print

32KB used for ACPI

24KB used for booting

16KB used for Parameter Block

Others

• North Bridge Intel Cantiga GS

Meorom Processor System Bus Supports

PCI Express Based Graphics Interface

System Memory supports :DDR2-667 / DDR2-800, 4GB max.

DMI(Direct Media Interface: x4/x2, ASPM L0s, L1 states support)

Power management control (DPST 4.0)

• South Bridge ICH9M-E(SFF)

-PCI Local Bus Specification, Revision 2.3-compliant with support for 33MHz PCI operations

-PCI slots (supports up to 4 Req/Gnt pairs)

-PCI Express (6 PCI Express root ports)

-ACPI 3.0b compliant

-Enhanced DMA Controller, Interrupt Controller, and Timer Functions

-Integrated Serial ATA Host Controller (4 ports)

- -USB host interface with support for 12 USB ports; 6 UHCI host controllers; 2 EHCI high-speed USB 2.0 Host Controller
- -System Management Bus (SMBus) Specification, Version 2.0 with additional support for I2C devices

-Intel High Definition Audio Interface

-Supports Audio Codec '97, Revision 2.3 specification or HD Audio

-Low Pin Count (LPC) interface

-Firmware Hub (FHW) interface support

-Alert On LAN (AOL)

-Support for Intel® AMT 4.0

-Support for Integrated Trusted Port module 1.2

□ Card controller (R5C833)

- - PCI Interface
- - SD/MMC, Memory Stick, xD card Controller

□ VGA Controller

The PC comes in with one of the following two types:

- The internal graphics controller in North Bridge is used.
- nVIDIA NB9M-NE is used.
- □ Sound Controller
 - Realtek ALC262D
 - Amplifier: Mathushita made AN12945A
 - HD Audio
 - Stereo speakers
 - Digital volume control
 - Supports VoIP
 - Stereo headphone jack
 - External microphone jack
 - Built-in microphone
- □ Internal LAN Controller
 - Intel made only GigaBit Ether is used.
 - This controller has the following functions:
 - PCI-Ex connection
 - Controller : Intel madeBoazman (WG82567LM SLAVV)
 : GLCI(PCI-Ex)/LCI Connection
 - Supports Gigabit Ethernet
 - One RJ45 port
 - WOL support
 - LED support
 - AMT 4.0 support

- □ Wireless LAN
 - One PCI Express Mini Card slot1

802.11a/b/g/n: Intel Shirley Peak

- 802.11a/b/g: Intel Shirley Peak
- Supports Wireless Communication SW
- □ Bluetooth
 - V2.1+EDR
 - USB interface connection
 - Built-in antenna
- □ EC/KBC (Embedded Controller/Keyboard Controller)
 - One Mitsubishi M306KAFCLPR micon chip functions as both EC and KBC.
- □ PSC (Power Supply Controller)
 - One TMP86FS49AUG chip is used.
 - This controller controls the power sources.
- □ Clock Generator
 - IDT 9LPR501 is used.
 - This device generates the system clock.

□ Sensor

- Thermal Sensor: One ADM1032ARMZ chip is used.
- Acceleration Sensor :LIS3L02A
- Fingerprints sensor: Authen Tec maid

1.3 3.5-inch Floppy Disk Drive (USB External)

The 3.5-inch FDD is a thin, high-performance reliable drive that supports 720KB (formatted) 2DD and 1.44MB (formatted) 2HD disks.

The FDD is shown in figure 1-4. The specifications for the FDD are listed in Table 1-1.

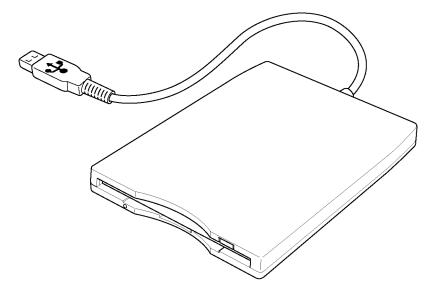


Figure 1-4 3.5-inch FDD (USB External)

Table 1-1	3.5-inch FDD	specifications
1001011	S.S then I DD	specifications

Items		TEAC FD-05PUB-337 (G8AC0000B320)	
		720KB mode 1.44MB mode	
Data transfer rate	FDD part	250K bits/second	500K bits/second
	USB	Full speed mode (12M bits/second)	
Disk rotation speed		300rpm	
Track density		5.3 track/mm (135TPI)	

1.4 2.5-inch Hard Disk Drive

The removable HDD is a random access non-volatile storage device. It has a non-removable 2.5-inch magnetic disk and mini-Winchester type magnetic heads. The computer supports an 80GB, 120GB, 160GB, 200GB, 250GB or 320GB.

The HDD is shown in figure 1-5. Specifications are listed in Table 1-2.

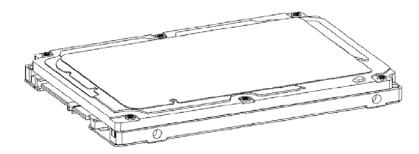


Figure 1-5 2.5-inch HDD

		Specifications								
Items		FUJITSU								
		G8BC0 0052 082	G8BC0 0052 122	G8BC0 0052 162	G8BC0 0052 252	G8BC0 0052 322	G8BC00 05N 160	G8BC00 05N 200	G8BC0005N 320	
Outline	Width (mm)					100.0				
Dimens ions	Height (mm)		9.5							
	Depth (mm)	70.0								
	Weight (g)	96 max			101	max	nax		115 max	
	Storage size (formatted)		120GB	160GB	250GB	320GB	160GB	200GB	320GB	
Speed (F	RPM)	5,400					7,200			
Data tran spee	sfer d (Mb/s)									
To/Form	To/Form Media		91.6 MB/s Max 150 MB/s (Genli)					118.4 MB/s Max 150 MB/s (Genli)		
To/Form Host										
Data buffer size (MB)		8					16			
Positioning Time(read and seek time)		Read: 12ms				Read: 10.5ms				
Motor startup time (s)		4 4.17								

Table 1-2 2.5-inch HDD specifications

					Specif	ications				
	Items		HGST							
			G8BC00 051120	G8BC0 005116 0	G8BC0005 1250	G8BC00 051320	G8BC00 05F160	G8BC00 05F200	G8BC0 005F32 0	
Outli ne	Width (mm)	100.2±0.25								
Dime nsio ns	Height (mm)			9.5±0.2						
	Depth (mm)		69.85±0.25							
Weight (g)		95 max		102 max		110 max	115 max			
Storage size (formatted)		80GB	120GB	160GB	250GB	320GB	160GB	200GB	320GB	
Speed (RPM)		5,400					7,200			
Data transfer rate Disk-buffer to/from media(Mbps) Buffer-host data transfer (Ggit/sec)		775 max 3.0/1.5 max.					1136 max 3.0/1.5 max.			
Data buffer size (KB)				8192	16384					
Positioning Time(read and seek time)		Read: 12ms								
Motor startup time (s)		3.5 4.0								

Table 1-2 2.5-inch HDD specifications

1.5 2.5-inch Solid State Drive (SSD)

Some models are equipped with a "Solid State Drive (SSD)" instead of a hard disk drive. The computer supports a 64GB and 128GB. The specifications of SSD are listed by the table 1-3.

Items		Specifications			
		TOSHIBA	TOSHIBA		
		G8BC00059640	G8BC00059120		
Outline	Width (mm)	69.85			
Dimensions Height (mm)		9.5			
Depth (mm) Weigh t (g)		100.0			
		66			
Storage size (formatted)		64GB	128GB.		
Data transfer speed		Host Interface : Max 300MB/s			
		Sustained Data Read : Max 100MB/s			
		Sustained Data Write : Max 40MB/s			

Table 1-3	1.8-inch Solid State	Drive (SSD)	specifications
-----------	----------------------	-------------	----------------

1.6 DVD-Super Multi Drive Optical Drive (ODD)

The DVD Super Multi drive accommodates either 12 cm (4.72-inch) or 8 cm (3.15-inch) CD-ROM, DVD-ROM, CD-R, CD-RW, DVD-R, DVD+R, DVD-RW, DVD+RW, DVD-RAM.

The specifications are listed in Table 1-4.

lte	em	Specifications			
		MATSUSHITA G8CC0004D320			
Outline	Width (mm)	128 (excluding projections)			
dimensions	Height (mm)	9.5 (excluding projections)			
	Depth (mm)	129 (excluding projections)			
	Mass (g)	107±5(bezel included)			
Data transfer DVD-ROM CD-ROM	speed (Read)	Max. 8x CAV Max. 24x CAV			
Data transfer speed (Write) CD-R CD-RW DVD-R DVD-R DL DVD-RW DVD+R DVD+R DVD+R DL DVD+RW DVD-RAM		Max. 24x CAV Max. 16x ZCLV (Ultra speed) Max. 8x ZCLV Max. 4x ZCLV Max. 6x ZCLV Max. 8x ZCLV Max. 4x ZCLV Max. 4x ZCLV Max. 8x ZCLV Max. 3x-5X PCAV (4.7GB)			
SATA interface	Э	150MByte/s			
Data Buffer Ca	apacity	2MB			
Access time (ms) CD-ROM DVD-ROM		150msec typ. 180msec typ.			
Supported Disks		CD: CD-ROM (12cm, 8cm), CD-R, CD-RW DVD: DVD-ROM, DVD-R, DVD-RW, DVD-RAM, DVD+RW,DVD-R DL(Read only),DVD+R,DVD+R DL(Read only)			
Supported Formats		CD: CD-DA, CD-ROM, CD-ROM XA, PHOTO CD, CD-Extra(CD+), CD-text, Video CD DVD: DVD-R, DVD-RW (Ver. 1.1, 1.2), DVD-Video, DVD+R, DVD+RW, DVD-RAM,DVD-ROM DVD-R DL(Read only, DVD+R DL(Read only			

1.7 Keyboard

The keyboard is mounted 85(US)/87(UK) keys that consist of character key and control key, and in conformity with JIS. The keyboard is connected to membrane connector on the system board and controlled by the keyboard controller.

Figure 1-6 is a view of the keyboard.

See Appendix E about a layout of the keyboard.



Figure 1-6 Keyboard

1.8 TFT Color Display

The TFT color display consists of 14.1-inch WXGA/WXGA+ LCD module.

1.8.1 LCD Module

The LCD module used for the TFT color display uses a white LED backlight as the light source and can display a maximum of 16M colors with 1,280 x 800 or 1,440×900 resolution. The Intel North Bridge (Cantiga GS) or nVIDIA NB9M-NE can control internal and external WXGA or WXGA+ support displays simultaneously.

Figure 1-7 shows a view of the LCD module and Table 1-5 lists the specifications.

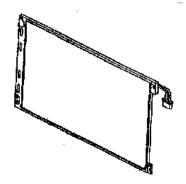


Figure 1-7 LCD module

Table 1-5	LCD	module	specifications
-----------	-----	--------	----------------

ltem	Specifications				
item	14.1-inch WXGA TFT Samsung (G33C00054110)				
Number of Dots	1,280 (W) x 800 (H)				
Dot spacing (mm)	0.237(H)x0.237(V)				
Display range (mm)	303.36(H)x189.6(V) (14.1" diagonal)				

Table 1-5 LCD module specifications

ltem	Specifications			
	14.1-inch WXGA+ TFT Samsung			
Number of Dots	1,440(W) ×900 (H)			
Dot spacing (mm)	_			
Display range (mm)	-			

1.9 Power Supply

The power supply supplies many different voltages to the system board and performs the following functions:

- 1. Judges that the DC power supply (AC adapter) is connected to the computer.
- 2. Detects DC output and circuit malfunctions.
- 3. Controls the battery icon, and DC IN icon.
- 4. Turns the battery charging system on and off and detects a fully charged battery.
- 5. Turns the power supply on and off.
- 6. Provides more accurate detection of a low battery.
- 7. Calculates the remaining battery capacity.
- 8. Controls the transmission of the status signal of the main battery.

The power supply output rating is specified in Table 1-6.

Table 1-6 Power supply output rating (1/3)

On/Off of a power supply system and a power supply system in each State is as for	ollows.
---	---------

AMT non-support mode							
ACPI State	S 0	S 0	S 3	S 3	S4/S5	S4/S5	G3
Wake On LAN	Support	not support	Support	not support	Support	not support	
P System Power supply	0	0	-	-	-	-	-
B System Power supply	0	0	0	0	-	-	-
LAN Power supply	0	0	0	-	0	-	-
M System Power supply	0	0	-	-	-	-	-
E System Power supply	0	0	0	0	0	*	-
S System Power supply	0	0	0	0	0	0	-
RTC Power supply	0	0	0	0	0	0	0
		•	•		•		•

AMT support model								
(At the time of Moff, it i	is the same	e as that o	f not support	ing AMT))			
ACPI State	SO	S 0	\$3/\$4/\$5	S 3	S 3	S4/S5	S4/S5	G 3
M State	M0	M0	M1	Moff	Moff	Moff	Moff	
Wake On LAN	Support	not support	Setup is impossible.	Support	not support	Support	not support	
P System Power supply	0	0	-	-	-	-	-	-
B System Power supply	0	0	0	0	0	-	-	-
LAN Power supply	0	0	0	0	-	0	-	-
M System Power supply	0	0	0	-	-	-	-	-
E System Power supply	0	0	0	0	0	0	*	-
S System Power supply	0	0	0	0	0	0	0	-
RTC Power supply	0	0	0	0	0	0	0	0

 $\circ: \mathsf{On}$

-: Off

*: It is dependent on support of Wake On LAN.

Table 1-6 Power supply output rating (2/3)

The main power supply systems inside PC are as follows.

РСВ	Object	Name	Voltage [V]	Powe	er supply name
FMWSY*	Clock Gen.	M-E3V	3.3	М	System
FMWSY*	Clock Gen.	P3V	3.3	Р	System
FMWSY*	CPU	1R05-P1V	1.05	Р	System
FMWSY*	CPU	1R5-P1V	1.5	Р	System
FMWSY*	CPU	PPV	0.6~1.275	Р	System
FMWSY*	GMCH	1R05M-E1V	1.05	Μ	System
FMWSY*	(G)MCH	1R05-P1V	1.05	Р	System
FMWSY*		1R5-P1V	1.5	Р	System
FMWSY*	(G)MCH	MR0R9-B0V	0.9	В	System
FMWSY*	(G)MCH	1R8-B1V	1.8	В	System
FMWSY*	(G)MCH	IGD-PGV	1.05	Р	System
FMWSY*	(G)MCH	P3V	3.3	Р	System
FMWSY*	Memory	0R9-B0V	0.9	В	System
FMWSY*	Memory	1R8-B1V	1.8	В	System
FMWSY*	ICH9M-E SFF	1R05-P1V	1.05	Р	System
FMWSY*	ICH8M(-E)	1R5-P1V	1.5	Р	System
FMWSY*	ICH8M(-E)	E3V	3.3	Е	System
FMWSY*	ICH8M(-E)	LAN-E3V	3.3	LAN	Power supply
FMWSY*	ICH8M(-E)	P3V	3.3	Р	System
FMWSY*	ICH8M(-E)	R3V	2~3.5	RTC	Power supply
FMWSY*	HDD	P5V	5	Р	System
FMWSY*	ODD	SODD-P5V	5	Р	System
FMWSY*	Card Cont.	P3V	3.3	Р	System
FMWSY*	Smart Card Reader	SMCRD-P3V	3.3	Ρ	System
FMWSD*	SD Card	FM-P3V	3.3	Р	System
FMWSD*	SD Card PS	P3V	3.3	Р	System
FMWSY*	Express Card	CRD1R5-P1V	1.5	Р	System
FMWSY*	Express Card	CRD-E3V	3.3	E	System
FMWSY*	Express Card	CRD-P3V	3.3	Р	System
FMWSY*	Express Card PS	1R5-P1V	1.5	Р	System
FMWSY*	Express Card PS	E3V	3.3	E	System
FMWSY*	Express Card PS	P3V	3.3	Р	System
FMWSY*	MiniCard Slot1	1R5-P1V	1.5	Р	System
FMWSY*	W-LAN	WLAN-E3V	3.3	Е	System
FMWSY*	W-LAN	P3V	3.3	Р	System
FMWPE*	MiniCard Slot2	1R5-P1V	1.5	Р	System
FMWPE*	3G	MP2-E3V	3.3	Е	System
FMWPE*	SIM Card	UIMPWR-E3V	3.3	E	System

FMWSY*	SPI	LAN-E3V	3.3	LAN	Power supply
FMWSY*	EC/KBC	S3V	3.3	S	System
FMWTP*	Touch Pad	P5V	5	Р	System
FMWSD*	LED	M5V	5	S	System
FMWSY*	ТРМ	E3V	3.3	E	System
FMWSY*	ТРМ	P3V	3.3	Р	System
FMWSY*	Accelerometer	S3V	3.3	S	System
FMWTP*	Finger Sensor.	FS-E3V	3.3	E	System
FMWTP*	Finger.	AT-E3V	3.3	E	System
FMWSY*	LAN	LN1R05-E1V	1.05	LAN	Power supply
FMWSY*	LAN	LAN1R8-E1V	1.8	LAN	Power supply
FMWSY*	LAN	LAN-E3V	3.3	LAN	Power supply
FMWSY*	Bluetooth	P3V	3.3	Р	System
FMWPE*	USB	USB0PS-E5V	5	E	System
FMWUS*	USB	USB1PS-E5V	5	E	System
FMWUS*		USB2PS-E5V	5	E	System
FMWSY*	GPU	1R1-P1V	1.1	Р	System
FMWSY*	GPU	1R8-PGV	1.8	Р	System
FMWSY*	GPU	P3V	3.3	Р	System
FMWSY*	GPU	PGV	0.9~1.09	Р	System
FMWSY*	VRAM	1R8-PGV	1.8	Р	System
FMWSY*	LCD	PNL-P3V	3.3	Р	System
FMWSY*	DVI Transmitter	2R5-P2V	2.5	Р	System
FMWSY*		P3V	3.3	Р	System
FMWUS*	AMP	A4R7-P4V	4.7	Р	System
FMWUS*	AMP	P5V	5	Р	System
FMWUS*	CODEC	A4R7-P4V	4.7	Р	System
FMWUS*	CODEC	P3V	3.3	Р	System
FMWUS*	Headphone AMP	P3V	3.3	Р	System
FMWSY*	PSC	MCV	5	S	System
FMWSY*	FAN	E5V	5	E	System

Table 1-6 Power supply output rating (3/3)

Four sorts of power su	pplies with many use	places are indicated for	every power supply.
F The second sec			

Name	Voltage [V]		wer supply me	Object
1R5-P1V	1.5	Ρ	System	CPU, GMCH, ICH9M-E,Express Card PS, MiniCard Slot1, MiniCard Slot2
E3V	3.3	Е	System	Express Card, Finger Sensor, ICH9M-E, LAN, TPM, MiniCard Slot1, MiniCard Slot2
P3V	3.3	Ρ	System	Clock Gen. ,GMCH, Card Cont., CODEC, Express Card , GPU, Headphone AMP, ICH9M-E, LCD, SD Card , TPM,
P5V	5	Ρ	System	Bluetooth PS, FAN, HDD, ODD

1.10 Batteries

The computer has three types of batteries as follows:

□ Main battery pack

RTC battery

The battery specifications are listed in Table 1-7.

Battery name		Material	Output voltage	Capacity
battery	G71C0009H110/210/310	Lithium-Ion	10.8 V	4,000 mAh
battery	G71C0009J110/210/310	Lithium-Ion	10.8 V	5,100 mAh
Slice Expansion battery	G71C0006K110/210	Lithium-Ion	10.8 V	4,000 mAh
RTC battery	GDM710000041	NiMH	2.4 V	16 mAh

Table 1-7	Battery specifications	
-----------	------------------------	--

1.10.1 Main Battery

The removable main battery pack is the computer's main power source when the AC adaptor is not attached. The main battery maintains the state of the computer when the computer enters in sleep mode.

1.10.2 Battery Charging Control

Battery charging is controlled by a power supply microprocessor. The microprocessor controls whether the charge is on or off and detects a full charge when the AC adaptor and battery are attached to the computer. The system charges the battery.

Battery Charge

When the AC adaptor is attached, there are two types of charge: When the system is powered off and when the system is powered on. Table 1-8 lists the charging time required for charges.

Battery type	Power on (hours)	Power off (hours)
Battery(4,000 mAh)	About 3.0 to 9.5	About 2.5
Battery(5,100 mAh)	About 4.0to 12.0	About 3.0
Slice Expansion battery (4,000 mAh)	About 3.0 to 9.5	About 2.5

Table 1-8Time required for charges

NOTE: The time required when the system is powered on is affected by the amount of power the system is consuming. Use of the fluorescent lamp and frequent disk access diverts power and lengthens the charge time.

If any of the following occurs, the battery charge process stops.

- 1. The battery becomes fully charged.
- 2. The AC adaptor or battery is removed.
- 3. The battery or output voltage is abnormal.

□ Data preservation time

When turning off the power in being charged fully, the preservation time is as following Table 1-9.

Condition	preservation time
Standby	About 3 days Battery(4,000 mAh)
Shutdown	About 45 days Battery(4,000 mAh)
Standby	About 4 days (5,100 mAh)
Shutdown	About 60 days(5,100 mAh)
Standby	About 3 days Slice Expansion battery (4,000 mAh)
Shutdown	About 45 days Slice Expansion battery (4,000 mAh)

Table 1-9 Data preservation time

1.10.3 RTC battery

The RTC battery provides power to keep the current date, time and other setup information in memory while the computer is turned off. Table 1-10 lists the charging time and data preservation period of the RTC battery.

 Table 1-10
 RTC battery charging/data preservation time

Status	Time
Charging Time (power on)	24 hours
Data preservation period (full charge)	30 days

1.11 AC Adapter

The AC adapter is also used to charge the battery.

Table 1-11 lists the AC adapter specifications.

Parameter	Specification	
	G71C0006Q310 (2-pin)	G71C0006R230 (3-pin)
Power	75W (Peak 90W)	
Input voltage	100V/240V	
Input frequency	50Hz to 60Hz	
Input current	1.5A or less (100V-240V)	
B Output voltage	15V	
Output current	0A to 5A (At constant voltage mode) 5A to 6A (At surge load mode)	

Chapter 2

Troubleshooting Procedures

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	DC IN icon Error code Debug port error status FDD error code and status

Troubleshooting 2.1

Chapter 2 describes how to determine which Field Replaceable Unit (FRU) in the computer is causing the computer to malfunction. (The "FRU" means the replaceable unit in the field.) The FRUs covered are:

- 1. Power supply
- 2. System Board
- 3. USB FDD
- 4. HDD/SSD
- 5. Keyboard
- 8. Display 9. Optical Disk Drive
- 10. LAN

14. 3G

- 11. Wireless LAN
- 12. Bluetooth
- 13. Sound
- 16. Fingerprint Sensor
 - 17. Web camerta 18. Intel Turbo Memory

15. SD Card Slot

6. Touch pad 7. Membrane switch

The Test Program operations are described in Chapter 3. Detailed replacement procedures are described in Chapter 4.

NOTE: Before replacing the system board, it is necessary to execute the subtest 03 DMI Information save of the 3.4 Setting of the hardware configuration in Chapter 3. After replacing the system board, it is necessary to execute the subtest 04 DMI Information recovery and subtest 08 System configuration display of the 3.4 Setting of the hardware configuration in Chapter 3. Also update with the latest

EC/KBC as described in Appendix H "EC/KBC Rewrite Procedures".

After replacing the LCD, update with the latest EC/KBC as described in Appendix H "EC/KBC Rewrite Procedures" to set the SVP parameter.

The implement for the Diagnostics procedures is referred to Chapter 3. Also, following implements are necessary:

- 1. Phillips screwdrivers (For replacement procedures)
- 2. Implements for debugging port check
 - Toshiba MS-DOS system FD •
 - RS-232C cross cable
 - Test board with debug port test cable •
 - PC for displaying debug port test result

There are following two types of connections in the figure of board and module connection in and after 2.3 Power Supply Troubleshooting.

- (1) Cable connection is described in the figure as line.
- (2) Pin connection is described in the figure as arrow.
- <e.g> Connection of modem

2.2 Troubleshooting Flowchart

Use the flowchart in Figure 2-1 as a guide for determining which troubleshooting procedures to execute. Before going through the flowchart steps, verify the following:

- □ Ask him or her to enter the password if a password is registered.
- □ Verify with the customer that Toshiba Windows is installed on the hard disk. Non-Windows operating systems can cause the computer to malfunction.
- □ Make sure all optional equipment is removed from the computer.

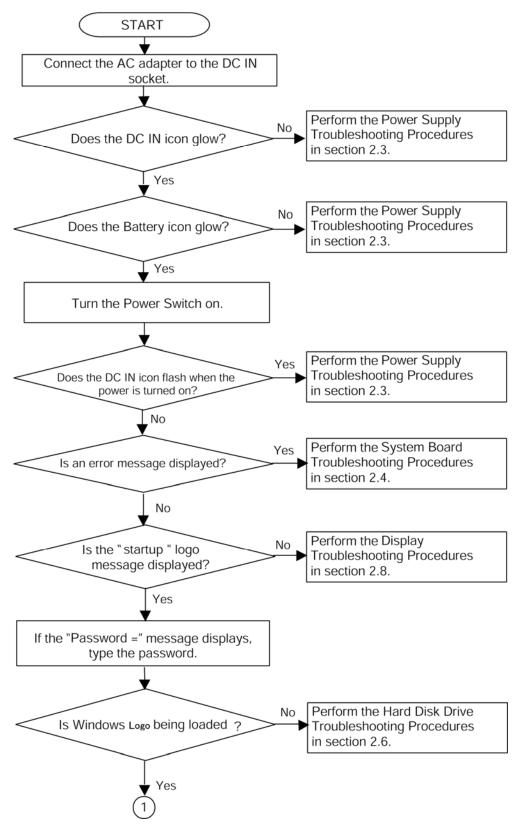


Figure 2-1 Troubleshooting flowchart (1/2)

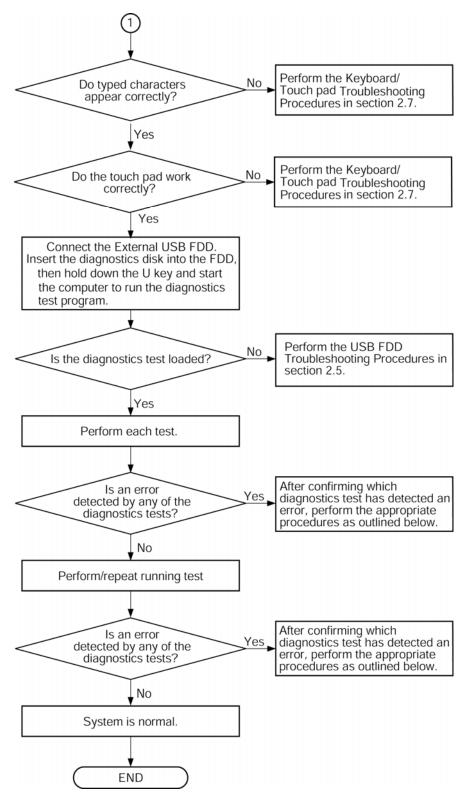


Figure 2-1 Troubleshooting flowchart (2/2)

If the diagnostics program cannot detect an error, the problem may be intermittent. The Test program should be executed several times to isolate the problem. Check the Log Utilities function to confirm which diagnostic test detected an error(s), then perform the appropriate troubleshooting procedures as follows:

- 1. If an error is detected on the system test, memory test, display test, CD-ROM/DVD-ROM test, expansion test, real timer test, sound test or Modem/LAN/Bluetooth /IEEE1394 test, perform the System Board Troubleshooting Procedures in Section 2.4.
- 2. If an error is detected on the floppy disk test, perform the USB FDD Troubleshooting Procedures in Section 2.5.
- 3. If an error is detected on the hard disk test, perform the HDD/SSD Troubleshooting Procedures in Section 2.6.
- 4. If an error is found on the keyboard test (DIAGNOSTICS TEST) and pressed key display test (ONLY ONE TEST), perform the Keyboard Troubleshooting Procedures in Section 2.7.
- 5. If an error is found on the touch pad test (ONLY ONE TEST), perform the touch pad Troubleshooting Procedures in Section 2.8.
- 6. If an error is found on the button test (ONLY ONE TEST), perform the membrane switch Troubleshooting Procedures in Section 2.9.
- 7. If an error is detected on the display test, perform the Display Troubleshooting Procedures in Section 2.10.
- 8. If an error is detected on the CD-ROM/DVD-ROM test, perform the Optical Disk Drive Troubleshooting Procedures in Section 2.11.
- 9. If an error is detected on the LAN test, perform the LAN Troubleshooting Procedures in Section 2.12.
- 10. If an error is detected on the wireless LAN test, perform the Wireless LAN Troubleshooting Procedures in Section 2.13.
- 11. If an error is detected on the Bluetooth test, perform the Bluetooth Troubleshooting Procedures in Section 2.14.
- 12. If an error is detected on the sound test, perform the Sound Troubleshooting Procedures in Section 2.15.
- 13. If an error is detected on the 3G, perform the 3G Troubleshooting Procedures in Section 2.16.
- 14. If an error is detected on SD card, perform the SD Card Slot Troubleshooting Procedures in Section 2.17.

- 15. If a malfunction is detected on the fingerprint sensor, perform the Fingerprint Sensor Troubleshooting Procedures in Section 2.18.
- 16. If a malfunction is detected on the Web camerta, perform the Web camerta Troubleshooting Procedures in Section 2.19.
- 17. If a malfunction is detected on the Intel Turbo Memory, perform the Intel Turbo Memory Troubleshooting Procedures in Section 2.20.

2.3 Power Supply Troubleshooting

The power supply controller controls many functions and components. To determine if the power supply is functioning properly, start with Procedure 1 and continue with the other Procedures as instructed. The procedures described in this section are:

Procedure 1: Power Status CheckProcedure 2: Error Code CheckProcedure 3: Connection CheckProcedure 4: Charging CheckProcedure 5: Replacement Check

Procedure 1 Power Status Check

The following icons indicate the power supply status:

- □ Battery icon
- DC IN icon

The power supply controller displays the power supply status with the Battery icon and the DC IN icon as listed in the tables below.

Battery icon	Power supply status
Lights orange	Battery is charged and the external DC is input. It has no relation with ON/OFF of the system power.
Lights blue	Battery is fully charged and the external DC is input. It has no relation with ON/OFF of the system power.
Flashes orange	Battery charge is low. The AC adaptor must be connected to recharge the battery.
Blinks orange (even intervals)	The battery level is low while the system power is ON.
Blinks orange once (at being switched on)	The system is driven by only a battery and the battery level is low.
Doesn't light	Any condition other than those above.

DC IN icon	Power supply status	
Lights blue	DC power is being supplied from the AC adapter.	
Blinks orange	Power supply malfunction ^{*1}	
Doesn't light	Any condition other than those above.	

Table 2-2 DC IN icon

*1 When the power supply controller detects a malfunction, the DC IN icon blinks orange. It shows an error code.

When the icon is blinking, perform the following procedure.

- 1. Remove the battery pack and the AC adapter.
- 2. Re-attach the battery pack and the AC adapter.

If the icon is still blinking after the operation above, check the followings:

Check 1 If the DC IN icon blinks orange, go to Procedure 2.

Check 2 If the DC IN icon does not light, go to Procedure 3.

Check 3 If the battery icon does not light orange or blue, go to Procedure 4.

NOTE: Use a supplied AC adapter G71C0002R710, G71C0002R810 (2-pin)/ G71C00067210, G71C00067110 (3-pin).

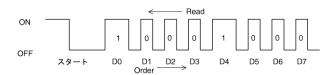
Procedure 2 Error Code Check

If the power supply microprocessor detects a malfunction, the DC IN icon blinks orange. The blink pattern indicates an error as shown below.

□ Start	Off for 2 seconds
Error code (8 bit)	
"1"	On for one second
···O'"	On for half second
Interval between data bits	Off for half second

The error code begins with the least significant digit.

Example: Error code 11h (Error codes are given in hexadecimal format.)



Start

Check 1 Convert the DC IN icon blink pattern into the hexadecimal error code and compare it to the tables below. Then go to Check 2.

Error code	Where error occurs
1*h	DC Power (AC Adapter)
2*h	Main battery
3:h	2nd battery
4*h	S3V output
5*h	E5V output
6*h	E3V output
7*h	PPV output
8*h	1R05-E1V output
9*h	1R8-E1V output
A*h	-
B*h	PPV output
C*h	PGV output
D*h	1R05-E1V output
E*h	-
F*h	-

Table 2-3 Error code

DC power supply (AC adapter)

Error code	Meaning
10h	AC Adapter output voltage is over 16.5V.
11h	Common Dock output voltage is over 16.5V.
12h	Current from the DC power supply is over 8.80A.
13h	Current from the DC power supply is over 0.5A when there is no load.
14h	The compensation value of [0A] is not within the limits from design data (\pm 481mA).

□ Main Battery

Error code	Meaning
22h	Main battery discharge current is over 0.5A.
23h	Main battery charge current is over 4.3A.
24h	The compensation value of [0A] is not within the limits from design data (\pm 15LSB).
25h	Main battery charge current is over 0.3A when the charging is off.

□ 2nd Battery

Error code	Meaning
32h	Second battery discharge current is over 0.5A.
33h	Second battery charge current is over 3.5A.
34h	The compensation value of [0A] is not within the limits from design data (\pm 15LSB)
35h	Second battery charge current is over 0.3A when the charging is off.

□ S3V output

Error code	Meaning
40h	S3V voltage is over 3.47V.
45h	S3V voltage is under 3.14V.
46h	S3V voltage is under 3.14V or less when the computer is booting up.

□ E5V output

Error code	Meaning
50h	E5V voltage is over 6.00V.
51h	E5V voltage is under 4.50V when the computer is powered on.
52h	E5V voltage is under 4.50V when the computer is booting up.
54h	E5V voltage is under 4.50V when EV power is maintained.

E3V output

Error code	Meaning
60h	E3V voltage is over 3.96V.
61h	E3V voltage is under 2.81V when the computer is powered on.
62h	E3V voltage is under 2.81V when the computer is booting up.
64h	E3V voltage is under 2.81V when EV power is maintained.

□ PPV output

Error code	Meaning
70h	PPV voltage is over 1.56V.
71h	PPV voltage is under 0.27V when the computer is powered on.
72h	PPV voltage is under 0.59V when the computer is booting up.

□ 1R05-E1V output

Error code	Meaning
80h	1R05-E1V voltage is over 1.38V.
81h	1R05-E1V voltage is under 0.85V when the computer is powered on.
82h	1R05-E1V voltage is under 0.85V when the computer is booting up.

□ 1R8-E1V output

Error code	Meaning
90h	1R8-E1V voltage is over 2.16V.
91h	1R8-E1V voltage is under 1.53V when the computer is powered on.
92h	1R8-E1V voltage is under 1.53V when the computer is booting up.
94h	E3V voltage is under 1.53V when EV power is maintained.

□ PPV output

Error code	Meaning
B0h	PPV voltage is over 1.56V.
B1h	PPV voltage is under 0.27V when the computer is powered on.
B2h	PPV voltage is under 0.59V when the computer is booting up.

□ PGV output

Error code	Meaning
C0h	PGV voltage is over 1.32V.
C1h	PGV voltage is under 0.765V when the computer is powered on.
C2h	PGV voltage is under 0.785V when the computer is booting up.

□ 1R05-E1V output

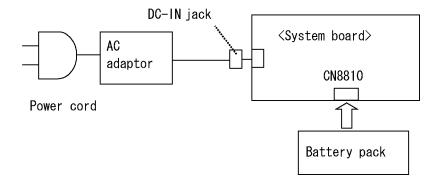
Error code	Meaning
D0h	1R05-E1V voltage is over 1.26V.
D1h	1R05-E1V voltage is under 0.89V when the computer is powered on.
D2h	1R05-E1V voltage is under 0.89V when the computer is booting up.
D4h	1R05-E1V voltage is under 0.89V when EV power is maintained.

□ Miscellaneous

Error code	Meaning
F0h	The sub clock does not oscillate.

- Check 2 In the case of error code 10h or 12h:
 - Make sure the AC adapter and AC power cord are firmly plugged into the DC IN 15 V socket and wall outlet. If the cables are connected firmly, go to the following step.
 - □ Connect a new AC adapter and AC power cord. If the problem still occurs, go to Procedure 5.
- Check 3 In the case of error code 21h:
 - Go to Procedure 3.
- Check 4 For any other errors, go to Procedure 5.

Procedure 3 **Connection Check**



The wiring diagram related to the power supply is shown below:

Any of the connectors may be disconnected. Perform Check 1.

- Check 1 Make sure the AC adapter and the AC power cord are firmly plugged into the DC IN jack and wall outlet. If these cables are connected firmly, go to Check 2.
- Check 2 Replace the AC adapter and the AC power cord with new ones.
 - If the DC IN icon does not light, go to Procedure 5.
 - If the battery icon does not light, go to Check 3.
- Check 3 Make sure the battery pack is installed in the computer correctly. If the battery is properly installed and the battery icon still does not light, go to Procedure 4.

Procedure 4 Charging Check

Check if the power supply controller charges the battery pack properly. Perform the following procedures:

- Make sure the AC adapter is firmly plugged into the DC IN jack. Check 1
- Check 2 Make sure the battery pack is properly installed. If it is properly installed, go to Check 3.
- Check 3 The battery pack may be completely discharged. Wait a few minutes to charge the battery pack while connecting the battery pack and the AC adapter. If the battery pack is still not charged, go to Check 4.
- Check 4 The battery's temperature is too high or low. Leave the battery for a while to adjust it in the right temperature. If the battery pack is still not charged, go to Check 5.
- Check 5 Replace the battery pack with a new one. If the battery pack is still not charged, go to Procedure 5.

Procedure 5 Replacement Check

The power is supplied to the system board by the AC adapter. If either the AC adapter or the system board was damaged, perform the following Checks.

To disassemble the computer, follow the steps described in Chapter 4, *Replacement Procedures*.

When AC adapter is connected:

- Check 1 AC adapter may be faulty. Replace the AC adapter with a new one. If the problem still occurs, perform Check 2.
- Check 2 System board may be faulty. Replace the system board with a new one.

When AC adapter is not connected: (When driving with battery pack)

- Check 1 Battery pack may be faulty. Replace it with a new one. If the problem still occurs, perform Check 2.
- Check 2 System board may be faulty. Replace it with a new one.

2.4 System Board Troubleshooting

This section describes how to determine if the system board is malfunctioning or not. Start with Procedure 1 and continue with the other procedures as instructed. The procedures described in this section are:

Procedure 1: Message Check

Procedure 2: Debugging Port Check

Procedure 3: Diagnostic Test Program Execution Check

Procedure 4: Replacement Check

Procedure 1 Message Check

When the power is turned on, the system performs the Initial Reliability Test (IRT) installed in the BIOS ROM. The IRT tests each IC on the system board and initializes it.

- □ If an error message is shown on the display, perform Check 1.
- □ If there is no error message, go to Procedure 2.
- □ If MS-DOS or Windows OS is properly loaded, go to Procedure 4.
- Check 1 If one of the following error messages is displayed on the screen, press the **F1** key as the message instructs. These errors occur when the system configuration preserved in the RTC memory (CMOS type memory) is not the same as the actual configuration or when the data is lost.

If you press the **F1** key as the message instructs, the SETUP screen appears to set the system configuration. If error message (b) appears often when the power is turned on, replace the RTC battery. If any other error message is displayed, perform Check 2.

(a)	*** Bad HDD type *** Check system. Then press [F1] key
(b)	*** Bad RTC battery *** Check system. Then press [F1] key
(C)	*** Bad configuration *** Check system. Then press [F1] key
(d)	*** Bad memory size *** Check system. Then press [F1] key
(e)	*** Bad time function *** Check system. Then press [F1] key
(f)	*** Bad check sum (CMOS) *** Check system. Then press [F1] key
(g)	*** Bad check sum (ROM) *** Check system. Then press [F1] key

Check 2 If the following error message is displayed on the screen, press any key as the message instructs.

The following error message appears when data stored in RAM under the resume function is lost because the battery has become discharged or the system board is damaged. Go to Procedure 3.

WARNING: RESUME FAILURE. PRESS ANY KEY TO CONTINUE.

If any other error message displays, perform Check 3.

Check 3 The IRT checks the system board. When the IRT detects an error, the system stops or an error message appears.

If one of the following error messages (1) through (17), (23) or (24) is displayed, go to Procedure 4.

If error message (18) is displayed, go to the Keyboard Troubleshooting Procedures.

If error message (19), (20) or (21) is displayed, go to the HDD Troubleshooting Procedures.

If error message (22) is displayed, go to the USB FDD Troubleshooting Procedures.

(1) PIT ERROR (2) MEMORY REFRESH ERROR (3) TIMER CH.2 OUT ERROR (4) CMOS CHECKSUM ERROR (5) CMOS BAD BATTERY ERROR (6) FIRST 64KB MEMORY ERROR (7) FIRST 64KB MEMORY PARITY ERROR (8) VRAM ERROR (9) SYSTEM MEMORY ERROR (10) SYSTEM MEMORY PARITY ERROR (11) EXTENDED MEMORY ERROR (12) EXTENDED MEMORY PARITY ERROR (13) DMA PAGE REGISTER ERROR (14) DMAC #1 ERROR (15) DMAC #2 ERROR (16) PIC #1 ERROR (17) PIC #2 ERROR (18) KBC ERROR (19) HDC ERROR (20) HDD #0 ERROR (21) HDD #1 ERROR (22) NO FDD ERROR (23) TIMER INTERRUPT ERROR (24) RTC UPDATE ERROR

Procedure 2 Debugging Port Check (Boot Mode)

Check the D port status by a serial port test. The tool for serial port test is shown below.

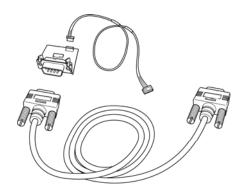
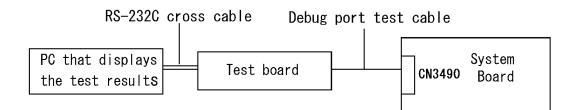


Figure 2-2 Debug port (Boot mode) error status

The test procedures are follows:

- 1. Connect the debug port test cable to the connector CN3490 of the system board. For disassembling to connect the test cable, refer to Chapter 4.
- 2. Connect the debug port test cable and RS-232C cross-cable to the test board.
- 3. Connect the RS-232C Cross-cable to the PC that displays the test results.



- 4. Boot the computer in MS-DOS mode.
- 5. Execute GETDPORT.COM in the text menu in CPU REAL mode. (Insert the FD for starting D port into FDD and input "FD starting drive:>dport".)

The D port status is displayed in the following form;

F100:000.000382		IRT_CHK_INI\SYSI_START		
D port Time status proces	(second) to	Contents of	 of process	

- 6. When the D port status is FFFFh (normal status), go to Procedure 4.
- 7. When the D port status falls into any status in Table 2-4, execute Check 1.

Г

System BIOS SUSPEND processing				
Debug Code	BIOS processing	Target Device	IC No.	
F139	Suspend processing start			
F13A	Preparation before suspend processing	EC/KBC(EC)	IC3200 EC/KBC	
	CPU setup			
F13B	It branches to Resume (F13C)/Boot (F141).	CPU	IC1050 (CPU)	
F13C	setup of ICH	ICH(USB controller)	IC1600 (ICH)	
F13D F13E	setup of ICH Preservation of CPU HDD setup Preservation of PCI Preservation of PIT Display preservation Preservation of ICH (PIC) Preservation of ICH (DMAC)	ICH(USB controller, PIT controller, PIC controller DMAC, PCI register) CPU HDD VGA	IC1600 (IC) IC1050 (CPU) CN1900 (HDD Conn), IC1200 (VGA), IC5000(VGA) (nVIDIA) IC2000 (PC-Card Cont)	
F13E	Display setup (Boot) HDD setup (Boot)	VGA HDD ICH(SATA controller)	IC1200 (VGA), IC5000 (VGA) (nVIDIA)	
F142	ROM setup	BIOS ROM		
F143	HDD setup	HDD		
F144	sound setup	EC/KBC(EC)	IC3200 (EC/KBC)	
F145	End processing of SUSPEND processing	-		
F146	Interruption, power supply control	EC/KBC(EC) ICH	IC1600 (ICH) IC3200 (EC/KBC)	
F147	CPU setup	CPU	IC1050 (CPU)	

radie 2-4	Debug port error status (1/3)

System	System BLOS DESUME processing			
System BIOS RESUME processing				
Debug	BIOS processing	Target Device	IC No.	
Code	Defende IDT			
F100	Refer to IRT			
F101	Refer to IRT			
F102	Refer to IRT			
F103	Refer to IRT			
F12A				
	Initialization of ICH (PIT)			
	PIT initialization error			
	CPU check	CDU		
	check of ROM data	CPU,		
	SMI setup	ICH (PIT Controller,		
	Part number data distinction	MEM		
	CMOS check	I/O,CMOS,I/O,PICCont	IC1050(CPU)	
	Clock generator setup	roller,IDEController,So	IC1600(ICH)	
	CPU initialization	undController,ModemC	IC1000(CLKGEN)	
	EC data reading	ontroller,PCI Expess, USB Controller, PCI	IC3200(EC/KBC)	
	BIOS processing reading 2		IC1200(MCH)	
F12C	setup of ICH (IDE)	Register),	CN1400,CN1410(RAM	
	setup of ICH (Azalia)	Clock Generator,	Conn)	
	setup of MCH	EC/KBC(EC,KBC)、	IC3000 (BISO RON)	
	Thermal control setup	CECC、	IC1200 (VGA), IC5000(VGA (nVIDIA))	
	Initialization of KBC	ICH()、		
	Display setup	MCH、		
	BIOS processing reading 3	RAM		
	setup of built-in LAN	BIOSROM		
	PCI Express initialization	VGA		
	Initialization of a sound			
	setup of ICH			
	setup of ICH (PIC)			
	PCI initialization	ICH(PCI Register)	IC1600(ICH)	
F12D			IC3200(EC/KBC)	
F12D	LAN initialization	EC/KBC(EC), LAN	IC4000(LAN	
		Controller	Controller)	
F12E	PCI device initialization	DCI doviso	IC2000(PC Card Cont)	
F12E	PCI ExpressCard setup	PCI devise	IC2000(PC-Card Cont)	
	Initialization of EC and battery access	EC/KBC(EC,KBC)	IC3200(EC/KBC)	
F12F	setup of a setup item	PSC	IC8972(PSC) CN8810(1 st Battery	
1 1 21		Battery (E2PROM)	Conn)	
	setup of ICH (DMAC)	ICH(DMAC)	IC1600(ICH)	
F130	Display setup	EC/KBC(EC)、VGA、 MCH(MEM I/O)、 RAM	IC3200(EC/KBC) IC1200 (VGA), IC5000(VGA (nVIDIA)) IC1200(MCH) CN1400,CN1410(RAM	
			Conn)	

Table 2-5 Debug port error status (2/8)

Debug Code	BIOS processing	Target Device	IC No.
F131	end of a display setting		
F132	Password processing	EC/KBC(EC) VGA ICH(USB controller) RAM	IC3200(EC/KBC) IC1600 (ICH) CN1400,CN1410(RAM Conn)
F133	setup of ICH (DMAC)	ICH(DMAC)	IC1600 (ICH)
F134	setup of ICH (PCI) CPU setup setup of ICH (MEM IO) Display setup setup of PIT setup of ICH (PIC)	ICH(CMOS,MEM I/O, PIT Controller, PIC Controller), EC/KBC(EC,KBC), RAM, BIOSROM, CPU	IC1600 (ICH) IC3200(EC/KBC) CN1400,CN1410(RAM Conn) IC3000(BIOS ROM) IC1050(CPU)
F135	setup of ICH	ICH	IC1600 (ICH)
F136	end of Resume processing	-	
F137	Setup of RAM	RAM	CN1400,CN1410(RAM Conn)
F138	Setup of RAM	RAM	CN1400,CN1410(RAM Conn)

Table 2-6	Debug p	ort error	status (3/8)
					,

NOTE: Status outputted by the test means the last error detected in the debug port test.

- Check 1 If the D port is status F11Eh or F120h is displayed, go to "HDD Trouble shooting Procedure in Section 2.6.
- Check 2 If any other D port status error code is displayed, perform Procedure 3.

D port error code is as follows:

Error code	Contents
F003h or F004h	SC initialization error
F00Bh	BIOS update error
F117h	Exception check error
F121h	Clock generator error

Procedure 3 Diagnostic Test Program Execution Check

Execute the following tests from the Diagnostic Test Menu. These tests check the system board. Refer to Chapter 3, *Tests and Diagnostic*, for more information on how to perform these tests.

- 1. System test
- 2. Memory test
- 3. Keyboard test
- 4. Display test
- 5. Floppy Disk test
- 6. Printer test [It is not supported]
- 7. Async test [It is not supported]
- 8. Hard Disk test
- 9. Real Timer test
- 10. NDP test
- 11. Expansion test
- 12. CD-ROM/DVD-ROM test
- 13. Only One test
- 14. Wireless LAN test
- 15. LAN/Modem/Bluetooth/IEEE1394 test
- 16. Sound test

If an error is detected during these tests, go to Procedure 4.

Procedure 4 Replacement Check

System board may be faulty. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and replace system board with a new one.

2.5 USB FDD Troubleshooting

This section describes how to determine if the USB FDD is functioning properly. Perform the steps below starting with Procedure 1 and continuing with the other procedures as required.

Procedure 1: USB FDD Head Cleaning CheckProcedure 2: Diagnostic Test Program Execution CheckProcedure 3: Connector CheckProcedure 4: Replacement Check

Procedure 1 USB FDD Head Cleaning Check

USB FDD head cleaning operation details are given in Chapter 3, Tests and Diagnostics.

Insert the Diagnostics Disk in the computer's floppy disk drive, turn on the computer and run the test. Clean the USB FDD heads using the cleaning kit. If the USB FDD still does not function properly after cleaning, go to Procedure 2.

If the test program cannot be executed, go to Procedure 3 and Procedure 4.

Procedure 2 Diagnostic Test Program Execution Check

Insert the Diagnostics Disk in the USB FDD, turn on the computer and run the test. Refer to Chapter 3, *Tests and Diagnostics*, for more information about the diagnostics test procedures.

Make sure the floppy disk is formatted correctly and that the write protect tab is disabled. Floppy disk drive test error codes and their status names are listed in Table 2-7. If any other errors occur while executing the FDD diagnostics test, go to Check 1.

Code	Status
01h	Bad command
02h	Address mark not found
03h	Write protected
04h	Record not found
06h	Media replaced
08h	DMA overrun error
09h	DMA boundary error
10h	CRC error
20h	FDC error
40h	Seek error
60h	FDD not drive
80h	Time out error (Not ready)
EEh	Write buffer error
FFh	Data compare error

Table 2-5FDD error code and status

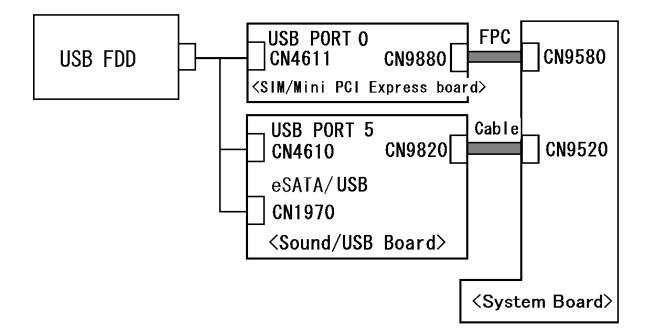
Check 1 If the following message is displayed, disable the write protect tab on the floppy disk by sliding the write protect tab to "write enable". If any other message appears, perform Check 2.

Write protected

Check 2 Make sure the floppy disk is formatted correctly. If it is, go to Procedure 3.

Procedure 3 Connector Check

The connection of USB port is shown in the following figure.



- Check 1 Check the connection of the USB FDD. If the USB FDD is still not functioning properly, perform Check 2.
- Check 2 As the connection may be defective, disassemble the computer and check each connection. If the problem still occurs, go to Procedure 4.

Procedure 4 Replacement Check

The USB FDD or USB FDD cable may be defective or damaged. Replace it with a new one. If the USB FDD is still not functioning properly, perform the following.

- □ If USB port 0 does not work properly, perform check 1.
- □ If USB port 5 does not work properly, perform check 3.
- □ If eSATA/USB port does not work properly, perform check 3.
- Check 1 SIM/Mini PCI Express board may be faulty. Replace it with a new one following the steps in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 2.
- Check 2 SIM/Mini PCI Express board FFC may be faulty. Replace it with a new one following the steps in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 5.
- Check 3 Sound/USB board may be faulty. Replace it with a new one following the steps in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 4.
- Check 4 Sound/USB board cable may be faulty. Replace it with a new one following the steps in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 5.
- Check 5 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*.

2.6 HDD/SSD Troubleshooting

To check if the HDD/SSD is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Partition CheckProcedure 2: Message CheckProcedure 3: Format CheckProcedure 4: Diagnostic Test Program Execution CheckProcedure 5: Connector Check and Replacement Check

CAUTION: The contents of the hard disk will be erased when the HDD troubleshooting procedures are executed. Transfer the contents of the hard disk to floppy disks or other storage drive(s). For the backup, refer to the User's Manual.

Procedure 1 Partition Check

Insert the Toshiba MS-DOS system disk and start the computer. Perform the following checks:

- Check 1 Input C: and press **Enter**. If you cannot change to drive C, go to Check 2. If you can change to drive C, go to Procedure 2.
- Check 2 Input FDISK and press Enter. Choose Display Partition Information from the FDISK menu. If drive C is listed in the Display Partition Information, go to Check 3. If drive C is not listed, return to the FDISK menu and choose the option to create a DOS partition or a logical DOS drive on drive C. If the problem still occurs, go to Procedure 2.
- Check 3 If drive C is listed as active in the FDISK menu, go to Check 4. If drive C is not listed as active, return to the FDISK menu and choose the option to set the active partition for drive C. Then go to Procedure 2.
- Check 4 Remove the system disk from the FDD and reboot the computer. If the problem still occurs, go to Procedure 2. Otherwise, the 2.5" HDD is operating normally.

Procedure 2 Message Check

When the power is turned on, the system performs the Initial Reliability Test (IRT) installed in the BIOS ROM. When the test detects an error, an error message is displayed on the screen.

Make sure no floppy disk is in the FDD. Turn on the computer and check the message on the screen. When an OS starts from the 2.5" HDD, go to Procedure 3. Otherwise, start with Check 1 below and perform the other checks as instructed.

Check 1 If any of the following messages appear, go to Procedure 3. If the following messages do not appear, perform Check 2.

HDC ERROR or HDD #X ERROR (After 5 seconds this message will disappear.)

Check 2 If either of the following messages appears, go to Check 3. If the following messages do not appear, perform Check 4.

Insert system disk in drive Press any key when ready or Non-System disk or disk error Replace and press any key when ready

Check 3 Using the SYS command of the DOS, transfer the system to the 2.5" HDD. If the system is not transferred, go to Procedure 3. Refer to the DOS Manual for detailed operation.

If the following message appears on the display, the system program has been transferred to the HDD.

System Transferred

If an error message appears on the display, perform Check 4.

Check 4 2.5" HDD(s) and the connector(s) of system board may be defective (Refer to the steps described in Chapter 4, *Replacement Procedures* for disassembling.). Insert HDD(s) to the connector(s) firmly. If it is (or they are) firmly connected, go to Procedure 3.

Procedure 3 Format Check

The computer's HDD is formatted using the DOS FORMAT program or the physical format program of the test program. To format the HDD, start with Check 1 below and perform the other steps as required.

Refer to the DOS Manual for the operation of DOS. For the format by the test program, refer to the Chapter 3.

Check 1 Format the 2.5" HDD using DOS FORMAT command. Type as **FORMAT C:** /S/U.

If the 2.5" HDD can not be formatted, perform Check 2.

- Check 2 Using the DOS FDISK command, set the 2.5" HDD partition. If the partition is not set, go to Check 3. If it is set, format the 2.5" HDD using MS-DOS FORMAT command.
- Check 3 Using the Diagnostic Disk, format the 2.5" HDD with a format option (physical format). If HDD is formatted, set the 2.5" HDD partition using DOS FDISK command.

If you cannot format the 2.5" HDD using the Tests and Diagnostic program, go to Procedure 4.

Procedure 4 Diagnostic Test Program Execution Check

The HDD test program is stored in the Diagnostics Disk. Perform all of the HDD tests in the Hard Disk Drive Test. Refer to Chapter 3, *Tests and Diagnostics*, for more information about the HDD test program.

If an error is detected during the HDD test, an error code and status will be displayed. The error codes and statuses are described in Table 2-8. If an error code is not displayed but the problem still occurs, go to Procedure 5.

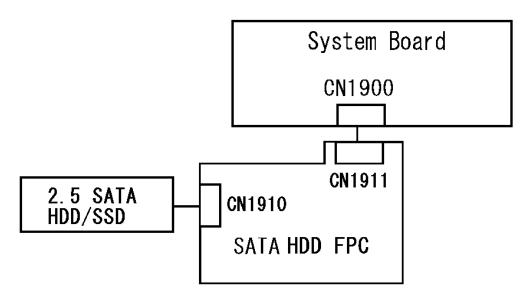
Code	Status
05	HDD - HDC NOT RESET ERROR
07	HDD - DRIVE NOT INITIALIZE
09	HDD - DMA BOUNDARY ERROR
0B	HDD - BAD TRACK ERROR
BB	HDD - UNDEFINED ERROR
08	HDD - OVERRUN ERROR (DRQ ON)
01	HDD - BAD COMMAND ERROR
02	HDD - ADDRESS MARK NOT FOUND
04	HDD - RECORD NOT FOUND ERROR
10	HDD - ECC ERROR
20	HDD - HDC ERROR
40	HDD - SEEK ERROR
80	HDD - TIME OUT ERROR
11	HDD - ECC RECOVER ENABLE
AA	HDD - DRIVE NOT READY
CC	HDD - WRITE FAULT
E0	HDD - STATUS ERROR
0A	HDD - BAD SECTOR
EE	HDD - ACCESS TIME ERROR
DA	HDD - NO HDD
12	HDD - DMA CRC ERROR

Table 2-6 2.5" Hard disk drive error code and status

Procedure 5 Connector Check and Replacement Check

The SATA HDD/SSD may be disconnected, or the 2.5 SATA HDD/SSD, SATA HDD FPC or system board may be damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and perform the following checks:

Check 1 Make sure the SATA HDD/SSD is firmly connected to CN1900 on the system board.



If any of the connections are loose, reconnect firmly and repeat Procedure 1. If there is still an error, go to Check 2.

- Check 2 The 2.5 SATA HDD/SSD may be damaged. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures* and check the operation. If the problem still exists, perform Check 3.
- Check 3 The SATA HDD FPC may be damaged. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still exists, perform Check 4.
- Check 4 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*

2.7 Keyboard Troubleshooting

To check if the computer's keyboard is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connector Check and Replacement Check

Procedure 1 Diagnostic Test Program Execution Check

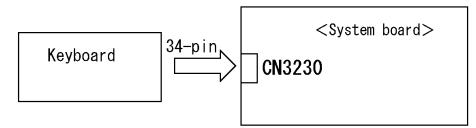
Execute the Keyboard Test (DIAGNOSTIC TEST) and Pressed key display test (ONLY ONE TEST) in the Diagnostic Program. Refer to Chapter 3, *Tests and Diagnostics*, for more information on how to perform the test program.

If an error occurs, go to Procedure 2. If an error does not occur, keyboard is functioning properly.

Procedure 2 Connector Check and Replacement Check

The connection of cable and board may be defective. Otherwise, they may be faulty. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks:

Check 1 Make sure keyboard cable is firmly connected to system board.



If the connection is loose, reconnect firmly and repeat Procedure 1. If the problem still occurs, go to Check 2.

- Check 2 Keyboard may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 3.
- Check 3 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*.

2.8 Touch pad Troubleshooting

To check if the computer's touch pad is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connector Check and Replacement Check

Procedure 1 Diagnostic Test Program Execution Check

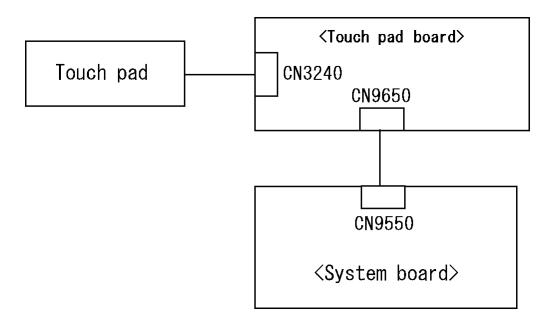
Execute the Touch pad test (ONLY ONE TEST) in the Diagnostic Program. Refer to Chapter 3, *Tests and Diagnostics*, for more information on how to perform the test program.

If an error occurs, go to Procedure 2. If an error does not occur, touch pad is functioning properly.

Procedure 2 Connector Check and Replacement Check

The connection of the cable and board may be defective. Otherwise, they may be faulty. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks:

Check 1 Make sure the cables are firmly connected to the Finger/pad button board and system board.



If the connection is loose, reconnect firmly and repeat Procedure 1. If the problem still occurs, go to Check 2.

- Check 2 Touch Pad or the cable may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 3.
- Check 3 Touch pad board or the cable may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 4.
- Check 4 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*

2.9 Membrane switch Troubleshooting

To check if the computer's Membrane switch is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connector Check and Replacement Check

Procedure 1 Diagnostic Test Program Execution Check

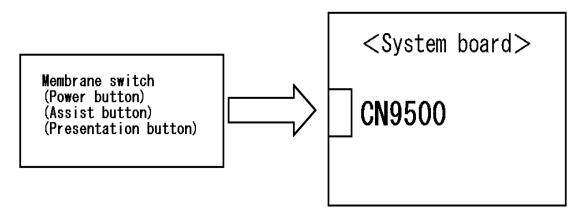
Execute the button Test (DIAGNOSTIC TEST) and Pressed key display test (ONLY ONE TEST) in the Diagnostic Program. Refer to Chapter 3, *Tests and Diagnostics*, for more information on how to perform the test program.

If an error occurs, go to Procedure 2. If an error does not occur, Membrane switch is functioning properly.

Procedure 2 Connector Check and Replacement Check

The connection of cable and board may be defective. Otherwise, they may be faulty. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks:

Check 1 Make sure Membrane switch or cable is firmly connected to system board.



If the connection is loose, reconnect firmly and repeat Procedure 1. If the problem still occurs, go to Check 2.

- Check 2 Membrane switch or cable may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 3.
- Check 3 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*.

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2.10 Display Troubleshooting

This section describes how to determine if the computer's display is functioning properly. Start with Procedure 1 and continue with the other procedures as instructed.

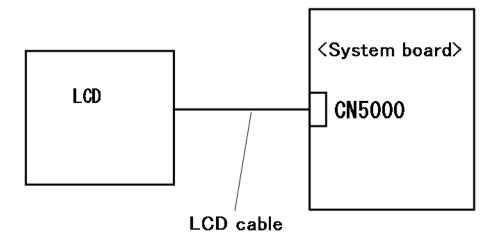
Procedure 1: Diagnostic Test Program Execution CheckProcedure 2: Connector Check and Cable CheckProcedure 3: Replacement Check

Procedure 1 Diagnostic Test Program Execution Check

The Display Test program is stored on the computer's Diagnostics disk. This program checks the display controller on the system board. Insert the Diagnostics disk in the computer's floppy disk drive, turn on the computer and run the test. Refer to Chapter 3, *Tests and Diagnostics* for details. If an error is detected, go to Procedure 2.

Procedure 2 Connector Check and Cable Check

Check 1 Make sure the LCD cable is securely connected to CN5000 on the system board.



If the connection is loose, reconnect firmly and restart the computer. If there is still an error, go to Procedure 3.

Procedure 3 Replacement Check

The LCD module and system board are connected to display circuits. Any of these components may be damaged. Refer to Chapter 4, *Replacement Procedures*.

- Check 1 Replace the LCD cable with a new one following the instructions in Chapter 4, *Replacement Procedures* and test the display again. If the problem still exists, perform Check 2.
- Check 2 Replace the LCD module with a new one following the instructions in Chapter 4, *Replacement Procedures* and test the display again. If the problem still exists, perform Check 3
- Check 3 The display controller on the system board may be damaged. Replace the system board with a new one following the instructions in Chapter 4, *Replacement Procedures*.

2.11 Optical Drive Troubleshooting

This section describes how to determine if the optical drive (Super Multi drive) is functioning properly. Perform the steps below starting with Procedure 1 and continue with the other procedures as required.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connector Check and Replacement Check

Procedure 1 Diagnostic Test Program Execution Check

The CD-ROM/DVD-ROM test program is stored in the Diagnostics Disk.

For the test, prepare test Media.

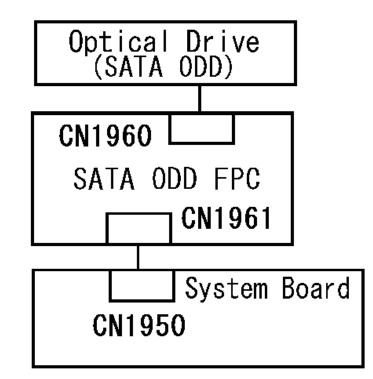
Then insert the Diagnostics Disk in the computer's floppy disk drive, turn on the computer and run the test. Refer to Chapter 3, *Tests and Diagnostics*, for more information about the diagnostics test procedures.

If any errors occur while executing the CD-ROM/DVD-ROM test, go to Procedure 2.

Procedure 2 Connector Check and Replacement Check

The optical drive (DVD Super Multi drive) is connected to the system board. The connectors may be disconnected from the system board or may be damaged. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures* and perform the following checks:

Check 1 The connection of Optical drive system is shown in the following figure.



If any of the connections is loose, reconnect firmly and repeat Procedure 1. If there is still an error, go to Check 2.

- Check 2 The Optical drive (SATA ODD) may be defective or damaged. Replace the drive with a new one. If there is still an error, go to Check 3.
- Check 3 The SATA ODD FPC may be defective or damaged. Replace the drive with a new one. If there is still an error, go to Check 4.
- Check 4 Replace the system board with a new one following the steps in Chapter 4, *Replacement Procedures*.

2.12 LAN Troubleshooting

To check if the computer's LAN is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connector Check and Replacement Check

Procedure 1 Diagnostic Test Program Execution Check

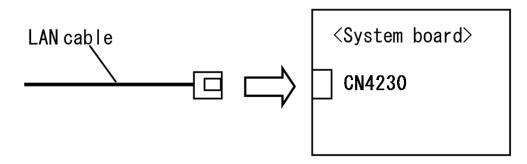
Execute LAN test in the LAN/Modem/Bluettoth/IEEE1394 test program. Refer to Chapter 3, *Tests and Diagnostics* for more information on how to perform the test program.

If any error is detected by the test, go to Procedure 2.

Procedure 2 Connector Check and Replacement Check

LAN cable is connected to system board. If LAN malfunctions, the connection of the cable and board may be defective. Otherwise, they may be faulty.

Check 1 Make sure LAN cable is firmly connected to the LAN jack on the system board. If the problem still occurs, perform Check 2.



- Check 2 LAN cable may be faulty. Replace it with a new one. If the problem still occurs, perform Check 3.
- Check 3 System board may be faulty. Replace it with a new one following the instruction in Chapter 4, *Replacement Procedure*.

2.13 Wireless LAN Troubleshooting

To check if the computer's Wireless LAN is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Transmitting-Receiving CheckProcedure 2: Antennas' Connection CheckProcedure 3: Replacement Check

Procedure 1 Transmitting-Receiving Check

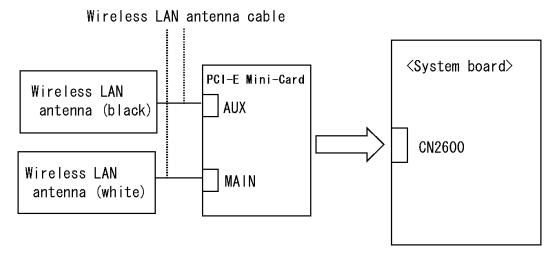
Before starting the test, make sure the wireless communication switch is set in the ON position.

Check 1 Execute Wireless LAN test program to check the transmitting-receiving function of wireless LAN. You will need a second computer that can communicate by wireless LAN. Perform the test following the instructions described in Chapter 3, *Tests and Diagnostics*.

If the computer passes the test, the function is correctly working. If the computer does not pass the test, perform Procedure 2.

Procedure 2 Antennas' Connection Check

The wireless LAN function-wiring diagram is shown below:



Any of the connections may be defective. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks:

Check 1 Make sure the wireless communication switch is "On".

If the switch is "Off", turn it "On". If the problem still occurs, perform Check 2.

- Check 2 Make sure wireless LAN card (PCI-E Mini-Card) is firmly connected to the CN2600 on the system board. If the connection is loose, connect it firmly and perform Procedure 1. If the problem still occurs, perform Check 3.
- Check 3 Make sure that wireless LAN antenna cables (black and white) are firmly connected to the connectors on Wireless LAN card. If wireless LAN antenna cables are not connected properly, connect them firmly and perform Procedure 1. If the problem still occurs, go to the procedure 3.

Procedure 3 Replacement Check

Wireless LAN card, wireless LAN antenna or system board may be faulty. Refer to Chapter 4, *Replacement Procedures*, for instructions on how to disassemble the computer and then perform the following checks:

- Check 1 Wireless LAN antenna may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 2.
- Check 2 Wireless LAN card may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 3.
- Check3 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*.

2.14 Bluetooth Troubleshooting

This section describes how to determine if the computer's Bluetooth is functioning properly. Perform the steps below starting with Procedure 1 and continuing with the other procedures as required.

Procedure 1: Diagnostic Test Program Execution Check

Procedure 2: Connection Check

Procedure 3: Replacement Check

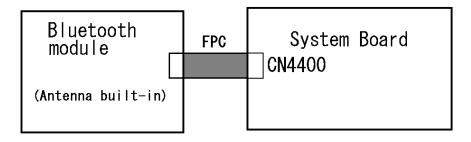
Procedure 1 Diagnostic Test Program Execution Check

Make sure the wireless switch on the left side of the computer is turned "On". If it is not, slide the switch toward the back of the computer to turn it on.

- Check 1 Execute Bluetooth test program. Perform the test following the instructions described in Chapter 3, Bluetooth Test Program. You will need a second computer that can communicate by the Bluetooth.If the computer passes the test, the function is correctly working. If the computer does not pass the test, go to check 2.
- Check 2 The Bluetooth module may be defective or damaged. Replace it with a new one. Then perform the test program again. If the computer still does not pass the test, go to Procedure 2.

Procedure 2 Connection Check

The Bluetooth function wiring diagram is shown below:



Any of the connections may be disconnected. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks:

Check 1 Make sure the Bluetooth module is firmly connected to CN4400 on the system board.

If the Bluetooth module FPC is disconnected, connect it firmly. If the Bluetooth module is still not functioning properly, go to Procedure 3.

Procedure 3 Replacement Check

The Bluetooth antenna, Bluetooth module, sound board and system board are connected to the circuits. Any of these components may be damaged. Refer to Chapter 4, *Replacement Procedures*, for instructions on how to disassemble the computer and then perform the following checks:

- Check 1 The Bluetooth module may be defective or damaged. Replace the Bluetooth module with a new one following the steps in Chapter 4, *Replacement Procedures*. If the Bluetooth is still not functioning properly, perform Check 2.
- Check 2 The Bluetooth module FPC may be defective or damaged. Replace the Bluetooth module FPC with a new one following the steps in Chapter 4, *Replacement Procedures*. If the Bluetooth is still not functioning properly, perform Check 3.
- Check 3 The system board may be defective or damaged. Replace the system board with a new one following the steps in Chapter 4, *Replacement Procedures*.

2.15 Sound Troubleshooting

This section describes how to determine if the computer's sound functions are functioning properly. Perform the steps below starting with Procedure 1 and continuing with the other procedures as required.

Procedure 1: Diagnostic Test Program Execution Check Procedure 2: Connecor Check Procedure 3: Replacement Check

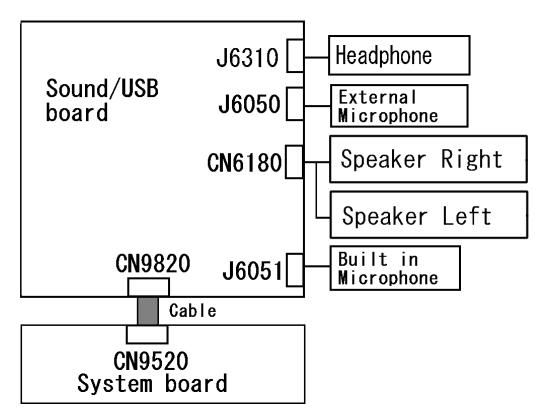
Procedure 1 Diagnostic Test Program Execution Check

Execute the Sound test in Sound Test program disk. Refer to Chapter 3, *Tests and - Diagnostics* for more information on how to perform the test program.

If any error is detected by the test, go to Procedure 2.

Procedure 2 Connector Check-

The connection of sound system is shown in the following figure.



As the connection may be defective, disassemble the computer and check each connection. If the problem still occurs, go to Procedure 3.

Procedure 3 Replacement Check

- □ If headphone does not work properly, perform check 1.
- □ If external microphone does not work properly, perform check 2.
- \Box If speaker does not work properly, perform check 3.
- □ If internal microphone does not work properly, perform check 4.
- Check 1 Headphone may be faulty. Replace it with a new one following the steps in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 5.
- Check 2 External microphone may be faulty. Replace it with a new one following the steps in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 5
- Check 3 Speaker may be faulty. Replace it with a new one following the steps in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 5
- Check 4 Internal microphone may be faulty. Replace it with a new one following the steps in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 5
- Check 5 Sound/USB board or cable may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 6
- Check 6 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*.

2.16 3G Troubleshooting

This section describes how to determine if the computer's 3G is functioning properly. Perform the steps below starting with Procedure 1 and continuing with the other procedures as required.

Procedure 1: Transmitting-Receiving Check

Procedure 2: Antenna Connection Check

Procedure 3: Replacement Check

Procedure 1 Transmitting-Receiving Check

Make sure the wireless switch on the left side of the computer is turned "On". If it is not, slide the switch toward the back of the computer to turn it on.

Refer to Chapter 3, *Tests and Diagnostics* for more information on how to perform the test program.

Check 1 Execute test program for the 3G function to check the transmitting-receiving function of the 3G. You will need a second computer that can communicate by the 3G.

3G test program for DOS is an object for EV620TV2.

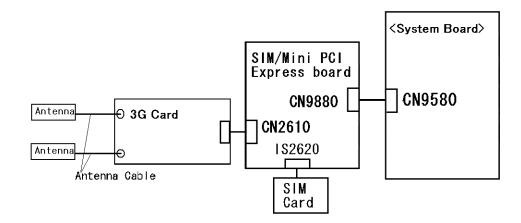
The test program for EU870DT1 should use the WINDOWS version.

If the computer passes the test, the function is correctly working.

If the computer does not pass the test, perform Procedure 2.

Procedure 2 Antenna Connection Check

The 3G wiring diagram is shown below:



Any of the connections may be disconnected. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks:

Check 1 Make sure the 3G antenna cables are firmly connected to the 3G card.

If the 3G antenna cables are disconnected, connect them firmly and go to Procedure 1. If the 3G card is still not functioning properly, go to Check 2.

- Check2 Make sure the 3G card connected to CN2610 on the SIM/Mini PCI Express board. If the connector is disconnected, connect it firmly and go to Procedure 1. If the 3G card is still not functioning properly, perform Check 3.
- Check3 Make sure the SIM card connected to IS2620 on the SIM/Mini PCI Express board.. If the connector is disconnected, connect it firmly and go to Procedure 1. If the 3G card is still not functioning properly, perform Check 4.
- Check4 Make sure the CN9880 on the SIM/Mini PCI Express board is firmly connected to CN9580 on the system board, connect it firmly and go to Procedure 1. If the 3G card is still not functioning properly, perform Procedure 3.

Procedure 3 Replacement Check

The 3G antenna, 3G card, SIM card, SIM/Mini PCI Express board and the system board are connected to the circuits. Any of these components may be damaged. Refer to Chapter 4, *Replacement Procedures*, for instructions how to disassemble the computer and then perform the following checks:

- Check 1 The 3G card, SIM card may be defective or damaged. Replace it with a new one following the steps in Chapter 4, *Replacement Procedures*. If the problem still exists, perform Check 2.
- Check 2 The 3G antennas may be defective or damaged. Replace the antennas with new ones following the steps in Chapter 4, *Replacement Procedures*. If the problem still exists, perform Check 3.
- Check 3 The SIM/Mini PCI Express board may be defective or damaged. Replace the SIM/Mini PCI Express board C with a new one following the steps in Chapter 4, *Replacement Procedures*. If the problem still exists, perform Check 4
- Check 4 The system board may be defective or damaged. Replace the board with a new one following the instructions in Chapter 4, *Replacement Procedures*.

2.17 SD card Slot Troubleshooting

This section describes how to determine if the computer's Bridge media functions are functioning properly. Perform the steps below starting with Procedure 1 and continuing with the other procedures as required.

Procedure 1: Check on Windows OS

Procedure 2: Connector Check and Replacement Check

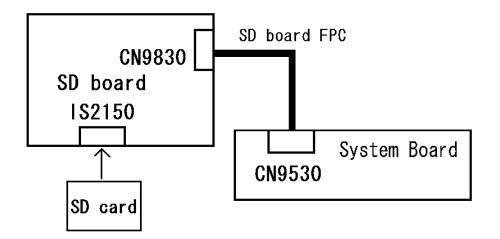
Procedure 1 Check on Windows OS

Insert a SD card into the slot. Check if the installed Windows recognizes automatically the SD card and the data in the SD card can be read.

If the card is not recognized or data are not read, go to Procedure 2.

Procedure 2 Connector Check and Replacement Check

Check 1 The connection of SD system is shown in the following figure.



If any of the connections is loose, reconnect firmly and repeat Procedure 1. If there is still an error, go to Check 2.

- Check 2 The SD board may be defective or damaged. Replace the drive with a new one. If there is still an error, go to Check 3.
- Check 3 The SD board FPC may be defective or damaged. Replace the drive with a new one. If there is still an error, go to Check 4
- Check 4 System board may be faulty. Replace it with a new one following the step in Chapter 4 *Replacement Procedures*.

2.18 Fingerprint sensor Troubleshooting

CAUTION: To delete the account for confirming the fingerprint operation, it is necessary to log on by the account with the management authority. If the password has been set to log on, ask the Log-ON password to the user.

To check if the Fingerprint sensor works correctly or not, follow the troubleshooting procedures below as instructed.

When failed in Procedure 1 to Procedure 3, execute Procedure 4.

Procedure 1: Setting Windows Log-ON password

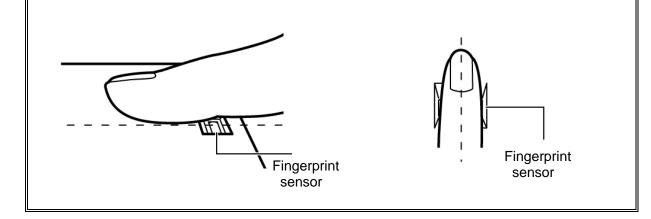
Procedure 2: Registration of fingerprint

Procedure 3: Authentication of fingerprint

Procedure 4: Connector Check and Replacement Check

CAUTION: Scan your finger shown below.

- 1. Lay your finger straight to the sensor and put lightly the first joint of your finger at the centerline of the fingerprint sensor.
- 2. Slide slowly your finger from the first joint to fingertip at constant speed. When not recognized, adjust the speed.



Procedure 1 Setting Windows Log-ON password

- 1. Open [User Account] from [Control Panel].
- 2. Click [User Account].
- 3. Click the icon of the account (user's name) that you want to set the password.
- 4. Click "Create Account".
- 5. Type a password in "Type a new password".
- 6. Press **Tab** key.
- 7. Type the password again.
- 8. Click "Create Password" button.
- 9. When "Do you want to make your files and folders private" appears in [Computer administrator], click [Yes, Make Private].

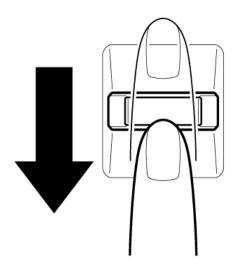
Procedure 2 Registration of fingerprint

- 1. To run this program, click Start -> All Programs -> TrueSuite Access Manager -> TrueSuite Access Manager ->.
- 2. The Verify screen will be displayed, enter the Windows logon password and click the Next button.
- 3. On the User's Fingers screen click the box above the finger you wish to register. If any of the previously enrolled fingerprints is selected again, the latest information will be enrolled and any previous information over-written.
- 4. The Fingerprint Enrollment screen will be displayed and the tutorial will begin. First click "Replay video" and confirm the proper movement for the finger you wish to register. Then confirm the message displayed on this screen and ensure that there is a check mark in the Run Interactive Tutorial box. Once this has been done, click Next.
- 5. At the Scanning Practice screen, you are able to practice swiping (three times) your finger to ensure you use the correct method. Click "Try again" to if you wish to practice again. You have finished practicing, click Next button.
- 6. Register your fingerprint on the Fingerprint Image Capture screen. Let the computer read the finger to be registered 3 times. An image of your fingerprint will be shown on the screen each time the fingerprint is successfully read. Once the fingerprint is successfully read for the third time, the message successfully combined will be displayed beneath the fingerprint images. Click the Next button.

7. When the Store to Sensor screen is displayed, check Store fingerprint to Sensor. Click Finish to complete fingerprint registration.

Procedure 3 Authentication of fingerprint

- 1. Turn on the computer to start up Windows.
- 2. In the Windows logon window, put lightly the first joint of your finger registered and slide your finger sideways.



When authenticated, [Success] is displayed in the fingerprint authentication display.

When not authenticated well, warning message appears.

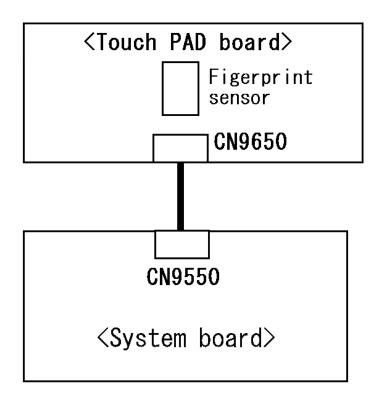
If you fail continually five times or more, you can not use the fingerprint authentication about two minute.

When not authenticated, type the password to logon to Windows.

Procedure 4 Connector Check and Replacement Check

The connection of the cable and board may be defective. Otherwise, they may be faulty. Disassemble the computer following the steps described in Chapter 4, *Replacement Procedures*, and perform the following checks:

Check 1 Make sure the cables are firmly connected to the Finger/pad board and system board.



If the connection is loose, reconnect firmly and repeat Procedure 1. If the problem still occurs, go to Check 2.

- Check 2 Touch PAD board or the cable may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*. If the problem still occurs, perform Check 3.
- Check 3 System board may be faulty. Replace it with a new one following the instructions in Chapter 4, *Replacement Procedures*.

2.19 Web camera Troubleshooting

To check if the computer's web camera is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Check on Windows OS

Procedure 2: Connector Check and Replacement Check

Procedure 1 Check on Windows OS

Web

Camera

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Use the software, Camera Assistant Software, which is originally prepared in the computer to check if the web camera can record/replay still images and moving images (including sound) without problems.

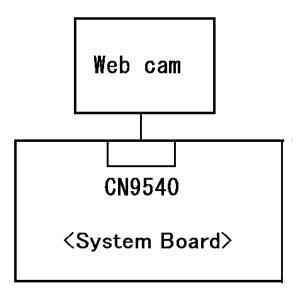
When the Camera Assistant Software is installed, the menu will stay on the screen but hide at the left edge of the screen. Move the pointer to the left on the screen to show the menu. When the menu appears, double-click the icon for Web Camera to operate the web camera.

If any troubles occur on recording/replaying of still or moving images, perform Procedure 2.

Procedure 2 Connector Check and Replacement Check

The connection of cables, web camera and microphone may be defective. Otherwise, they may be faulty. disassemble the computer following the steps described in Chapter 4 and perform the following checks.

Check 1 If the connection is loose, reconnect it firmly and check each connection. If the problem still occurs, perform Check 2.



- Check 2 The Web camera may be defective or damaged. Replace the drive with a new one. If there is still an error, go to Check 3.
- Check 3 System board may be faulty. Replace it with a new one following the step in Chapter 4 *Replacement Procedures*.

2.20 Intel Turbo Memory Troubleshooting (Not Used)

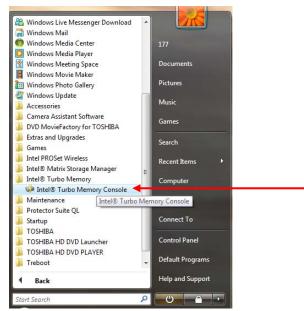
To check if Intel Turbo Memory is malfunctioning or not, follow the troubleshooting procedures below as instructed.

Procedure 1: Check on Windows OS

Procedure 2: Connector Check and Replacement Check

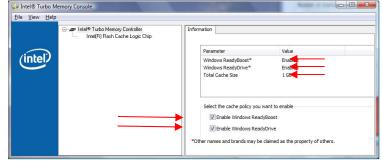
Procedure 1 Check on Windows OS

Use the software, Intel Turbo Memory Console, which is originally prepared in the computer to check if the Intel Turbo Memory is operating without problems.



Start the Intel Turbo Memory Console and confirm the followings:

- □ Check marks are attached to "Enable Windows ReadyBoost" and "Enable Windows ReadyDrive".
- □ The values for "Windows ReadyBoost" and "Windows ReadyDrive" are "Enabled" and "Total Cache Size" is "4GB".

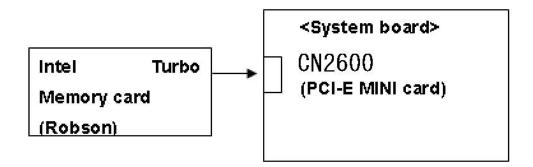


If any problems are found, perform the Procedure 2.

Procedure 2 Connector Check and Replacement Check

The connection of Intel Turbo Memory card may be faulty or the card may be defective. Disassemble the computer following the steps described in Chapter 4 and perform the following checks.

Check 1 Check the following connection. To disassemble the computer for the check, follow the steps described in Chapter 4. If the connection is loose, reconnect the card firmly. If the problem still occurs, perform Check 2.



- Check 2 The Intel Turbo Memory card may be faulty. Replace it with a new one following the steps in Chapter 4, *Replacement Procedures*, and check the operation again. If the problem still occurs, perform Check 3.
- Check 3 System board may be faulty. Replace it with a new one following the step in Chapter 4, *Replacement Procedures*.

Chapter 3

Tests and Diagnostics

[CONFIDENTIAL]

3

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3.1 The Diagnostic Test

This chapter explains how to use the Diagnostic Test programs to test the functions of the computer's hardware modules. The Diagnostics Programs are stored on some Diagnostic Disks. There are Service Program Modules (DIAGNOSTIC MENU) and the Test Program Modules (DIAGNOSTIC TEST MENU) on the Diagnostic Disk.

The Hardware Initial information Setting Tool consists of some programs that write the hardware information or displays the current information of the computer. It is also included in one of Diagnostic Disks.

The heatrun test is automatic test program that executes the some tests successively.

NOTE: Before starting the diagnostics, be sure to follow these steps:

- 1. Check all cables are connected firmly.
- 2. Exit any application and close Windows.
- 3. Check if [ALL Device] is selected in the "Device Config." in SET UP menu. After checking the diagnostics, be sure to select [Setup by OS] in the "Device Config."

3.1.1 Diagnostics menu

The DIAGNOSTIC MENU consists of the following functions.

- □ DIAGNOSTIC TEST
- ONLY ONE TEST
- □ HEAD CLEANING
- □ LOG UTILITIES
- □ RUNNING TEST
- □ FDD UTILITIES
- □ SYSTEM CONFIGURATION
- Device of POWER OFF

The DIAGNOSTIC TEST MENU contains the following functional tests:

SYSTEM TEST
MEMORY TEST
KEYBOARD TEST
DISPLAY TEST
FLOPPY DISK TEST
PRINTER TEST [It is not supported]
ASYNC TEST [It is not supported]
HARD DISK TEST

- □ REAL TIMER TEST
- NDP TEST
- EXPANSION TEST
- CD-ROM/DVD-ROM TEST
- □ ERROR RETRY COUNT SET [FDD & HDD]

Other tests are:

- □ Wireless LAN TEST (Wireless LAN TEST disk)
- LAN/Modem/Bluetooth/IEEE1394 TEST (LAN/Modem/Bluetooth/IEEE1394 TEST disk)
- □ Sound TEST (Sound TEST disk)

You will need the following equipment to perform some of the Diagnostic test programs.

- USB FDD
- □ The Diagnostic Disks (T&D for maintenance, LAN/Modem/Bluetooth/IEEE1394 for maintenance, wireless LAN for maintenance and Sound for maintenance)
- □ A formatted working disk (Floppy disk test)
- A cleaning kit to clean the floppy disk drive heads (Head Cleaning)
- An external display supporting monitor ID (Expansion test)
- A CD test media TOSHIBA CD-ROM TEST DISK or ABEX TEST CD-ROM (Sound test)
- A DVD test media (DVD-ROM TEST DISK TSD-1) (Sound test)
- A music CD (Sound test)
- □ A CD-RW test media (CD-ROM/DVD-ROM test)
- □ A USB test module (USB test)
- □ A USB cable (USB test)
- LAN wraparound connector (LAN test)
- □ RGB wraparound connector (Expansion test)
- □ Module cable and RJ11 connector checker (Modem test)
- □ Headphones (Sound test)
- □ A microphone (Sound test)
- □ A PC for wraparound test (Wireless LAN test/Bluetooth test/IEEE1394 test)
- □ PC card wraparound connector (Expansion test) [Not necessary for this model)

3.1.2 H/W (Hardware) initial information setting tool

The H/W initial information setting tool consists of the following programs.

- □ Initial configuration
- DMI information save
- **DMI** information recovery
- □ System configuration display
- E2PROM test (MAC/GUID/DMI)

You will need the following equipment to perform some of the programs.

□ The Diagnostics Disk (Main T&D)

3.1.3 Heatrun test program

The heatrun test starts automatically after the selection.

You will need the following equipment to perform this program.

□ The Diagnostics Disk (Main T&D)

3.2 Executing the Diagnostic Test

To start the Repair test program, follow these steps:

- 1. Insert the Repair test program disk in the USB floppy disk drive or Optical disk drive.
- 2. Turn on the computer while pressing **U** key. The following menu appears.

NOTE: The following menu is an example when Repair test program is performed from the floppy disk.

V*.**

Repair test program

- 1. DMI Entry utirity
- 2. Repair Heatrun (T&D)
- 3. Repair Main (T&D)

Enter a choice:

To start the Diagnostics menu (T&D), press **3** and **Enter**. To start the H/W initial information setting tool, press **1** and **Enter**. To start the Heatrun test, press **2** and **Enter**.

NOTE: When replacing the system board, be sure to execute the following procedures.
1. Before replacing the system board, execute subtest03 "DMI information save" in 3.4 Setting of the hardware configuration in order to save the DMI information from system board to floppy disk.
2. After replacing the system board, execute the subtest04 "DMI information recovery" and subtest08 "System configuration display" in 3.4 Setting of the hardware configuration in order to copy the DMI information and system information from the floppy disk.

3.2.1 Diagnostics menu (T&D)

Set the highlight bar to **3**, and press **Enter**. The following DIAGNOSTIC TEST MENU will appear:

TOSHIBA personal computer XXXXX DIAGNOSTICS version X.XX (c) copyright TOSHIBA Corp. 20XX DIAGNOSTICS MENU : 1 - DIAGNOSTIC TEST 2 - ONLY ONE TEST 3 -4 - HEAD CLEANING 5 - LOG UTILITIES 6 - RUNNING TEST 7 - FDD UTILITIES 8 - SYSTEM CONFIGURATION 9 - Power OFF 0 - Exit to Repair menu

NOTE: To exit the DIAGNOSTIC TEST MENU, press the Esc key. If a test program is in progress, press Ctrl + Break to exit the test program. If a test program is in progress, press Ctrl + C to stop the test program.

Set the highlight bar to **1**, and press **Enter**. The following DIAGNOSTIC TEST MENU will appear:

TOSHIBA personal computer XXXXXX DIAGNOSTICS version X.XX (c) copyright TOSHIBA Corp. 20XX DIAGNOSTIC TEST MENU : 1 - SYSTEM TEST 2 - MEMORY TEST 3 - KEYBOARD TEST 4 - DISPLAY TEST 5 - FLOPPY DISK TEST [It is not supported] 6 – PRINTER TEST 7 – ASYNC TEST [It is not supported] 8 – HARD DISK TEST 9 - REAL TIMER TEST 10 - NDP TEST 11 - EXPANSION TEST 12 - CD-ROM/DVD-ROM TEST 88 - ERROR RETRY COUNT SET [FDD & HDD] 99 - EXIT TO DIAGNOSTICS MENU

NOTE: Only when a 2nd HDD is installed in the computer, [There is a second hard disk] message appears in the display.

Functions 1 through 12 are the Diagnostic Tests. Function 88 sets the floppy disk drive and hard disk drive error retry count (0-255).

To exit the submenu of the Diagnostic Test and returns to the Diagnostics Menu, set the highlight bar to function 99 and press **Enter**.

Select the option you want to execute and press **Enter**. When you select 1-SYSTEM TEST, the following message will appear:

SYSTEM TEST NAME XXXXXX XXXXX DIAGNC [Ctrl]+[Break] [Ctrl]+[C]			
SUB-TEST : XX PASS COUNT : XXXXX ERROR COUNT: XXXXX WRITE DATA : XX READ DATA : XX ADDRESS : XXXXXX STATUS : XXX			
SUB-TEST MENU :			
01 - ROM checksum 02 - Fan ON/OFF 03 - Geyserville 04 - Quick charge 05 - DMI read 99 - Exit to DIAGNOSTIC TEST MENU			
	$\begin{array}{rccc} \uparrow \downarrow \longrightarrow & : & \text{Select items} \\ \text{Enter} & : & \text{Specify} \\ \text{Esc} & : & \text{Exit} \end{array}$		

NOTE: The menu displayed by your computer may be slightly different from the one shown above.

Select the desired subtest number from the subtest menu and press **Enter**. The following message will appear:

TEST LOOP : YES (or NO) ERROR STOP : YES (or NO)

Use the right and left arrow keys to move the cursor to the desired option.

Selecting **YES** of TEST LOOP increases the pass counter by one, each time the test cycle ends and restarts the test cycle.

Selecting **NO** returns the process to the subtest menu after the test is complete.

Use the up and down arrow keys to move the cursor to "ERROR STOP".

Use the right and left arrow keys to move the cursor to the desired option and press **Enter**.

Selecting **YES** of ERROR STOP stops the test program when an error is found and displays the operation guide on the right side of the display screen as shown below:

```
ERROR STATUS NAME [[ HALT OPERATION ]]
1: Test end
2: Continue
3: Retry
```

These three selections have the following functions respectively:

- 1. Terminates the test program and exits to the subtest menu.
- 2. Continues the test.
- 3. Restarts the test from the error.

Selecting **NO** keeps the test running even if an error is found. When an error occurred, the error status is displayed and one error is added to the error counter.

Table 3-1 in section 3.6 describes the function of each test on the subtest menu. Table 3-2 in section 3.19 describes the error codes and error status for each error.

3.2.2 H/W initial information setting tool

After selecting this test, the following menu appears in the display.

For more details on this test, refer to the section 3.3.

3.2.3 Heatrun test program

Heatrun test starts executing the same subtest as 3.23 RUNNING TEST.

For more details on this test, refer to the section 3.4.

3.3 Setting of the hardware configuration

To execute this program, input **1** in the startup menu. Then press **Enter** to select the (2)-Initial config set. The H/W initial information setting tool consists of four subtests. Input the number you want to execute and press **Enter**.

NOTE: Connect USB FDD, when you perform the Repair test program from the CD-ROM. DMI information on the subtest 02 is written in floppy disk.

Subtest 01 Entry of the DMI information

This subtest executes the following items and shows their contents in the display. When an item ends normally, the program proceeds automatically to the next one. When an error is found, the program stops and waits for key input. (After solving the problem, the program executes the item again.)

Setting of the CPU set table Setting of the micro code Setting of the EHSS Inputting and writing of DMI information

When the DMI information is displayed, the following messages appear in order. Input each information. (If you do not replace the PCB, the DMI information should not be changed.)

- 1. "Enter Model Name?" is displayed. Input the computer's model name and press **Enter**. (e.g. DynaBook)
- 2. "Enter Version Number?" is displayed. Input the computer's version number and press **Enter**. (e.g. PC18070C313S)
- 3. "Enter Serial Number?" is displayed. Input the computer's serial number and press **Enter**. (e.g. 12345678)
- 4. "Enter Model Number?" is displayed. Input the computer's sales model number and press **Enter**. (e.g. PP200-AAAA)
- "Enter Bundle Number?" is displayed. Input the computer's PCN/Bundle number and press Enter. (e.g. PMSREQ3Q34H/S0123456789)
- 6. "Write data OK (Y/N)?" is displayed. To write the DMI information to the Flash ROM, press **Y**, and then **Enter**.

7. "Create DMIINFO TXT (Y/N)?" is displayed. Press **Y**, then the DMI information (text data) is written to the Floppy disk, etc.

Setting of the HWSC Setting of the UUID Display of the DMI information (including UUID)

After completion of the above settings, H/W configuration & DMI information are appeared in order. Check the contents and press **Enter**.

Subtest 02 DMI information save

NOTE: Before replacing the system board, be sure to execute this subtest and save the DMI information to the floppy disk.

This is one of tools to copy the DMI information to a new PCB after replacing.

This subtest saves all the DMI data in a floppy disk.

Subtest 03 DMI information recovery

This is one of tools to copy the DMI information to a new PCB after replacing.

This subtest writes all the DMI data in the floppy disk into the new PCB.

NOTE: Since the data of UUID is updated every time when this subtest, DMI information recovery, is done, the saved UUID data is not written.

3.4 Heatrun Test

To execute this program, press **2**, Repair Heatrun and press **Enter** in the startup menu, press **Enter**.

After selecting this test, the same subtests as 3.23 RUNNING TEST is executed successively.

For more details on the procedure and test content, refer to RUNNING TEST.

When the heatrun test ends, following message appears in the display.

Press any key and return to the startup menu.

3.5 Subtest Names

Table 3-1 lists the subtest names for each test program in the DIAGNOSTIC TEST MENU.

No.	Test Name	Subtest No.	Subtest Name
1	SYSTEM 01		ROM checksum
		02	Fan ON/OFF
		03	Geyserville
		04	Quick charge
		05	DMI read
2	MEMORY	01	Conventional memory
		02	Protected Mode
		03	Protected Mode (cache off)
		04	Cache memory (on/off)
		05	Stress
3	KEYBOARD	01	Pressed key code display
4	DISPLAY	01	VRAM read/write for VGA
		02	Gradation for VGA
		03	Gradation for LCD
		04	Gradation & Mode test for VGA
		05	All dot on/off for LCD
		06	"H" pattern display
		07	LCD Brightness
5	FLOPPY DISK	01	Sequential read
		02	Sequential read/write
		03	Random address/data
		04	Write specified address
		05	Read specified address

Table 3-1 Subtest names (1/2)

No.	Test Name	Subtest No.	Subtest Name
6	PRINTER	01	Ripple pattern
	[Not supported]	02	Function
		03	Wraparound
7	ASYNC	01	FIR/SIR Point to point (send)
	[Not supported]	02	FIR/SIR Point to point (receive)
		03	Wraparound (board)
8	HARD DISK	01	Sequential read
		02	Address uniqueness
		03	Random address/data
		04	Cross talk & peak shift
		05	Partial Read
		06	Write specified address
		07	Read specified address
		08	Sequential write
		09	W-R-C specified address
9	REAL TIMER	01	Real time
		02	Backup memory
		03	Real time carry
10	NDP	01	NDP test
11	EXPANSION	01	PCMCIA wraparound [Not supported]
		02	RGB monitor ID
12	CD-ROM	01	Sequential read
	/DVD-ROM	02	Read specified address
		03	Random address/data
		04	RW 1point W/R/C

Table 3-1 Subtest names (2/2)

3.6 System Test

To execute the System Test select **1** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions on the screen. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtest 01 ROM checksum

This subtest executes a checksum test of the BIOS ROM (range: F0000h to FFFFFh, 64KB) on the System Board.

Subtest 02 Fan ON/OFF

This subtest turns on/off the fan motor by force with Fan ON/OFF commands.

The following message will appear.

Fan number select (1:FAN#1, 2:FAN#2, 0:FAN#1) ?

To check the CPU fan, press **1** and **Enter**. To check the VGA fan, press **2** and **Enter**. To check both CPU fan and VGA fan, press **0** and **Enter**.

The following message will appear.

Fan test execute now ... (CPU:xxxxRpm / GPU:xxxxRpm)

*** Test Fan Revolution 0000RPM start

Make sure the specified fan does not rotate and the message of fan revolution is "0000Rpm". Then press **Enter**.

The following message will appear.

*** Test Fan Revolution Low speed Start

Make sure the fan rotates at low speed, then press **Enter**.

The following message will appear.

*** Test Fan Revolution High speed Start

Make sure the fan rotates at high speed, then press **Enter**.

After a while, the fan rotating will stop.

Subtest 03 Geyserville

If the CPU supports Gerserville (SpeedStep), this Subtest checks that the CPU operating clock speed can be changed.

If the CPU does not support Gerserville (SpeedStep), the following message is displayed and the test is ended.

This chip is not supported

Subtest 04 Quick Charge

This subtest checks the status for the quick charge.

Subtest 05 DMI read

This subtest displays the information in the Flash-ROM in the following format.

To exit this subtest and return to the SYSTEM test menu, press Enter.

3.7 Memory Test

To execute the Memory Test, select **2** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions on the screen. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtest 01 Conventional memory

This subtest writes a constant data to conventional memory (0 to 640 KB), then reads the new data and compares the result with the original data.

Subtest 02 Protected Mode

NOTE: The CONFIG.SYS file must be configured without expanded memory manager programs such as EMM386.EXE, EMM386.SYS or QEMM386.SYS. Also, the HIMEM.SYS must be deleted from the CONFIG.SYS file.

This subtest writes constant data and address data (from 1MB to maximum MB), and reads the new data and compares the result with the original data.

Subtest 03 Cache memory (on/off)

To test the cache memory, a pass-through write-read comparison of '5Ah' data is run repeatedly to the test area ('7000': 'Program' size to '7000': '7FFF' (32 KB)) to check the hit-miss ratio (on/off status) for CPU cache memory. One test takes 3 seconds.

Number of misses < Number of hits \rightarrow OK Number of misses \ge Number of hits \rightarrow Fail

Subtest 04 Stress

Write/Read buffer (1 size = B30h) is prepared in the conventional memory. The data is made in the Write Buffer, the data in Write Buffer is written in the area of address of 1MB or after. The data is red in the Read Buffer and data is compared in area up to the maximum size.

3.8 Keyboard Test

To execute the Keyboard Test, select **3** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions on the screen. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtest 01 Pressed key code display

When a key is pressed, the scan code, character code, and key top name are displayed on the screen in the format shown below. The **Ins Lock**, **Caps Lock**, **Num Lock**, **Scroll Lock**, **Alt**, **Ctrl**, **Left Shift**, and **Right Shift** keys are displayed in reverse screen mode when pressed. The scan codes, character codes, and key top names are shown in Appendix D.

KEYBOARD TEST IN PROGRESS 302000

	Scan code	=		
	Character co	de =		
	Keytop	=		
Ins Lock	Caps Lock	Num Lock	Scroll Lock	
Alt	Ctrl	Left Shift	Right Shift	
PRESS [Enter] KEY				

3.9 Display Test

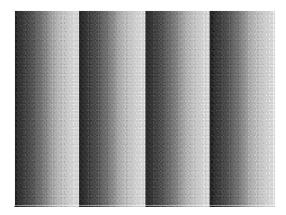
To execute the Display Test, select **4** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions on the screen. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtest 01 VRAM read/write for VGA

This subtest writes the constant data (AAAAh and 5555h) to the video RAM. The data is read and compared to the original data.

Subtest 02 Gradation for VGA

This subtest displays four colors: red, green, blue and white from left to right across the screen from black to maximum brightness. The display below appears on the screen, when this subtest is executed.



To exit this subtest and return to the DISPLAY TEST menu, press **Enter**.

Subtest 03 Gradation for LCD

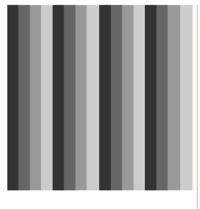
This subtest displays bands of gradations for mixed colors, then for red, green, and blue. Next, it displays eight solid colors full screen: red, semi-red, green, semi-green, blue, semi-blue, white, and semi-white. Each color displays for three seconds.

Subtest 04 Gradation & Mode test for VGA

This subtest displays gradations for following modes. To change the mode, press **Enter**.

[Mode [Mode [Mode	13]		
[Mode	111	640*480	64K]
[Mode	112	640*480	16M]
[Mode	114	800*600	64K]
[Mode	115	800*600	16M]
[Mode	117	1024*768	64K]
[Mode	118	1024*768	16M]

The display below appears on the screen when this subtest is executed.



[Mode 12]

(Display example: Mode 12)

To exit this subtest and return to the DISPLAY TEST menu, press **Enter** after displaying the Mode 118.

Subtest 05 All dot on/off for LCD

This subtest displays an all-white screen then an all-black screen. The display changes automatically every three seconds, then returns to the DISPLAY TEST menu.

Subtest 06 "H" Pattern Display

This subtest displays a full screen of "H" patterns.

To exit this subtest and return to the DISPLAY TEST menu, press Enter.

NOTE: The last row may not be completely filled. This condition does not indicate on error.

Subtest 07 LCD Brightness

The LCD brightness changes in the following order:

Super-Bright —> Bright —> Semi-Bright —> Bright —> Super-Bright

After displaying with Super-Bright of LCD brightness, return to the DISPLAY TEST menu.

3.10 Floppy Disk Test

CAUTION: Before running the floppy disk test, prepare a formatted work disk. Remove the Diagnostics Disk and insert the work disk into the FDD. The contents of the floppy disk will be erased.

To execute the Floppy Disk Test, select **5** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions displayed on the screen.

1. The following message will appear. Select the media mode and start track to be tested, then press **Enter.**

```
Test start track (Enter:0/dd:00-79) ?
```

 The Floppy Disk test contains five subtests that test the FDD. The floppy disk test menu will appear after you select FDD test parameters.

FLOPPY DISK	XXXXXXX	XXX DIAGNOSTIC TEST VX.XX [Ctrl]+[Break] : test end [Ctrl]+[C] : key stop			
PASS COUNT WRITE DATA	: XX READ	R COUNT : XXXXX DATA : XX US : XXX			
<pre>SUB-TEST MENU : 01 - Sequential read 02 - Sequential read/write 03 - Random address/data 04 - Write specified address 05 - Read specified address 99 - Exit to DIAGNOSTIC TEST MENU</pre>					

<u>↑↓→←</u>	:	Select items
Enter	:	Specify
Esc		Exit

Select the number of the subtest you want to execute and press **Enter**. The following message will appear during the floppy disk test.

FLOPPY DISK	IN PROGRESS	XXXXXXX	<pre>xxx DIAGNOSTIC TEST VX.XX [Ctrl]+[Break] : test end [Ctrl]+[C] : key stop</pre>
SUB-TEST PASS COUNT WRITE DATA ADDRESS	: XX : XXXXX : XX : XXXXXX	ERROR (READ DA STATUS	ATA : XX

When the subtest 04 or 05 is selected, the following messages will appear on the screen. Select the test data (subtest 04 only), track number and head number you want to test.

Test data ?? (subtest 04 only) Track No. ?? Head No. ?

Subtest 01 Sequential read

This subtest performs a Cyclic Redundancy Check (CRC) that continuously reads all the tracks (track: 0 to 39/0 to 79) on a floppy disk.

Subtest 02 Sequential read/write

This subtest continuously writes data pattern B5ADADh to all the tracks (track: 0 to 39/0 to 79) on a floppy disk. The data is then read and compared to the original data.

Subtest 03 Random address/data

This subtest writes random data to random addresses on all tracks (track: 0 to 39/0 to 79) on a floppy disk. The data is then read and compared to the original data.

Subtest 04 Write specified address

This subtest writes the data specified by an operator to a specified track, head, and address.

Subtest 05 Read specified address

This subtest reads data from a track, head, and address specified by an operator.

3.11 Printer Test

CAUTION: Printer Test is not supported for this model.

To execute the Printer Test, select **6** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions on the screen.

NOTE: An IBM compatible printer must be connected to the system to execute this test. Also, printer port wraparound connector must be connected.

The following message will appear, after selecting the subtest 01 to 03 of the printer test:

```
channel#1 = XXXXh
channel#2 = XXXXh
channel#3 = XXXXh
Select the channel number (1-3) ?
```

The printer I/O port address is specified by the XXXXh number. The computer supports three printer channels. Select the printer channel number, and press **Enter** to execute the selected subtest.

Subtest 01 Ripple Pattern

This subtest prints characters for codes 20h through 7Eh line-by-line while shifting one character to the left at the beginning of each new line.

:"#\$%f'()*+,/0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXYZ[\]^_`abcdefghijklmno
:"#\$%f'()*+,/0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXY2[\]^_abcdefghijk1mnop
"#\$%E'()*+,/0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXYZ[\]^_`abcdefghijklmnopg
<pre>#\$%f'()*+,/0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXYZ[\]^_`abcdefghijklmnopqr</pre>
<pre>\$%f'()*+,/0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXYZ[\]^_`abcdefghijklmnopqrs</pre>
<pre>%E'()*+,/0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXY2[\]^_`abcdefghijklmnopgrst</pre>
f'()*+,/0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXYZ[\]^_`abcdefghijklmnopqrstu
'()*+,/0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXY2[\]^_`abcdefghijklmnopqrstuv
()*+,/0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXYZ[\]^_`abcdefghijklmnopqrstuvw
)*+,/0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXY2[\]^_`abcdefghijklmnopqrstuvwx
*+,/0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXY2[\]^_`abcdefghijklmnopqrstuvwxy

Subtest 02 Function

This subtest is for IBM compatible printers, and tests the following functions:

Normal print Double-width print Compressed print Emphasized print Double-strike print All characters print

This subtest prints the various print types shown below:

PRINTER TEST
1. THIS LINE SHOWS NORMAL PRINT.
2. THIS LINE SHOWS DOUBLE-WIDTH PRINT.
3. THIS LINE SHOWS COMPRESSED PRINT.
4. THIS LINE SHOWS EMPHASIZED PRINT.
5. THIS LINE SHOWS DOUBLE-STRIKE PRINT.
6. ALL CHARACTERS PRINT
!"#\$\$&'()*+,./0123456789:;<=>?@ABCDEFGHIJKLMNOPQRSTUVWXYZ[\]^_`abcdefghijklmn
opgrstuvwxyz[]>~

Subtest 03 Wraparound

NOTE: To execute this subtest, a printer wraparound connector must be connected to the computer's printer port.

This subtest checks the output and bi-directional modes of the data control and status lines through the parallel port wraparound connector (34M741986G01). (Both output and bi-directional modes are tested.)

3.12 Async Test

CAUTION: Printer Test is not supported for this model.

To execute the Async Test, select **7** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions displayed on the screen. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtests 01 and 02 require the following data format:

Method:AsynchronousSpeed:38400BPSData:8 bits and one parity bit (EVEN)Data pattern:20h to 7Eh

Subtest 01 FIR/SIR Point to point (send)

NOTE: To execute subtests 01 and 02, each computer must have access to the other computer's infrared port.

This subtest sends 20h through 7Eh data to the receive side, then receives the sent data and compares it to the original data through the FIR/SIR port.

Subtest 02 FIR/SIR Point to point (receive)

This subtest is used with subtest 01 described above. This subtest receives the data from the send side, then sends the received data through the FIR/SIR port.

Subtest 03 Wraparound (board)

NOTE: To execute this subtest, a RS-232C wraparound connector must be connected to the RS-232C port.

This subtest checks the data send/receive function through the wraparound connector.

3.13 Hard Disk Test

To execute the Hard Disk Test, select **8** from the DIAGNOSTIC TEST MENU, press **Enter**, and follow the directions on the screen.

CAUTION: The contents of the hard disk will be erased when subtest 02, 03, 04, 06, 08 or 09 is executed. Before running the test, the customer should transfer the contents of the hard disk to floppy disk or another hard disk. If the customer has not or cannot perform the back-up, create back-up disks as described below.

> Check to see if the Microsoft Create System Disks Tools (MSCSD.EXE) still exists in the System Tools Folder. (This tool can be used only once.) If it exists, use it to back up the pre-installed software, then use the Backup utility in the System Tools folder to back up the entire disk, including the user's files.

Refer to the operating system instructions.

When a 2nd HDD is installed, the following messages will appear after selecting the hard disk test from the DIAGNOSTIC TEST MENU.

Test	drive	number	select	(1:HDD#1,	2:HDD#	2, 0:	HDD	#1&2) ?
					:		:	Select items Specify Exit

- 1. Input the number of HDD test and press **Enter**.
- 2. This message is used to select the error dump operation when a data compare error is detected. Select **1** or **2**.

Data compare error dump (1:no, 2:yes)

3. This message is used to select whether or not the HDD status is displayed on the screen. The HDC status is described in section 3.20. Select **1** or **2**.

```
Detail status display (1:no, 2:yes)
```

4. The Hard Disk Test message will appear after you respond to the Detail Status prompt. Select the number of the subtest you want to execute and press **Enter**. The following message will appear during each subtest.

HARD DISK TEST	XXXXXXX		NOSTIC TEST VX.XX [Break] : test end [C] : key stop
SUB TEST	: XX	. <u></u>	
PASS COUNT	: XXXXX	ERROR COUNT	: XXXXX
WRITE DATA	: XX	READ DATA	: XX
ADDRESS	: XXXXXX	STATUS	: XXX

The first three digits of the ADDRESS indicate which cylinder is being tested, the fourth digit indicates the head and the last two digits indicate the sector.

The first digit of the STATUS number indicates the drive being tested and the last two digits indicate the error status code as explained in table 3-2 of the section 3.19.

Subtest 01 Sequential read

This subtest is a sequential reading of all the tracks on the HDD starting at track 0. When all the tracks on the HDD have been read, the test starts at the maximum track and reads the tracks on the HDD sequentially back to track 0.

Subtest 02 Address uniqueness

This subtest writes unique address data to each sector of the HDD track-bytrack. The data written to each sector is then read and compared with the original data. There are three ways the HDD can be read:

- 1. Forward sequential
- 2. Reverse sequential
- 3. Random

Subtest 03 Random address/data

This subtest writes random data in a random length to random addresses. This data is then read and compared to the original data.

Subtest 04 Cross talk & peak shift

This subtest writes eight types of worst pattern data (listed below) to a cylinder, then reads the data while moving from cylinder to cylinder. (Test the data interference in the neighbor track)

Worst pattern data	Cylinder
'B5ADAD'	0 cylinder
'4A5252'	1 cylinder
'EB6DB6'	2 cylinder
'151149'	3 cylinder
'63B63B'	4 cylinder
'9C49C4'	5 cylinder
'2DB6DB'	6 cylinder
'D25114'	7 cylinder

Subtest 05 Partial Read

This subtest reads 1GB data that is in minimum, middle and maximum address of the HDD area.

Subtest 06 Write specified address

This subtest writes specified data to a specified cylinder and head on the HDD.

Subtest 07 Read specified address

This subtest reads data, which has been written to a specified cylinder and head on the HDD.

Subtest 08 Sequential write

This subtest writes specified 2-byte data to all of the cylinders on the HDD.

Subtest 09 W-R-C specified address

This subtest writes data to a specified cylinder and head on the HDD, then reads the data and compares it to the original data.

3.14 Real Timer Test

To execute the Real Timer Test, select **9** from the DIAGNOSTIC TEST MENU, press **Enter** and follow the directions on the screen. Move the highlight bar to the subtest you want to execute and press **Enter**.

Subtest 01 Real time

A new date and time can be input during this subtest. To execute the real time subtest, follow these steps:

1. Select subtest 01 and the following messages will appear:

Current date : XX-XX-XXXX Current time : XX:XX:XX Enter new date: PRESS [ENTER] KEY TO EXIT TEST

- 2. If the current date is not correct, input the correct date at the "Enter new date" prompt and press **Enter**.
- 3. The following messages will appear:

Current date : XX-XX-XXXX Current time : XX:XX:XX Enter new time: PRESS [ENTER] KEY TO EXIT TEST

4. If the current time is not correct, input the correct time in 24-hour format. To enter ":", press **Shift + ;**. The time is updated.

To exit the test, press **Enter**.

Subtest 02 Backup memory

This subtest checks the following backup memories:

Writes 1-bit of "on" data (01h through 80h) to address 0Eh through 7Fh

Writes 1-bit of "off" data (FEh through 7Fh) to address 0Eh through 7Fh

Writes the data pattern AAh and 55h to the address 0Eh to 7Fh

Then the subtest reads and compares this data with the original data.

Subtest 03 Real time carry

CAUTION: When this subtest is executed, the current date and time are erased.

This subtest checks the real time clock increments, making sure the date and time are displayed in the following format:

Current date : 12-31-1999 Current time : 23:59:58

The real time increments are automatically executed and the following is displayed:

Current date : 01-01-2000 Current time : 00:00:00 PRESS [Enter] KEY TO EXIT TEST

To exit the test, press **Enter**.

3.15 NDP Test

To execute the NDP test, select **10** from the DIAGNOSTICS TEST MENU, press **Enter** and follow the directions on the screen.

CAUTION: Judge the existence of high-speed operation processor by 1bit of the composition byte. If exists, the bit is "1". Test only when the high-speed operation processor exists.

Subtest 01 NDP test

This test checks the following functions of NDP:

- □ Control word
- □ Status word
- Bus
- □ Addition
- □ Multiplication

3.16 Expansion Test

To execute the expansion test, select **11** from the DIAGNOSTICS TEST MENU, press **Enter** and follow the directions on the screen.

Subtest 01 PCMCIA wraparound [It is not supported]

CAUTION: PCMCIA wraparound test is not supported for this model.

NOTE: To execute this subtest, the PC card wraparound connector is required.

This subtest checks the following signal line of the PC card slot:

- □ Address line
- □ REG#, CE#1, CE#2 line
- Data line
- □ Speaker line
- □ Wait line
- □ BSY#, BVD1 line

This subtest is executed in the following order:

Sub#	Address	Good	Bad	Contents
01	00001 00001	nn nn	xx xx	Address line REG#, CE#1, CE#2 nn=A0, 90, 80, 00
02	00002	ww	rr	Data line ww=write data, rr=read data
03	00003			Speaker line
04	00004	40,80	хх	Wait line (40 <xx<80)< td=""></xx<80)<>
05	00005	nn	ХХ	Other lines (BSY#, BVD1) NN=21, 00

NOTE: Select the subtest number01, The following message will appear: Test slot number select (1:slot0, 2:slot1, 0:slot0&1)? Subtest 02 RGB monitor ID

NOTE: To execute this subtest, monitor supporting EDID (Extended Display Identification Data) is required.

Connect a wraparound connector to CRT monitor for the test of ID acquisition. This subtest is executed by using VESA command.

CAUTION: It becomes NG because the priority is given to the internal monitor in a simultaneous display mode.

3.17 CD-ROM/DVD-ROM Test

To execute the CD-ROM/DVD-ROM test, select **12** from the DIAGNOSTICS TEST MENU, press **Enter** and follow the directions on the screen.

NOTE: For the subtest 01, 02 and 03, use the TOSHIBA CD-ROM TEST DISK TDY-01 or ABEX TEST CD-ROM TCDR-702 and DVD-ROM TEST DISK TSD-1.

Subtest 01 Sequential read

This subtest is a sequential reading of one-block units (2K bytes) of all the logical addresses.

Subtest 02 Sequential read (CD)

This subtest is a sequential reading of all the logical addresses.

Subtest 03 Sequential read (DVD)

This subtest is a sequential reading of all the logical addresses.

NOTE: It is the way of making the test data of the CD-ROM/DVD-ROM test for 2 of sub test, 3. A data-organization tool, "FMAKE.EXE", is added to the T&D test media of CD or FD. The manner of use starts up a prompt from the accessories of Windows XP or Vista and executes. it with the DOS window. Because a result, an about 5 GB test data are created, using the tool of the various Windows, it makes the test media of the CD or the DVD be complete. CDDTEST0.DAT..... It writes only this dater in one sheet of CD-R, CD-RW. DVDTEST1.DAT..... It writes all of the daters from 1 to 5 in one sheet of DVD-R, DVD-RW DVDTEST2.DAT..... DVDTEST3.DAT..... DVDTEST4.DAT..... DVDTEST5.DAT..... When starting up this tool, the hard disk needs equal to or more than 5 GB room.

3.18 Error Code and Error Status Names

Table 3-2 lists the error codes and error status names for the Diagnostic Test.

Device name	Error code	Error status name
(Common)	FF	Data Compare Error
System	01 03 04 05 06 07 08 09 10	ROM - CHECKSUM ERROR ROM - SERIAL ID WRITE ERROR ROM - NOT SUPPORTED PS-SYSTEM ROM - SENSING ERROR(AC-ADAPT) ROM - SENSING ERROR(1st Batt) ROM - SENSING ERROR(2nd Batt) ROM - THORMISTOR ERROR(1) ROM - THORMISTOR ERROR(2) ROM - THORMISTOR ERROR(3)
Memory	01 02 DD	RAM - PARITY ERROR RAM - PROTECTED MODE NO CHANGE RAM - CACHE MEMORY ERROR
Keyboard	FE FD F0 F1 F2 F3 F4 F5 F6 F7 F8 F9 FA EF ED	USB - GET DESCR.ERROR (FIRST) USB - SET ADDRESS ERROR HUB - GET DESCR.ERROR(Top 8B) HUB - GET DESCR.ERROR (Whole) HUB - SET CONFIGURATION ERROR HUB - GET DESCR.ERROR(DESCR.) HUB - GET DESCR.ERROR(PON) HUB - GET STATUS ERROR HUB - SET FEATURE ERROR(RESET) HUB - CLEAR FEATURE ERROR HUB - CLEAR FEATURE ERROR HUB - SET FEATURE ERROR HUB - SET FEATURE ERROR HUB - CLEAR FEATURE ERROR HUB - CLEAR FEATURE ERROR HUB - CLEAR FEATURE ERROR USB - OVER CURRENT ERROR USB - GET DESCR.ERROR(SECOND)
Display	EE	VRAM SIZE NOT SUPPORT

Table 3-2 Error codes and error status names $(1/3)$
--

Device name	Error code	Error status name
FDD	01 02 03 04 08 09 10 20 40 80 60 06 EE	FDD - BAD COMMAND ERROR FDD - ADDRESS MARK NOT FOUND FDD - WRITE PROTECTED FDD - RECORD NOT FOUND FDD - DMA OVERRUN ERROR FDD - DMA BOUNDARY ERROR FDD - CRC ERROR FDD - CRC ERROR FDD - FDC ERROR FDD - SEEK ERROR FDD - SEEK ERROR FDD - TIME OUT ERROR FDD - NOT DRIVE ERROR FDD - MEDIA REMOVED FDD - WRITE BUFFER ERROR
Printer	01 08 10 20 40 80	PRT - TIME OUT PRT – FAULT PRT - SELECT LINE PRT - OUT OF PAPER PRT - POWER OFF PRT - BUSY LINE
ASYNC	01 02 04 08 10 20 40 80 80 88 05 06	RS232C - [DTR ON] TIME OUT RS232C - [CTS ON] TIME OUT RS232C - [RX READY] TIME OUT RS232C - [TX FULL] TIME OUT RS232C - PARITY ERROR RS232C - FRAMING ERROR RS232C - FRAMING ERROR RS232C - OVERRUN ERROR RS232C - OVERRUN ERROR RS232C - LINE STATUS ERROR SIR - TIME OUT ERROR FIR - TIME OUT ERROR
HDD	05 07 09 0B BB 08 01 02 04 10 20 40 80 11 AA	HDD - HDC NOT RESET ERROR HDD - DRIVE NOT INITIALIZE HDD - DMA BOUNDARY ERROR HDD - BAD TRACK ERROR HDD - UNDEFINED ERROR HDD - OVERRUN ERROR (DRQ ON) HDD - BAD COMMAND ERROR HDD - ADDRESS MARK NOT FOUND HDD - ADDRESS MARK NOT FOUND HDD - RECORD NOT FOUND ERROR HDD - ECC ERROR HDD - ECC ERROR HDD - SEEK ERROR HDD - TIME OUT ERROR HDD - ECC RECOVER ENABLE HDD - DRIVE NOT READY

Device name	Error code	Error status name
(HDD)	CC E0 0A EE DA 12	HDD - WRITE FAULT HDD - STATUS ERROR HDD - BAD SECTOR HDD - ACCESS TIME ERROR HDD - NO HDD HDD - DMA CRC ERROR
NDP	01 02 03 04 05 06	NDP - NO CO-PROCESSOR NDP - CONTROL WORD ERROR NDP - STATUS WORD ERROR NDP - BUS ERROR NDP - ADDITION ERROR NDP - MULTIPLAY ERROR
EXPANSION	C1 C3 C4 C5 C6 C7 C8 CB CB CC CE CF	ADDRESS LINE ERROR CE#1 LINE ERROR CE#2 LINE ERROR DATA LINE ERROR WAIT LINE ERROR BSY# LINE ERROR BVD1 LINE ERROR ZV-Port ERROR NO PCMCIA CARD TYPE ERROR ZV_CONT# ERROR
CD-ROM /DVD-ROM	01 02 03 04 05 06 09 11 20 40 80 90 B0	BAD COMMAND ILLEGAL LENGTH UNIT ATTENTION MEDIA CHANGE REQUEST MEDIA DETECTED ADDITIMAL SENSE BOUNDARY ERROR CORRECTED DATA ERROR DRIVE NOT READY SEEK ERROR TIME OUT RESET ERROR ADDRESS ERROR

Table 3-2	Error codes	s and error	status na	umes (3/3)
-----------	-------------	-------------	-----------	------------

3.19 Hard Disk Test Detail Status

When an error occurs in the hard disk test, the following message is displayed:

HDC status = XXXXXXXX

Detailed information about the hard disk test error is displayed on the screen by an eight-digit number. The first four digits represent the hard disk controller (HDC) error status number and the last four digits are not used.

The hard disk controller error status is composed of two bytes; the first byte displays the contents of the HDC status register in hexadecimal form and the second byte displays the HDC error register.

The contents of the HDC status register and error register are listed in Tables 3-3 and 3-4.

Bit	Name	Description
7	BSY (Busy)	"0" HDC is ready. "1" HDC is busy.
6	DRY (Drive ready)	"0" Hard disk drive is not ready to accept any command. "1" Hard disk drive is ready.
5	DWF (Drive write fault)	"0" DWF error is not detected. "1" Write fault condition occurred.
4	DSC (Drive seek complete)	"0" The hard disk drive heads are not settled over a track. "1" The hard disk drive heads are settled over a track.
3	DRQ (Data request)	"0" Drive is not ready for data transfer. "1" Drive is ready for data transfer.
2	COR (Corrected data)	"0" Not used "1" Correctable data error is corrected.
1	IDX (Index)	"0" … Not used "1" … Index is sensed.
0	ERR (Error)	"0" Normal "1" The previous command was terminated with an error.

Table 3-3 Hard disk controller status register contents

Bit	Name	Description
7	BBK (Bad block mark)	"0" Not used "1" A bad block mark is detected.
6	UNC (Uncorrectable)	"0" There is no uncorrectable data error. "1" Uncorrectable data error has been detected.
5		Not used
4	IDN (Identification)	"0" Not used "1" There is no ID field in the requested sector.
3		Not used
2	ABT (Abort)	"0" Not used "1" Illegal command error or command abort.
1	TK0 (Track 0)	"0" The hard disk found track 0 during a recalibrate command.
		"1" The hard disk could not find track 0 during a recalibrate command.
0		Not used

3.20 ONLY ONE TEST

3.20.1 Program Description

This program tests the unique functions of this model.

3.20.2 Operations

Select test **2** from the DIAGNOSTIC MENU and press **Enter**. The following menu appears in the display.

```
########
          ONLY ONE TEST Menu
                                 ########
*
  1 ..... Pressed Key Display
                                     *
  2 ..... Touch pad
  3 ..... Wireless communication Switch
  4 ..... USB Port select menu
  5 .... LED
  6 .... Button
  7 ..... Acceleration sensor
  8 ..... Docker Dock/Undoc
  9 ..... Fan control
  A ..... E2PROM (Internal MAC)
*
  B ..... Intel AMT
  C..... Intel Shirley Peak (MAC)
*
  D ..... SD Card (R5C833 Writh/Read)
*
  99 ..... Exit to Common Test
.... Press test number [1-9, A-D, 99] ?
```

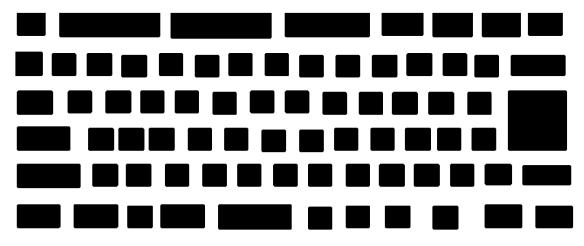
Select the subtest number you want to test and press Enter.

To return to the DIAGNOSTIC TEST menu, select **99** and press **Enter**.

Subtest 01 Pressed Key Display

When you execute this subtest, the keyboard layout is drawn on the display as shown below. When any key is pressed, the corresponding key on the screen changes to the key character that was pressed. Holding a key down enables the auto-repeat function that causes the key's display character to blink.

Press **Del + Enter** to end the test.



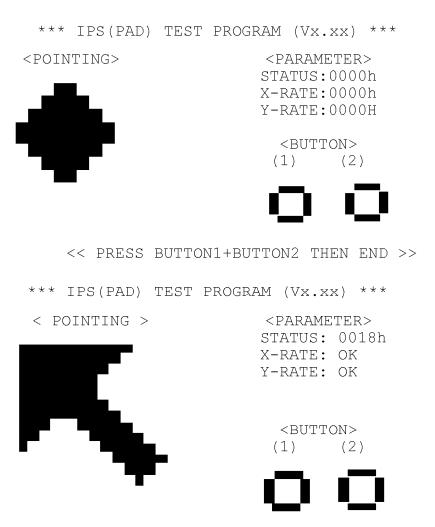
IF TEST OK, Press [Dell][Enter]key

Subtest 02 Touch Pad

This subtest checks the functions of the touch pad as shown below.

- A) Direction and parameter
- B) Switching function check.

This test displays the response from the touch pad and touch pad switch. When moving your finger on the touch pad towards the upper left, the <POINTING> display changes according to the following illustration. If a touch pad switch is pressed, the <BUTTONS> displays appear on the right side one by one. The parameters appear above the <BUTTONS> (1) or (2) corresponding to the pressed touch pad switch highlights. To end this subtest, press two touch pad switches at the same time.



<< PRESS BUTTON1+BUTTON2 THEN END >>

Subtest 03 Wireless communication Switch

This subtest checks if the Wireless communication switch works properly.

If the test is started with the switch ON, following message appears in the display.

```
Wireless communication Switch is set to a start position (OFF)
```

Slide the switch to OFF position. Then, following message appears in the display.

```
Wireless communication Switch ON !!
```

Slide the switch to ON position. Then, following message appears in the display.

```
Wireless communication Switch OFF !!
```

After Sliding the switch to OFF position, return to the ONLY ONE TEST menu automatically.

Subtest 04 USB

NOTE: When executing this subtest, USB test module and USB cable must be connected.

This subtest checks if USB port works properly.

The following menu appears in the display.

```
########
         Port Select menu
                               ######
*
  0 ..... Port 0 (Right side )
                                  *
*
  1 ..... Port 1 (Left side back)
  2 . . . . . . . . . . . . . . .
          Port 2 (Left side front)
  9
          Exit
.... Press test number [0-2, 9] ?
```

Connect the USB test module and USB cable to the computer.

Input the port test number and press **Enter**.

OK message appears in the display if the test ends without fail.

NG message appears in the display if an error is found during the test. Confirm the connection of cable, and then execute the test again.

Press **9** and **Enter** to return to ONLY ONE TEST menu.

Subtest 05 LED

This subtest checks if each LED lights properly.

The following message appears in the display in order. Follow the instructions in the display to execute the test.

[HDD Access LED test]

Confirm the LED of HDD status blinks properly.

Press any key and following message appears in the display.

[Caps/Num/Overlay BT/W-LAN LED test]

Confirm each LED lights properly.

(1)	Press	[Caps	Lock]	key	!	Caps	(on/off)
(2)	Press	[Fn +	F10]	key	!	Arrow	(on/off)
(3)	Press	[Fn +	F11]	key	!	Num	(on/off)
(4)	Slide	[BT/W-	-LAN s	SWI	itch	L۵	2R]!	(on/off)

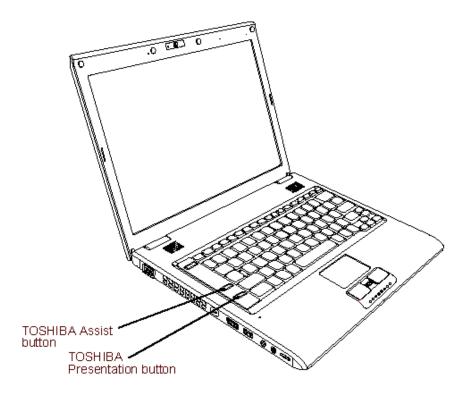
Press Enter and following message appears in the display.

Check [DC-IN]&[Power]&[Main Battery]LED= Green

Check if the each LED lights in the same color as the message in the display (Message switches Green <-> Orange).

Press **Enter** and return to the ONLY ONE TEST menu.

Subtest 06 Button



This subtest checks the moving of the of the front operation panel button.

Press the Toshiba Assist button and Back light On/Off button after the following message appears.



Press Function button (Toshiba Assist button)

OK message appears in the display if the test ends without an error.

Press any key return to each Steps if NG! or Press any key message apprears.

Press the Toshiba Presentation button after the following message appears.

Step2



Press Function button (Toshiba Presentation button)

OK message appears in the display if the test ends without an error.

Press any key return to each Steps if NG! or Press any key message apprears.

The following message appears in the display.

< -----> Volume Down -----> Volume Up!

Step5

Volume dial is turned to the right.

OK message appears in the display if the test ends without an error.

*

*

Press any key return to each Steps if NG! or Press any key message apprears

*	<	Volume Down
*	>	Volume Up!

Step6

Volume dial is turned to the left.

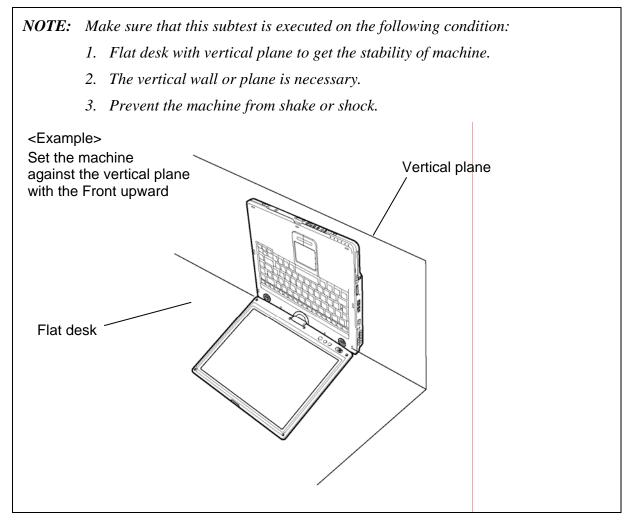
OK message appears in the display if the test ends without an error.

Press any key return to each Steps if NG! or Press any key message apprears.

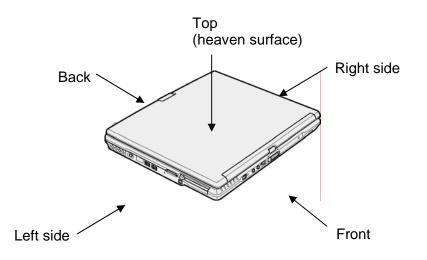
If the test ends successfully, the display returns to the ONLY ONE TEST menu.

Subtest 7 Acceleration sensor

This subtest detects and corrects the each axis (X, Y, Z).



The figure below shows the name and position of each side.



When this subtest is selected, the following message appears in the display.

The heaven surface establishes in the upper direction Press [Enter] key

NOTE: Be sure to execute the test with the display panel opened.

Set the machine on the flat desk. Then press **Enter** to detect the data on this setting of machine. The following message appears in the display.

```
The back establishes in the upper direction Press [Enter] key
```

Set the machine against the vertical plane on the flat desk with the back of machine upward. Then press **Enter** to detect the data on this setting of machine. The following message appears in the display.

```
The right establishes in the upper direction Press [Enter] key
```

Set the machine against the vertical plane on the flat desk with the right side of machine upward. Then press **Enter** to detect the data on this setting of machine. The following message appears in the display.

```
The front establishes in the upper direction Press [Enter] key
```

Set the machine against the vertical plane on the flat desk with the front of machine upward. Then press **Enter** to detect the data on this setting of machine. The following message appears in the display.

```
The left establishes in the upper direction Press [Enter] key
```

Set the machine against the vertical plane on the flat desk with the left side of machine upward. Then press **Enter** to detect the data on this setting of machine.

When there is no defective during the all checks above, the following message appears in the display. Then press **Enter** and return to the Only One Test menu.

```
** Setting OK! **
Press [Enter] key
```

When any trouble in the above setting is found, the following message appears and the test halts. Then press **Enter** and return to the Only One Test menu.

```
** Setting ERROR! **
Press [Enter] key
```

Rev B

Subtest 8 Docker Dock/Undock

This subtest is executed with an Slim Port Replicator II. installed.

Press **Enter** while pushing the eject button of the Slim Port Replicator II. the following message appears.

Pushing Eject-SW, and press [Enter] Key

Press **Enter** without pushing the eject button of the Slim Port Replicator II. after the following message appears.

Release Eject-SW, and press [Enter] Key

If the test ends successfully, the display returns to the ONLY ONE TEST menu.

When the display returns to the ONLY ONE TEST menu, remove the Express Port Replicator from the computer.

Subtest 09 Fan control

This subtest checks if FAN works properly.

The following message appears in the display in order.

! Start low-speed rotation......Waits 8 seconds

! Start reading of rotation......Waits 3 seconds

! Start Hight-speed rotation.......Waits 8 seconds

! Start reading of rotation......Waits 3 seconds

FAN Low-speed----> Target Low: 3900 Rpm Result Low: XXXX Rpm OK!

FAN High-speed---> Target High: 3800 Rpm Result High: XXXX Rpm OK!

OK message appears in the display if the test ends without a defective.

NG message appears in the display if a defective is found during the test.

Subtest A E2PROM (Internal MAC)

It checks whether the MAC address..

Subtest B Intel AMT

It checks whether the Intel AMT corde versions information are written. Intel Kedron is required for an Intel AMT check. BIOS should be Intel AMT correspondence.

Subtest C Intel Shirley Peak (MAC)

The functional check of Shirley Peak and a MAC Address check are carried out.

Subtest D **SD Card (R5C833 Writh/Read)** The functional check of SD Card.

> Enter the E key and insert an SD card. Pressing any key will start the test.

If the test result is O.K., remove the SD card.

If it is NG, check the error message.

NOTE:SD card specifications which can be used for this test are shown below.

- Classical SD Card (V1.00) for Normal Speed (max 25MHz)
- High Speed SD Card (V1.10 optional) for High Speed (max 50MHz)

- SDHC (>= 4GB) Supported

* SDIO devices are not supported

As for the SD card specification which can be used in WINDOWS, check the product specification.

3.21 Head Cleaning

3.21.1 Function Description

This function cleans the heads in the FDD by executing a series of head load/seek and read operations. A cleaning kit is necessary to perform this program.

3.21.2 Operations

1. Selecting test **4** from the DIAGNOSTIC MENU and pressing **Enter** displays the following messages:

DIAGNOSTICS - FLOPPY DISK HEAD CLEANING : VX.XX Mount cleaning disk(s) on drive(s). Press any key when ready.

- 2. Remove the Diagnostics Disk from the FDD, then insert the cleaning disk and press **Enter**.
- 3. When the "cleaning start" message appears, the FDD head cleaning has begun.
- 4. The display automatically returns to the DIAGNOSTIC MENU when the program is completed.

3.22 Log Utilities

3.22.1 Function Description

This function logs error information generated while a test is in progress and stores the results in RAM. This function can store data on a floppy disk or output the data to a printer.

NOTE: Connect USB FDD, when you perform the DIAGNOSTIC PROGRAM from the DVD-ROM. The data is stored in floppy disk.

The error information is displayed in the following order:

- 1. Error count (CNT)
- 2. Test name, Subtest number (TS-No)
- 3. Pass count (PASS)
- 4. Error status (STS)
- 5. FDD/HDD or memory address (ADDR)
- 6. Write data (WD)
- 7. Read data (RD)
- 8. HDC status (HSTS)
- 9. Error status name (ERROR STATUS NAME)

If the power switch is turned off, the error information will be lost.

3.22.2 Operations

1. Select **5** and press **Enter** in the DIAGNOSTIC MENU, logs error information into RAM or onto a floppy disk. The error information is displayed in the following format:

```
XXXXX ERRORS
CNT
     TS-NO
             PASS STS
                        ADDR
                                WD RD HSTS [ERROR STATUS NAME]
001
     FDD 02 0000 103
                        00001
                                00 00 0000 FDD-WRITE PROTECTED
001
     FDD 01 0000 180
                        00001
                                00 00 0000 FDD-TIME OUT ERROR
                       Address
                                     HDC status
                Error status
             Pass count
                                   Read data
         Subtest number
                                                 Error status name
                                Write data
      Test name
```

Error count

[[1:Next,2:Prev,3:Exit,4:Clear,5:Print,6:FD Log Read,7:FD Log Write]]

2. The error information displayed on the screen can be manipulated by the following number keys:

The **1** key scrolls the display to the next page.

- The **2** key scrolls the display to the previous page.
- The **3** key returns to the Diagnostic Menu.
- The **4** key erases all error log information in RAM.
- The **5** key outputs the error log information to a printer.
- The **6** key reads the log information from a floppy disk.

The **7** key writes the log information to a floppy disk.

3. In the case of "error retry OK," a capital "R" will be placed at the beginning of the error status. However, it is not added to the error count.

3.23 Running Test

3.23.1 Function Description

This function automatically executes the following tests in sequence:

- 1. System test (subtest 01)
- 2. Memory test (subtests 01, 02)
- 3. Display test (subtest 01)
- 4. Real timer test (subtest 02)
- 5. HDD test (subtest 01)
- 6. FDD test (subtest 02)

The system automatically detects the number of floppy disk drives connected to the computer for the FDD test.

3.23.2 Operations

1. Select **6** from the Diagnostic Menu and press **Enter**, the following messages will appear in the display in order.

```
FDD write/read test (Y/N) ?
Printer wrap around test (Y/N) ?
Serial wrap around test (Y/N) ?
CD-ROM/DVD-ROM test (Y/N) ?
```

- 2. To execute the test, press **Y** (yes) and **Enter**. To cancel the test, press **N** (no) and **Enter**. If you execute the selectable test, follow the indication message in the display.
- 3. After setting the selectable test, the test starts automatically. To terminate the program, press **Ctrl + Break**.

3.24 Floppy Disk Drive Utilities

3.24.1 Function Description

This function formats the FDD, copies the floppy disk and displays the dump list for both the FDD and HDD.

1. FORMAT

NOTE: This program is only for testing a floppy disk drive. The option is different from the Toshiba MS-DOS FORMAT command.

This program can format a floppy disk in the following formats:

- (a) 2DD: Double-sided, double-density, double-track, 96/135 TPI, MFM mode, 512 bytes, 9 sectors/track.
- (b) 2HD: Double-sided, high-density, double-track, 96/135 TPI, MFM mode, 512 bytes, 18 sectors/track.
- 2. COPY

This program copies data from a source floppy disk to a target floppy disk.

3. DUMP

This program displays the contents of the floppy disk and the designated sectors of the hard disk on the display.

4. HDD ID READ

This program reads the hard disk ID and displays hard disk information.

3.24.2 Operations

1. Selecting **7** from the DIAGNOSTIC MENU and pressing **Enter** displays the following message:

```
[ FDD UTILITIES ]
```

- 1 FORMAT
- 2 COPY
- 3 DUMP
- 4 HDD-ID READ
- 9 EXIT TO DIAGNOSTICS MENU
- 2. FORMAT program
 - (a) Selecting FORMAT displays the following message:

DIAGNOSTICS - FLOPPY DISK FORMAT : VX.XX Drive number select (1:A, 2:B) ?

(b) Select a drive number to display the following message:

Type select (0:2DD, 3:2HD) ?

(c) Select a media/drive type number and press **Enter**. A message similar to the one below will be displayed:

Warning : Disk data will be destroyed. Insert work disk into drive A: Press any key when ready.

(d) Remove the Diagnostics Disk from the FDD, insert the work disk and press any key.

The following message will be displayed when the FDD format is executed:

[FDD TYPE] : TRACK = XXX
[FDD TYPE] : HEAD = X
[FDD TYPE] : SECTOR = XX
Format start
 [[track, head = XXX X]]

After the floppy disk is formatted, the following message will appear:

Format complete
Another format (1:Yes/2:No) ?

(e) Typing **1** displays the message from step (c) above. Typing **2** returns the test to the DIAGNOSTIC MENU.

- 3. COPY program
 - (a) When COPY is selected, the following message appears:

```
FLOPPY DISK FORMAT & COPY : VX.XX
Type select (0:2DD,3:2HD) ?
```

(b) Selecting a media/drive type number will display a message similar to the one below:

```
Insert source disk into drive A: Press any key when ready.
```

(c) Remove the Diagnostics Disk from the FDD, insert the source disk and press any key. The following message will appear, indicating the program has started.

```
[ FDD TYPE ] : TRACK = XXX
[ FDD TYPE ] : HEAD = X
[ FDD TYPE ] : SECTOR = XX
Copy start
        [[ track,head = XXX X ]]
```

(d) The following message will appear.

Insert target disk into drive A: Press any key when ready.

(e) Remove the source disk from the FDD, then insert a formatted work disk and press any key. The following message will appear and start copying to the target disk.

[[track,head = XXX X]]

(f) When the amount of data is too large to be copied in one operation, the message from step (b) is displayed again. After the floppy disk has been copied, the following message will appear:

```
Copy complete
Another copy (1:Yes/2:No) ?
```

(g) To copy another disk, type **1** and the message from step (a) is displayed again. Entering **2** returns the test program to the DIAGNOSTIC MENU.

4. DUMP program

(a) When DUMP is selected, the following message appears:

```
DIAGNOSTICS-HARD DISK & FLOPPY DISK DUMP : VX.XX
Drive type select (1:FDD, 2:HDD) ?
```

(b) Select a drive type. If 2:HDD is selected, the display will go to step (h). If 1:FDD is selected, the following message will appear:

Select drive number (1:A, 2:B) ?

(c) Select a drive number and the following message will be displayed.

Format type select (1:2DD, 3:2HD) ?

(d) If 3:2HD is selected, the following message will appear. Select a media mode.

2HD media mode (1:1.20MB, 2:1.44MB, 3:1.23MB)?

(e) The following message will appear:

Insert source disk into drive A: Press any key when ready.

(f) Insert a source disk and press any key and the following message will appear:

Max. address —
[Track] = XXXX
[Head] = XX
[Sector] = XX
Track number ????

- (g) Set the track number, head number and sector number you want to dump. The system will access the disk and dump a list. Then the message shown in (k) will appear.
- (h) The following message will appear when selecting 2:HDD in (a).

Select drive number (1:C, 2:D) ?

(i) Select a drive number and the following message will be displayed.

```
---Max. address ---
[LBA ] = XXXXXXXXX
LBA number ???????
```

(j) Set the LBA number you want to dump. The system will access the disk and dump a list.

(k) The following message will appear. To finish the dump, select **3**.

Press number key (1:up,2:down,3:end) ?

(1) The following message will appear. Selecting **2** returns to the FDD UTILITIES MENU.

Another dump (1:Yes,2:No) ?

5. HDD ID READ program

Selecting HDD ID displays the following HDD ID configuration:

[HDD ID Read	(VX.XX)] [Drive #1]	[Drive #2]
Model No.	= XXXXXXX	= XXXXXXX

NOTE: Only when a 2nd HDD is installed, [Drive #2] message appears in the display.

Press **Enter** to return to the FDD UTILITIES MENU.

3.25 System Configuration

3.25.1 Function Description

The System Configuration program contains the following configuration information for the computer:

- 1. Processor Type [Code/L2 cache]
- 2. Chip set [VRAM]
- 3. BIOS ROM version [1st ID, 2nd ID]
- 4. Boot ROM version
- 5. EC/KBC version
- 6. PS Microprocessor version
- 7. SVP parameter version [Panel/Manufacture code/Product code]
- 8. Micro code revision [Processor number]
- 9. Total Memory Size [Conventional memory]
- 10. Battery code
- 11. HWSC
- 12. FSB [Voltage]
- 13. Printer Adapter
- 14. ASYNC Adapter
- 15. Math co-processors
- 16. Floppy Disk Drive [Track/Head/Sector]
- 17. Hard Disk Drive [Sector/Drive size/Manufacture code]
- 18. Optical Disk Drive [Maker/Drive type/Manufacture code/Product code]
- 19. T&D total version
- 20. Date/Time

3.25.2 Operations

Select **8** from the DIAGNOSTIC MENU and press **Enter.** Then, the following system configuration appears in the display.

System Configuration Display: Ver X.XX [Machine Name???]

 * - Processor Type = XXXXX-XXXX * - Chip set = XXXXXX * - BIOS ROM Version = VX.XX * - BOOT ROM Version = VX.XX * - EC/KBC Version = VX.XX * - PS Micon Version = VX.XX 	XMHz Code = XX L2 Cache = XXXXXKB VGA Chip = XXXXXX Lst ID = XXH, 2nd ID = XXH
* - SVP Par. Version = VX.XX (P	anel-XXXXXXXXX Manu-XXXX Drod-XXXX)
* - Micro code Revision = VX.XX (P	
* - Total Memory Size = XXXXXXMB (C	
* - Battery Code = XXXXXXXXXXXXXX	X ·
<pre>* - Battery Code = XXXXXXXXXXXX * - HWSC = XXXXXXXX</pre>	
* - FSB = XXXXXMHz (V	oltage = XEh)
* - X Printer Adapter LPT1 = XXXX	LPT2 = XXXX LPT3 = XXXX
* - X ASYNC Adapter COM1 = XXXX	COM2 = XXXX COM3 = XXXX
* - X Math CO-Processor	
* - X Floppy Disk Drive(s) Track =	XX Head = XX, Sector = XX
* - X Hard Disk Drive(s) #1 Sect	ors = XXXXX, (XXXXX GB) [XXXXXXXXXXXXXXXXXXXXXXX ors = XXXXX, (XXXXX GB) [XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX
* - ODD = XXXX XXXXXX	
* - T&D Total Version = VX.XX	m mmmmm [mmmmmmmm]
Press [Enter] Key [Date = XXXX-Y	Y-ZZ, XX:YY:ZZ]

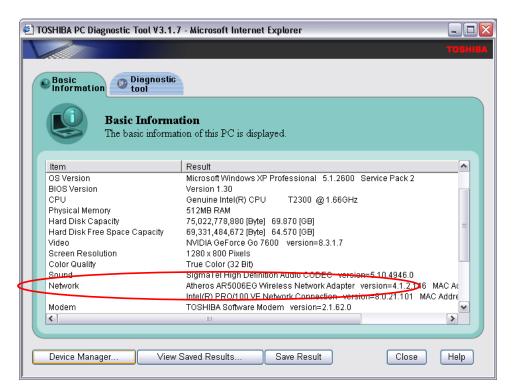
Press **Enter** to return to the DIAGNOSTIC MENU.

3.26 Wireless LAN Test Program (Atheros): Not Used

Since there is no test program for Atheros-made wireless LAN cards, check the wireless LAN card type of the computer and the antenna connection by using Windows programs.

Check of the wireless LAN card type

- 1. Slide the wireless communication switch to "ON" position.
- 2. Check the card type according to the following procedure:
 - Click [Start] -> [All Programs] -> [TOSHIBA] -> [Utilities] -> [PC Diagnostic Tool].
 - Check the "Network". If the "Atheros AR5007EG(11b/g)", "Atheros AR5006EX(11a/b/g)", "Atheros AR9281(11b/g/n)" or "Atheros 9280(11a/b/g/n)" is shown, the correct card is installed in the computer.



Check of the antenna connection

1. Confirm that the icon for wireless LAN appears at the lower right of the screen under the circumstances the wireless LAN communication is available. (It is no problem if a cross is shown on the icon.)

P 🗩 ? 🚆 😹 🛒 🕲 👖 🔛 💭 🥮 🚱 💽 5:10 PM

2. Double-click the icon. If the computer finds any AP (Access Point), the antenna marks like as follows will appear. It shows the antenna cables are surely connected to the wireless LAN card.

() Wireless Network Connect	ion 2	×
Network Tasks	Choose a wireless network	
😴 Refresh network list	Click as item in the list below to connect to a wireless network in range or t information.	o get more
Set up a wireless network for a home or small office	((p)) cherry_buffalo	^
	🖁 Security-enabled wireless network (WPA)	•000U j
Related Tasks	((Q)) WARPSTAR-DE28B1	-
 Learn about wireless 	Security-enabled wireless network	
networking	((Q)) ^{(05C51}	
Change the order of preferred networks	Security-enabled wireless network	•000D
🍛 Change advanced	((Q)) 3967F8A440000D876C7012C24FFDE002	
settings	Security-enabled wireless network	0000
	((Q)) P52-11g	
	Security-enabled wireless network	•000D
	((Q)) Cherry_CISCO	
	Security-enabled wireless network (WPA2)	o000 🗸
	V	Connect

3. The following message will appear if the antenna cables are not connected to the wireless LAN card or no available access point is found. In this case, check the antenna cable connection to the wireless LAN card by disassembling the computer following the steps described in Chapter 4, Replacement Procedures.

⁹⁾ Wireless Network Connect	ion 2 🛛 🛛 🔁
Network Tasks	Choose a wireless network Click an item in the list below to connect to a <u>wi</u> reless network in range or to get more information.
 Set up a wireless network for a home or small office Related Tasks Learn about wireless networking 	No wireless networks were found in range Make sure the wireless switch on your computer is on.
 Change the order of preferred networks Change advanced settings 	To see an updated list, click "Refresh network list."
	Connect

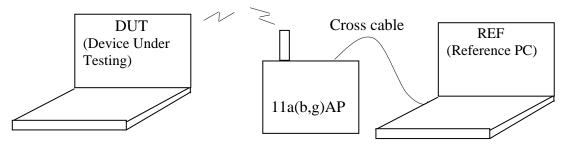
3.27 Wireless LAN Test Program (Intel-made a/b/g/n Setting up of REF PC)

For the test of Intel-made wireless LAN cards, configure the test environment as shown below with the following equipment.

• AP (which can operate on Windows XP and is corresponding to access point 11a, 11b and 11g)

NOTE: Set the SSID of AP as follows. (Note that upper case and lower case characters are recognized as different characters.) AP for check of 11a : 11aAP AP for check of 11b : 11bAP AP for check of 11g : 11gAP Make the security functions of AP (WEP, WPA, etc.) invalid.

- REF (Reference) PC
- Cross cable
- DUT (Device Under Testing)

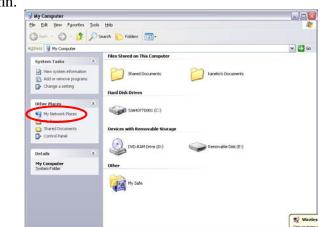


Configuration of equipment for transmitting-receiving test

How to setup the REF PC

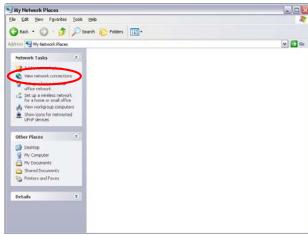
Set up the wireless LAN environment needed for the test before the start of Responder program on REF PC.

- 1. Copy the R100VWL5.ZIP (wireless LAN program for maintenance, common to Calexico, Golan and Kedron) to REF PC and unzip it. Then "Clx_Res" folder is created and the following three programs are copied in it.
 - PACKET.SYS
 - PACKET.INF
 - WTWINSVR.EXE

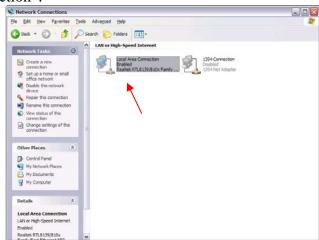


Open "My Computer" window and click "My Network places" on the left column.

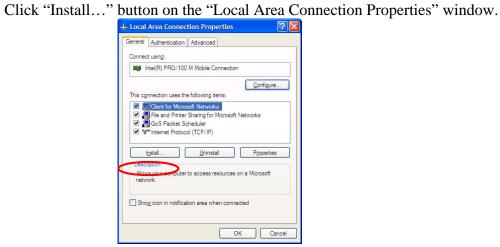
• Click "View network connections" on the left column.



• The "Network Connections" window appears. Double-click "Local Area Connection".



Network Connections window



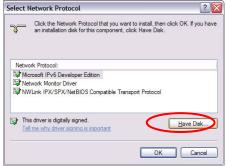
Local Area Connection Properties window

• Select "Protocol" on the "Select Network Component Type" window and click "Add..." button.

Client		
Protocol		
Description		
A protocol is a communicate	language your con	

Select Network Component Type window

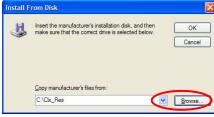
• Click "Have Disk..." button on the "Select Network Protocol" window.



Select Network Protocol window

•

• When "Install From Disk" window appears, click "Browse…" and specify the created "Clx_Res" folder. Then Click "OK". (For the test, "PACKET.INF" file is used.)



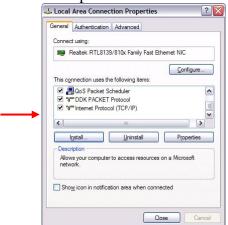
Install From Disk window

• The "Select Network Protocol" window appears again. In the "Network Protocol", "DDK PACKET Protocol" will appear. Then click "OK" to start the installation.

¥	Click the Network Protocol that you want to install, then click OK.
	ork Protocol: IK PACKET Protocol
A Th	

Select Network Protocol window

• When the installation is completed, "Local Area Connection Properties" will appear. Confirm that the "DDK PACKET Protocol" is added. Click "Close" button to finish the setup of REF PC.



Local Area Connection Properties window

After the completion of REF PC setup, restart the WINDOWS. Then perform the Responder test program for Windows (WTWINSVR.EXE) in the Clx_Res folder.

• WTWINSVR.EXE

Function	: Transmitting/receiving of data to/from DUT via AP
OS available	: Windows XP only
How to start	: Double-click WTWINSVR icon.

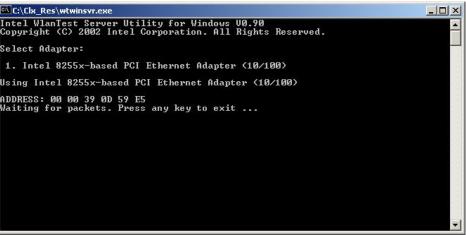
How to start

1. Double-click wtwinsvr icon. The following screen will appear.



Startup screen of wtwinsvr program

2. Enter the number of Network Adapter used on REF PC (enter **1** for example above). Then the following screen will appear. Start the test program on DUT.



Screen while running the wtwinsvr program

The REF PC is waiting for the start of the test program on DUT.

3.28 Wireless LAN Test Program on DUT PC (Intel-made)

3.28.1 Wireless LAN Test Program (Intel-made : Shirley Peak) on DUT PC

This section describes how to perform the wireless LAN transmitting-receiving test (Intelmade 802.11 a/b/g). To execute the wireless LAN test, use the Diagnostics disk for wireless LAN test.

Insert the Diagnostics disk for wireless LAN test into the Floppy Disk Drive. Turn on the power while pressing **U**.

The following menu appears in the display.

```
*
*
    Intel WiFi Link 5100/5300 Maintenance T&D Menu
                                                     *
*
  1 : Communication test of 11a mode for 5100/5150 module
                                                     *
*
                                                     *
*
  2 : Communication test of 11b mode for 5100/5150 module
*
  3 : Communication test of 11g mode for 5100/5150 module
                                                     *
  4 : All the tests of WiFi Link 5100/5150 Module
*
                                                     *
*
       (MAC Check, communication test)
  5 : Communication test of 11a mode for 5300/5350 module
*
  6 : Communication test of 11b mode for 5300/5350 module
*
                                                     *
*
                                                     *
*
  7 : Communication test of 11g mode for 5300/5350 module
                                                     *
  8 : All the tests of WiFi Link 5300/5350 Module
                                                     *
*
        (MAC Check, communication test)
```

To execute the subtest, input the subtest number and press **Enter**.

Subtest01 Communication test of 11a mode for 5100/5150 module (Two antenna type)

This subtest execute transmitting/receiving test in 802.11a mode using the main antenna.

If a defective is not found during the test, **OK** message will appear in the display. Press any key and return to the test menu.

If a defective is found during the test, **NG** message will appear in the display. When pressing any key, the following message is displayed

Press any key and return to the test menu.

Subtest02 Communication test of 11b mode for 5100/5150 module (Two antenna type)

This subtest execute transmitting/receiving test in 802.11b mode using the main antenna.

If a defective is not found during the test, **OK** message will appear in the display. Press any key and return to the test menu.

If a defective is found during the test, **NG** message will appear in the display. When pressing any key, the following message is displayed

Press any key and return to the test menu.

Subtest03 Communication test of 11g mode for 5100/5150 module (Two antenna type) This subtest execute transmitting/receiving test in 802.11g mode using the main antenna.

If a defective is not found during the test, **OK** message will appear in the display. Press any key and return to the test menu.

If a defective is found during the test, **NG** message will appear in the display. When pressing any key, the following message is displayed

Press any key and return to the test menu.

Subtest04 All the tests of WiFi Link 5100/5150 Module (MAC Check, communication test: Two antenna type)

> All the tests is executed in the order of Communication test of 11a mode, Communication test of 11b mode and Communication test of 11g mode.

When any error has detected, the test finishes.

Subtest05 Communication test of 11a mode for 5100/5150 module (Three antenna type)

This subtest execute transmitting/receiving test in 802.11a mode using the main antenna.

If a defective is not found during the test, **OK** message will appear in the display. Press any key and return to the test menu.

If a defective is found during the test, **NG** message will appear in the display. When pressing any key, the following message is displayed

Press any key and return to the test menu.

Subtest06 Communication test of 11b mode for 5100/5150 module (Three antenna type)

This subtest execute transmitting/receiving test in 802.11b mode using the main antenna.

If a defective is not found during the test, **OK** message will appear in the display. Press any key and return to the test menu.

If a defective is found during the test, **NG** message will appear in the display. When pressing any key, the following message is displayed

Press any key and return to the test menu.

Subtest07 Communication test of 11g mode for 5100/5150 module (Three antenna type) This subtest execute transmitting/receiving test in 802.11g mode using the main antenna.

If a defective is not found during the test, **OK** message will appear in the display. Press any key and return to the test menu.

If a defective is found during the test, **NG** message will appear in the display. When pressing any key, the following message is displayed

Press any key and return to the test menu.

Subtest08All the tests of WiFi Link 5100/5150 Module
(MAC Check, communication test: Three antenna type)

All the tests is executed in the order of Communication test of 11a mode, Communication test of 11b mode and Communication test of 11g mode.

When any error has detected, the test finishes.

3.29 LAN/Modem/Bluetooth/IEEE1394 Test Program

This section describes how to perform the LAN/Modem/Bluetooth/IEEE1394 test with the test program.

Insert the test program disk for LAN/Modem/Bluetooth/IEEE1394 test in FDD and turn on the power. The following message will appear:

Microsoft Windows XX Startup Menu ------1. LAN

- 2. Modem
- 3. Bluetooth
- 4. IEEE1394

Enter a choice:

Press the number you want to test and press Enter.

NOTE: It is impossible to go back to startup menu once you choose the test. Therefore, LAN/Modem/Bluetooth/IEEE1394 test can not be executed successively.

3.29.1 LAN test

To execute LAN test, press **1** and **Enter**. The following message will appear:

Press the number you want to test and press Enter.

Subtest01 (i82562 + ICHx)

This subtest checks the operation of mini-PCI I/F by the loopback test in the chip.

The following message will appear:

```
[LAN transmit & receive test !]
                  COMPLETED Repeat count =
                                                00000
                             Error count =
                                                00000
LOOPBACK TEST
100Mbps Auto-negotiation TxRx Test
Destination Address = xxxxxxxxxx
Source Address
                        = xxxxxxxxxxx
  ** 100Base-TX Full-Duplex **
  < TRANSMIT >
  < RECEIVE >
                                     mm
                                              11
                                                  M
                                             11 11
```

NOTE: The menu displayed by your computer may be slightly different from the one shown above.

If a defective is found, NG message will appear in the display.

Subtest02 (GbE)

This subtest checks the operation of mini-PCI I/F by the loopback test in the chip. Select **2** to execute and press **Enter**.

The following message will appear:

```
Testing adaptor...hit <ESC> to abort.
*
External Loopback Test...PASSED
Testing completed.
*
*
Loopback Test Complete
*
*
* 1000Base Auto-negotiation TxRx Test
*
* CE Test Complete
```

"| ||

NOTE: The menu displayed by your computer may be slightly different from the one shown above.

If a defective is found, NG message will appear in the display.

3.29.2 Modem test (Not Used)

For this subtest, connect the modem PCB and RJ11 connector with a harness. Use the dedicated "FAT-MODE inspection device (product code: QE2000P01 made by Nitto Denki Seisakusyo)" for the tests.

To execute Modem test, press 2 and Enter. Following message will appear:

[Modem loopback test !]	
ICHx MDC Test Program with Modem S Version X.X	ound (Line Test)
* Scorpio Modem Initialize	:OK
* Digital Loopback Test	:OK
* RJ11 Connector Check (LED)	:(Operator's Check!!)

OK is displayed when a error is detected, NG is display when a error is not detected.

NOTE: The menu displayed by your computer may be slightly different from the one shown above.

RJ11 Connection Check (LED) (Operator's Check LED) test will be executed, and the following message will appear:

 \dots Press Key (Y = OK , N =NG)

If the color in the LED of the connection checker is orange, press **Y**, otherwise, press **N**.

3.29.3 Bluetooth test

Preparation

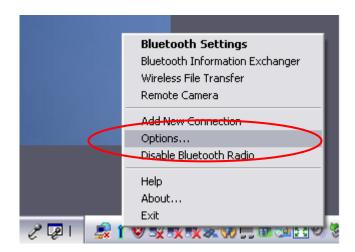
- For the test of Bluetooth function, use the Windows program installed on the target computer (computer to be tested). A responder device (device for transmitting/receiving data) is also needed. (A mobile phone with the Bluetooth function is also available.)
- A Bluetooth card should be installed on the target computer. Install the Bluetooth function by clicking [All Programs] -> [TOSHIBA] -> [Bluetooth] -> [Bluetooth Settings].

Test procedure

- 1. Enable the Bluetooth function of the responder device.
- 2. Make sure the wireless communication switch of the target computer is set to "ON" position.
- 3. Right-click the Bluetooth icon on the lower right screen of the target computer.



4. Select "Options...".



5. Select "Diagnostics" tab and click "Run".

Tests		Results
	nication with Bluetooth Device ote Bluetooth Device	
E_ encorron tem		
<	ш	
Log:		
		~
		~
	Clear	Run

6. Check the "Log" to confirm the test result.

eral Security Bluetooth Information Exchanger Other	r Diagnostics	1
Tests Tests Image: Check communication with Bluetooth Device Image: Check for remote Bluetooth Device	Results Pass Pass	
Log:		
Lheck communication with Bluetooth device Address: 00:0374:12:P3B9 HCI ver: 03:0778 LMP ver: 03 Bluetooth device is working. Check for remote Bluetooth device Connecting: 0		BT address of test computer
Found: 10 Address: 00:03:7A:F6:99:17	<u>R</u> un	BT address of responder device

 When the BT (Bluetooth) address of the responder device appears, the Bluetooth card and antenna connection are OK.
 If the BT address of the responder device does not appear, check the Bluetooth card condition and antenna cable connection to the Bluetooth card by disassembling the computer following the steps described in Chapter 4, *Replacement Procedures*.

3.29.4 IEEE1394 test

To execute this test, input **4** and press **Enter**.

NOTE: Use another computer that can communicate by IEEE1394 (i. Link) cable as a reference machine to perform this test.

The following menu will appear:

To execute the TEST, select the test number you want to execute and press **Enter**.

Subtest01 Transmit & Receive test

NOTE: Before executing subtest 01, be sure to execute subtest 02 in the responder machine.

This program checks the data transporting between responder machine and target machine and compare them with the original data through the IEEE1394 cable.

Subtest02 Responder set

This program is executed in the responder machine to initialize the responder machine with the IEEE1394 cable connected to the target machine before executing subtest 01.

Subtest03 1394 GUID Display

This program checks the GUID of IEEE1394.

3.30 Sound Test program

Sound TEST disk cannot be used in TECRA R10.
Therefore, please test the sound on Windows OS.
1) Play a music file.
2) click TOSHIBA-> utility -> "PC diagnostic tool." to test the sound Please check operation of speakers by one of methods.

3.31 3G Test program

Therefore, please test the sound on Windows OS. All the programs included in EU870 test CD are install. A procedure should look at ToshibaTestTools_ReleaseNotes.txt. Please uninstall after the completion of a EU870 test.

3.32 SETUP

3.32.1 Function Description

This program displays the current system setup information as listed below:

- 1. Memory
- 2. System Date/Time
- 4. Password
 - (a) User Password
 - (b) Supervisor Password
- 3. HDD Password
 - (a) HDD
 - (b) HDD Password Mode
 - (c) User Password
 - (d) Master Password
- 5. Boot Priority
 - (a) Boot Priority
 - (b) HDD Priority
- 6. Others
 - (a) Core Multi-Processing
 - (b) Dynamic CPU Frequency Mode
 - (c) Execute-Disable Bit Capability
 - (d) Virtualization Technology
 - (e) Trusted Execution Technology
 - (f) Auto Power On
 - (g) Beep Volume
 - (h) Diagnostic Mode
 - (i) USB Sleep and Charge
- 7. Configuration
- 8. Battery
 - (a) Battery Save Mode
 - (b) PCI Express Link ASPM
 - (c) Enhanced C-States

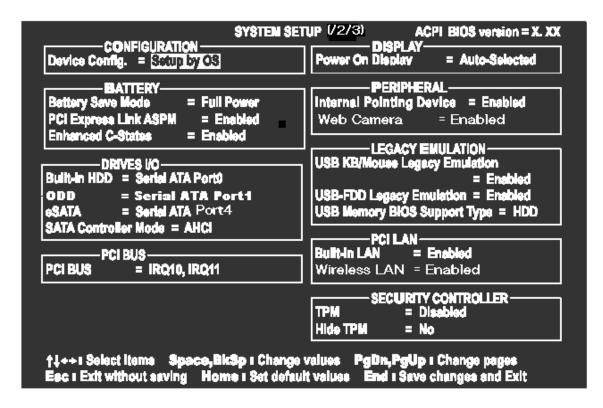
- 9. Drives I/O
 - (a) Built-in HDD
 - (b) ODD
 - (c) eSATA
 - (d) SATA Controller Mode
- 10. PCI Bus
- 11. Display
 - (a) LCD Display Stretch
- 12. Peripheral
 - (a) Internal Pointing Device
 - (b) Web Camera
- 13. Legacy Emulation
 - (a) USB KB/Mouse Legacy Emulation
 - (b) USB-FDD Legacy Emulation
 - (c) USB Memory BIOS Support Type
- 14. PCI LAN
 - (a) Built-in LAN
- 15. Security Controller
 - (a) TPM
 - (b) Hide TPM
 - (c) Clear TPM Owner
- 16. Intel(R)AMT
 - (a) MEBx SETUP

3.32.2 Accessing the SETUP Program

While pressing **ESC**, turn on the power. Then press **F1**. The following display appears.

MEMORY	SYSTEM SETUP (1/2)	DOOT BDIODITS	03 version = X. X /
Total = XXXX	MB Boot Priorit	ty = HDD+FDD)→CD-RON +LAN
SYSTEN DATE/TIME	HDD Priorit	y = Bullt-In HD	D→USB
Data (MM-DD-YYYY) = X+4-X	x-xxx (OTHERS	
Time (HH:MM:SS) = XX:XO			= Enabled
DIOBIODO	Dynamic Ci	PU Frequency N	
User Paseword = Not R	edistered		ally Switchable
	egistered Execute-Dis	eable Bit Capabl	
· ·	<u> </u>		Not Available
HDD PASSWORD		on Technology	
HDD = Built-		ecution Technol	
HDD Password Mode = Maste			= Disabled
User Password = Not R	egistered Auto Power	r On 👘 🖓	= Enabled
Mester Pasaword = Not R	egistered Beep Volun	ne :	= Nedium
	Diagnoatic		= Disabled
			= Disabled

Esc | Exit without saving Home | Set default values End | Save changes and Exit



MEBx SETUP = Disabled	SYSTEM SETUP	13/3)	ACPI BIOS version =
↑↓++>:Select itens Space, Esc:Exit without saving He	Sp:Change valu no:Set default	va luez En	:Change pages I:Save changes and Exit

Moving Within the SETUP Menu and Changing Values

- Press ← and → to move between the two columns. Press ↑ and ↓ to move between items in a column. Press Fn+↑ (PgUp) and Fn + ↓ (PgDn) to move between the two pages.
- 2. Press either the **Space bar** or **Back Space** to change the value.

Accepting Changes and Exiting the SETUP Window

1. Press **End** to accept the changes you made.

If the changed item does not require the system to reboot, the following message is displayed:

Are you sure? (Y/N)

If the changed item requires the system to reboot, the following message is displayed:

Are you sure? (Y/N) The changes you made will cause the system to reboot.

- 2. To make other changes, press **N**. Repeat the steps above.
- 3. To accept the changes, press **Y**.

NOTE: You can press **Esc** to quit at any time without saving changes. SETUP asks you to confirm that you do not want to save your changes. When SETUP is displayed at the next time, the current configuration appears.

The Factory Preset Configuration

When you access SETUP, the current configuration is displayed.

- 1. To show the factory preset configuration, press **Home**.
- 2. To accept the default settings, press **End** and then press **Y**.

NOTE: When you execute the default setting, the following settings are not changed: (1) HDD Mode (2) Password (3) Write Policy

SETUP Options

The SETUP screen is divided into 14 functionally related groups. This section describes each group and its options.

1. Memory

This group of options displays the computer's memory.

This field displays the total amount of memory installed and is automatically calculated by the computer. You cannot change this value.

2. System Date/Time

Sets the date and time.

System Date	Sets date.
System Time	Sets time.

- 3. Password
 - (a) User Password

This option allows you to set or reset the user password for power on.

Registered	A password has been registered.
Not Registered	Change or remove the password. (Default)

(a) Supervisor Password

This setting, which is displayed on the first page of the setup screen, allows you to register a Supervisor Password of the computer.

Registered Supervisor Password has been registered.

Not Registered Supervisor Password has not been registered (Default).

For details on setting the password, refer to the Online Manual.

4. HDD Password

This option sets HDD password. HDD password is a security function to protect the built-in HDD.

(a) HDD

This item selects the hard disk to set HDD password.

Built-in HDD Sets HDD password for the built-in HDD

(b) HDD Password Mode

This item registers HDD password and can be selected only for registering HDD password. To change HDD Password Mode when HDD password is registered, delete the registered HDD password first, and then register new password.

User Only Sets only User HDD Password (Default)

Master+User Sets Master HDD Password and User HDD Password

(c) User Password

This item sets User password. For details on setting user password, refer to the User's Manual.

(d) Master Password

This item sets the Master HDD password. This can be set **Master+User** is set in the HDD password Mode. For details, refer to the User's Manual.

5. Boot Priority

(a) Boot Priority

Use this option to set the priority for booting of the computer and the priority for the HDD for booting.

HDD→FDD→CD-ROM→LAN: FDD→HDD→CD-ROM→LAN:	The computer looks for bootable files in the following order: HDD, FDD, CD- ROM and LAN. (Default) The computer looks for bootable files in the following order: FDD, HDD, CD- ROM (*1) and LAN
HDD→CD-ROM→LAN→FDD:	The computer looks for bootable files in the following order: HDD, CD-ROM, LAN and FDD.
FDD→CD-ROM→LAN→HDD:	The computer looks for bootable files in the following order: FDD, CD-ROM, LAN and HDD.
CD-ROM→LAN→HDD→FDD:	The computer looks for bootable files in the following order: CD-ROM, LAN, HDD and FDD.
CD-ROM→LAN→FDD→HDD:	The computer looks for bootable files in the following order: CD-ROM, LAN, FDD and HDD.

NOTE: CD-ROM refers to a DVD Super Multi drive.

(b) HDD Priority

Use this option to set the booting priority from HDD or USB (USB Memory stick).

Built-in HDD→ USB (Default)

USB →Built-in HDD

6. Others

Whether or not you need to configure the computer with these options depends primarily on the kind of software or peripherals you use.

(a) Core-Multi Processing

The Core Multi-Processing sets the CPU operating mode. The configuration for the Core Multi - Processing is carried out in the BIOS setup program.

Enabled is Dual Core mode. Disabled is Single Core mode.

Enabled	Enables Core Multi-Processing functions. (Default)
Disabled	Disables Core Multi - Processing functions.

(b) Dynamic CPU Frequency mode Use this option to choose a setting from the followings.

Dynamically Switchable

	Enables Intel [®] Core [™] Duo processor featuring Intel SpeedStep technology. (Default)
Always High	Disables Intel [®] Core [™] Duo processor featuring Intel SpeedStep technology and always runs the processor at its maximum speed.
Always Low	Disables Intel [®] Core [™] Duo processor featuring Intel SpeedStep technology and always runs the processor at its default speed.

(c) Execute-Disable Bit Capability

This option set the Execute-Disable Bit function of CPU to the operation system. Execute-Disable Bit gives higher security function preventing the PC from the computer viruses and buffer overflow problem on unauthorized access.

Available	Enable the Execute-Disable Bit function.	

Not Available Disable the Execute-Disable Bit function. (Default)

(d) Virtualization Technology

Virtualization Technology sets enable or disable of the Intel Virtualization Technology installed in the CPU.

Intel Virtualization Technology is the technique that allows one machine to operate as multiple virtual machines.

Enabled	Enables Virtualization Technology.
Disabled	Disables Virtualization Technology. (Default)

(e) Trusted Execution Technology

Permission/prohibition of Trusted Execution Technology are set up. Trusted Execution Technology is the security technology of making it cooperating with TPM using Virtualization Technology.

Disabled Trusted Execution Technology is set as prohibition. (Default)

Enabled Trusted Execution Technology is set as permission.

When Trusted Execution Technology is set as permission, Please set both of "Virtualization Technology" of [6 "OTHERS"], and "TPM(s)" of [16 "SECURITY CONTROLLER"] as "Enabled" in advance.

(f) Auto Power On

Use this option to set a time and date for automatic power on and enable or disable the ring indicator feature. Alarm Date Option appears only when Alarm Time is enabled.

```
OPTIONSAlarm Time= DisabledWake-up on LAN= Disabledon Battery= DisabledCritical Battery Wake-up= Enabled
```

Set the parameters for the Auto Power On (automatic power on) function and the Wake-up on LAN in the "OPTIONS" window. To set the time, use **Space** or **BackSpace**. Press \downarrow to move the cursor to the right and \uparrow to move the cursor to the left when you set the date and time.

For the **Alarm Time**, set the time to turn on the power automatically. The "second" cannot be set. When it is set to "Disabled", the time to turn on automatically is not set.

The **Wake-up on LAN** is a function to turn on the power automatically by the call from the administrator. It can be set to "Enabled" only when "Built-in LAN" is set to "Enabled". To activate this function, use the AC adapter.

On Battery

The following settings can be changed when the Wake-up on LAN is Enabled.

Enabled	Wake-up on LAN function whenoperating from the battery.
Disabled	Wake-up on LAN function whenoperating from the battery (Default).

NOTE:

- 1. Do not remove the AC adaptor and battery pack at the same time when you use this feature. If you do so, data saved by the resume function will be lost. You must also reset this option.
- 2. If you have set a password and the computer boots by the Auto Power On function and Standby is on, the computer will start with the instant security function enabled. The **password** = message is not displayed; however, you must enter the password to use the computer.
- 3. This option is enabled only once, the setting is reset, after booting up.

Critical Battery Wake-up

Configures what action is taken when the remaining battery power is close to running out while the system is in Sleep Mode.

This setting is only available when the Critical battery action in Windows is set to Hibernate (Default).

To access it, Start -> Control Panel -> System and Maintenance ->

Power Options -> Edit Plan Settings -> Change advanced power settings -> Battery.

The operation of this function is dependent upon battery status.

Enabled	When the remaining battery power is about to run out while the system is in Sleep Mode, the system is automatically woken up and then switched to Hibernation Mode (Default).
Disabled	No action is taken even if the remaining battery power is

about to run out while the system is in Sleep Mode.

(g) Beep Volume

This Option sets up the volume of a Beep sound.

 $Medium \rightarrow High \rightarrow OFF \rightarrow Low$

(h) Diagnostic Mode

This option enables/disables the HW Diagnostic test function.

Enabled	Disables the HW Diagnostic test function. (Default)
Disabled	Enables the HW Diagnostic test function.

(i) USB Sleep and charge

This Option sets up whether a power supply is supplied to a USB device, when PC is in a Sleep mode state.

Disabled A power supply is not supplied in a Sleep mode state. (Default)

Enabled	(Mode1)	A power supply is supplied in a Sleep mode state.
Enabled	(Mode2)	A power supply is supplied in a Sleep mode state.
Enabled	(Mode3)	A power supply is supplied in a Sleep mode state.
Enabled	(Mode4)	A power supply is supplied in a Sleep mode state.

7. Configuration

This option lets you set the device configuration.

All Devices	BIOS sets all devices.
Setup by OS	Initializes devices, which is needed to load an operating system. Operating system initializes other devices. (Default)
H 77 · · · / 11	

NOTE: 1. When using installed OS, selecting "Setup by OS" is recommendation	ıded.
--	-------

- 2. When executing test programs, be sure to select "ALL Device". And after the test end, select "Setup by OS".
- 8. Battery
 - (a) Battery Save Mode

This option is used to select **Full Power**, **Low Power** or **User Setting** of the battery save mode. When you select the battery save mode, the followings will appear.

Full Power

The following shows full power settings.

BATTERY SAVI	E OPTIONS
Processing Speed =	= High
CPU Sleep Mode =	= Enabled
LCD Brightness =	= Bright (*1)
=	= Super-Bright (*2)
Cooling Method =	= Maximum Performance

Low Power

The following shows low power settings.

BATTERY SA	VE OPTIONS
Processing Speed	= Low
CPU Sleep Mode	= Enabled
LCD Brightness	= Semi-Bright (*1)
	= Bright (*2)
Cooling Method	= Battery Optimized

NOTE: Display of the LCD Brightness will be changed in the condition below: (*1) Operating the battery (*2) Using the AC adapter

User Setting Use this option to set the battery save parameters on the sub-window, BATTERY SAVE OPTIONS.

Battery Save Options

Processing Speed

This feature changes the CPU processing speed.

High	CPU operates at high speed. (Default in Full Power Mode)
Low	CPU operates at low speed. (Default in Low Power Mode)

CPU Sleep Mode

Use this option to enable or disable the CPU sleep function.

Enabled	Enables sleep mode. (Default)
Disabled	Disables sleep mode.

LCD Brightness

Use this option to set the level of LCD brightness.

Super-Bright	Full brightness for maximum visibility.
Bright	Full brightness for high visibility.
Semi-Bright	Less than full brightness for saving power.

Cooling Method

Maximum Performance	If the CPU becomes too hot, the fan turns on automatically in a high speed to cool down the CPU.
Performance	If the CPU becomes too hot, the fan turns on automatically. When the CPU temperature falls to a normal range, the fan turns off.
Battery optimized	If the CPU becomes too hot, the processing speed is lowered. If the temperature is still too high, the fan turns on. When the CPU temperature falls to a normal range, the fan is turned off and the processing speed is increased.

NOTE: Too hot condition may cause defect on the CPU. When the hot condition continues, the power is automatically turned off in resume mode.

(b) PCI Express Link ASPM

This option set the power-saving function of PCI Express on the following conditions.

Auto	PCI Express devices are not used while battery operation. (Default)
Disabled	Disable the Power-saving function and drive with maximum performance.
Enabled	PCI Express devices are not used.

(c) Enhanced C-States *Core2 model only

This option set the power-saving function of Enhanced C-States on the following conditions.

Enabled	This lowers the power consumption. (Default)
Disabled	This does not lower the power consumption.

9. Drives I/O

This option displays the address and interrupts level for hard disk drive and optical disk drive. It is for information only and cannot be changed.

(a) Built-in HDD

This item displays the Serial ATA Port Number. It is for information only and cannot be changed.

Serial ATA Port0

(b) ODD

This item displays the Serial ATA Port Number. It is for information only and cannot be changed. Serial ATA Port1

(c) eSATA

This item displays the Serial ATA Port Number. It is for information only and cannot be changed.

Serial ATA Port4

(d) SATA Controller Mode

This feature sets the SATA Controller Mode.

AHCISets AHCI which is the mode for VistaTM (default)CompatibilitySets the mode for legacy OS. Use this mode when the
driver corresponding to AHCI is not used.

10. PCI Bus

This option displays the interrupt level for the Card Bus in the computer. It is for information only and cannot be changed.

PCI BUS = IRQ10, IRQ11

11. Display

This group of options configures the computer's display.

(a) Power On Display

This option is used to select the display when booting up.

Auto-Selected	Selects an external monitor if one is connected. Otherwise it selects the internal LCD. (Default)
LCD+AnalogRGB	Selects both the internal LCD and the external monitor for simultaneous display.

NOTE: Pressing **Fn+F5** changes the display setting in the order of internal LCD to simultaneous to external monitor.

12. Peripheral

Use this option to select the peripheral's mode.

(a) Internal Pointing Device

This option enables or disables the touch pad

EnabledEnables the touch pad. (Default)DisabledDisables the touch pad.

(b) Web Camera

This option enables or disables the Web Camera

Enabled Enables the Web Camera (Default)

Disabled Disables the Web Camera

13. LEGACY EMULATION

(a) USB KB/Mouse Legacy Emulation

This option sets the Legacy support condition of the USB keyboard and the USB mouse.

Enabled	Enables LEGACY support. (Default) USB keyboard/USB mouse are available without the driver.
Disabled	Disables LEGACY support

(b) USB-FDD Legacy Emulation

This option sets the Legacy support condition of the USB floppy disk drive. When a computer is FDD built-in model, this option is not displayed.

Enabled	Enables LEGACY support. (Default)
	USB floppy disk is available without the driver.

Disabled Disables LEGACY support

(c) USB Memory BIOS Support Type

A setup about the USB flash memory used for a startup of a computer.

HDD	The priority as HDD turns into ranking of HDD in "BootPriorit	
	in a USB flash memory. The priority with other HDD can be set up	
	by "HDD Priority." (Default).	
FDD	A USB flash memory is treated as FDD. The priority as a drive to	
	start turns into ranking of FDD in "Boot Priority."	

14. PCI LAN

This option sets the Enable / Disable of the built-in LAN or Wireless LAN functions.

(a) built-in LAN

Enabled	Enables built-in LAN functions. (Default)
Disabled	Disables built-in LAN functions.

- 15. Security Controller
 - (a) TPM

Disables the security controller called TPM (Trusted Platform Module). When the cursor is on the **Enable** (**Disable**) and the **Space** is pressed, message is displayed and the PC waits **Y** or **N** key input by the user. When Y is pressed, it is sets to **Enable** (**Disable**). After changing, the cursor could not be moved on the **TPM** tem. This option can be changed after rebooting.

Disabled	Disables the TPM. (Default)
Enabled	Enables the TPM.

(b) Hide TPM

Yes	It prevents from checking TPM on Windows.
No	It enables it to check TPM on Windows (Default).

In order to set "TPM" as "Enabled", please set "Hide TPM" as "No" first. Moreover, if it is set as "Yes", TPM cannot be checked on Windows.

(d) Clear TPM Owner

This is not displayed when the **TPM** is set to **Disabled**. This is executed, when the PC is disposed or the owner of the PC changes. When the cursor is on this item and the **Space** is pressed, message is displayed and the PC waits **Y**, **E**, **S** and **Enter** key inputs by the user. When **Y**, **E**, **S** and **Enter** keys are pressed, the data is disposed. After changing, the display of **TPM** item is changed to **Disabled** and this item becomes not displayed and the cursor could not be moved on the **TPM** item.

16. Intel(R)AMT

- *AMT model only
 - (a) MEBx SETUP

This setting enables or disables the computer's MEBx SETUP Intel(R) AMT.

- **Enabled** Enables the MEBx SETUP.
- **Disabled** Disables the MEBx SETUP. (Default)

Chapter 4

Replacement Procedures

[CONFIDENTIAL]

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4.10	Keyboard	
4.11	BASE ASSY	
4.12	ExpressCard slot/KILL SW HOL ASSY	
4.13	HDD/SSD	
4.14	Wireless LAN card	
4.15	RTC battery	
4.16	DC-IN HARNESS/ RJ45 WIRE HARNESS	
4.17	3G card/SIM board	
4.18	Bluetooth module	
4.19	Smart card slot	
4.20	SD board	
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4.1 Overview

This chapter describes the procedure for removing and replacing the field replaceable units (FRUs) in the PC. It may not be necessary to remove all the FRUs in order to replace one. The chart below provides a guide as to which other FRUs must be removed before a particular FRU can be removed. The numbers in the chart indicate the relevant section numbers in this manual.

In all cases when removing an FRU, the battery pack must also be removed. When repairing an FRU that is the potential cause of a computer fault, use the chart to determine the order in which FRUs need to be removed.

4.2 Battery Pack		
4.3 SIM card4.4 ExpressCard4-6 Smart card4.7 Memory module	4-5 SD/SDHC memory card4-8 FIN COVER ASSY	
4-9 Optical disk drive	4.10 Keyboard	
4.11 BASE	EASSY	
4.12. Express card slot/ KILL SW HOLDER ASSY 4.13 HDD/SSD 4-14 Wireless LAN card 4.15 RTC battery 4.15 RTC battery 4-16 DC-IN HARNES/J45 WIRE HARNESS 4.18 Bluetooth module 4-19 Smart card slot 4.17 3G card/SIM board 4.20 SD board 4-21 RGB HARNESS 4-22 DC FAN 4-23 Sound/USB board and MIC HARNESS		
4.24 System board		
4.25 SPEAKER ASSY		
4.26 LCD COVER ASSY		
4.27 MEMBRANE SW 4.28 TOUCH PAD/Fingerprint sensor board	4.29 LCD unit 4.30 CAMERA MODULE/Antenna 4.31 Hinge	

This chart shows which unit(s) you need to remove in advance when you replace one unit.

Example: When you want to replace "4.13 HDD/SSD", you need to remove all FRUs down to the "4.2 Battery pack" to "4.11 BASE ASSY" must be removed.

4.2 Battery Pack			
4.3 SIM card4.4 ExpressCard4-6 Smart card4.7 Memory module	4-5 SD/SDHC memory card 4-8 FIN COVER ASSY		
4-9 Optical disk drive	4-9 Optical disk drive 4.10 Keyboard		
4.11 BAS	E ASSY		
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4.27 MEMBRANE SW 4.28 TOUCH PAD/Fingerprint sensor board	4.29 LCD unit 4.30 CAMERA MODULE/Antenna 4.31 Hinge		

ITEM	Parts List ITEM No	PART NAME	Quantity
COVER ASSY	50	COVER ASSY	1
	39	TOUCH PAD	1
	03	PCB ASSY FMWTP	1
	63	CUSHION TP SPILL	1
	50A	TAPE D STICK TP	1
	74	INSULATOR LCD HNS UP	1
	62	INSULATOR SQUARE	1

Prepare required parts in advance, when replacing the following items.

ITEM	Parts List ITEM No	PART NAME	Quantity
LCD COVER ASSY	51	LCD COVER ASSY	1
	41	CAMERA MODULE	1
	34	ANTENNA 2.4/5.2GHZ	1
	47	ANTENNA WWAN	1
	51A	INSULATOR ANT HOLDS	12

ITEM	Parts List ITEM No	PART NAME	Quantity
Hinge	57/58	BH L ASSY/ BH R ASSY	1
	83	CUSHION SQUARE	1
	84	CUSHION SQUARE	1

Parts which can not be reused are (1) TOUCH PAD, (2) PCB ASSY FMW TP, (3) CUSHION TP SPILL, (4) TAPE D STICK TP, (5) INSULATOR LCD HNS UP, (6) INSULATOR SQUARE, (7) CAMERA MODULE, (8) ANTENNA 2.4/5.2GHZ, (9) ANTENNA WWAN (3G Antenna), (10) INSULATOR ANT HOLDS, (11) BH L ASSY/ BH R ASSY, (12) CUSHION SQUARE (L1) and (12) CUSHION SQUARE (M1).

Parts List		
ITEM No	Manual NAME	PART NAME
01A	System board	PCB ASSY FMWSY
02B	Sound/USB board	PCB ASSY FMWUS
02C	SD board	PCB ASSY FMWSD
02A	SIM board	PCB ASSY FMWPE
03	Fingerprint sensor board	PCB ASSY FMWTP
08	Memory module	DDR2-800-2GB
15	RTC battery	BTN N/H BATTERY
19	Optical disk drive	DVD-SUPERMULTI DRIVE
		HDD (160GB- 5400rpm)
18	HDD	HDD (250GB- 5400rpm)
		HDD (320GB- 5400rpm)
	SSD	2.5 SATA 128G SSD
11	LCD	LCD (14.1 WXGA)
10	Wireless LAN antenna	WL-LAN (802.11a/g/n)
12	3G card	3G MODULE (HSPA)
48	Smart card slot	CONNECTOR SMART CARD
57	Hinge	BH L ASSY
58	Hinge	BH R ASSY

The main parts in this manual are indicated in the part list by the following names.

Safety Precautions

Please read the following safety instructions before disassembling the computer and always follow the instructions while working on the computer.

DANGER: 1) Always use the genuine battery that is authorized by Toshiba or compatible with the unit. Since other battery packs have different specifications, they may be incompatible with the unit, and may burst or explode. Never heat or disassemble the battery pack, as that could cause leakage of alkaline solution. Never throw the battery pack into a fire, as that could cause the battery pack to explode. 2) The power supply, FL inverter and other components carry high voltages. If you need to turn on the power of a partially disassembled computer to check its operation, be very careful not to touch connectors or components, in order to avoid the risk of electric shock. Also, do not disassemble individual components in first-level maintenance. WARNING: 1) Turn off the power and disconnect the AC adaptor from the power source, to avoid exposure to electric shock. 2) Batteries in the computer retain an electrical charge, so there is danger of electrical shock even when the computer is disconnected from an AC power source. Remove any metal jewelry or accessories such as necklaces, bracelets or rings, in order to reduce the risk of electric shock. Never work with wet or damp hands. *3)* Be careful of edges and corners as these may cut. **CAUTION:** 1) When you change a component, be sure the replacement component meets the required specifications. Never use foreign parts, to avoid any risk of damage to the computer. 2) To avoid any risk of short-circuit, fire or other internal damage, never allow any metal objects such as screws or paper clips to fall into the unit. Be sure to replace screws with the same size as those removed. Make sure all screws are securely fastened. Loose screws can cause short circuits, resulting in heat, smoke or fire. 3) Before lifting out an FRU or other component, make sure all cables to the component have been disconnected, in order to reduce the risk of accidental electric shock. 4) If you use AC power, be sure to use the cable that came with the computer or one recommended by Toshiba. 5) Make sure that all replacement components meet the specifications for the computer and that all cables and connectors are securely fastened, in order to avoid the risk of electric shock. 6) Some parts inside the computer, such as the CPU and cooling module, become very hot during operation. Conduct repair work after they have cooled. Be careful around the CPU and cooling module to avoid burns.

Before You Begin

Take note of the following points before starting work. Always remove the AC adapter and battery pack before commencing any of the procedures. The procedure for removing the battery pack is described in section "4.2. Battery Pack".

- 1. Do not disassemble the computer unless it is operating abnormally.
- 2. Use the designated tools.
- 3. Ensure that the environment for working on and storing parts does not contain any of the following.
 - Dust or dirt
 - Static electricity
 - Extremely hot, cold, or humid conditions
- 4. Perform the diagnostic tests described in Chapter 2 to determine which FRU is the cause of the fault.
- 5. Do not perform any unnecessary work. Always work in accordance with the disassembly and re-assembly procedures in this manual.
- 6. Keep parts removed from the computer in a safe place away from the computer where they will not be damaged or interfere with your work.
- 7. Disassembling requires the removal of a large number of screws. Keep removed screws in a safe place such that you can determine which screws belong to which part.
- 8. When re-assembling, ensure that you use the correct screws and fit parts in the correct position. Screw sizes are noted in the text and figures.
- 9. As all parts have sharp edges and corners, take care not to cut yourself.
- 10. After replacing an FRU, check that the computer and replaced part operate correctly.

Disassembly Procedures

Four main types of cable connector are used.

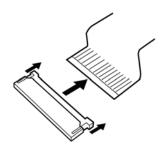
- Pressure plate connector
- Spring connector
- Back flip connector
- Normal pin connector

For pressure plate connectors, slide the pressure plate holding tags on both sides of the plastic pressure plate on the connector and pull the cable out from the connector. When reconnecting the cable to the pressure plate connector, slide the pressure plate holding tags on both sides of the plastic pressure plate on the connector and insert the cable into the connector. Push both tags of the pressure plate such that the cable is fixed in the correct position. Pull the cable to ensure that it is securely connected.

For spring connectors, lift up the stopper frees the cable and allow it to be pulled out. To reconnect, hold the stopper in the up position and insert the cable, then lower the stopper to secure the cable. Pull the cable to ensure that it is securely connected.

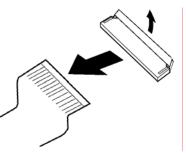
For back flip connectors, lift up the flip plate frees the cable and allow it to be pulled out. To reconnect, hold the flip plate in the up position and insert the cable, then lower the flip plate to secure the cable. Pull the cable to ensure that it is securely connected.

Normal pin connectors are used for all other cables. Simply pull out or push in these connectors to disconnect or reconnect.



Pressure plate connector

Spring connector



Back flip connector

Assembly Procedures

After the computer has been disassembled and the part that caused the fault has been repaired or replaced, the computer must be reassembled.

Take note of the following general points when assembling the computer.

- Take your time and follow the instructions carefully. Hurrying the assembly work will only introduce new problems.
- Check that all cables and connectors are securely connected.
- Before fastening FRUs or other parts in place, ensure that no cables are caught on screws or the FRU.
- Check that all latches are securely closed.
- Ensure that you have installed all FRUs correctly and do not have any screws left over. Using an incorrect screw may damage the thread or screw head and result in the FRU not being securely fastened in place.

After installing FRUs, check that the computer operates correctly.

Tools and Equipment

For your safety and the safety of the people around you, it is important that you use Electrostatic Discharge (ESD) equipment. Correctly utilizing of the equipment increases the percentage of successful repairs and saves on the cost of damaged or destroyed parts. The following equipment is required for disassembly and assembly.

- One Philips screwdriver with type 0 bit (for S-THIN HEAD screws)
- One Philips screwdriver with type 1 bit (for screws other than above)
- Tweezers (for lifting screws)
- ESD mats (lay on work table or floor)
- An ESD wrist strap and heel grounder
- Anti-static carpet or flooring
- Air-ionizers in highly static sensitive areas
- Antenna coaxial cable disconnector
- Special syringe (for applying grease)

Screw Tightening Torque

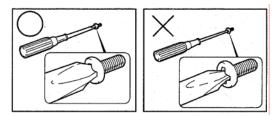
When you fasten screws, be sure to follow the torque list below.

CAUTION: Overtightening can damage components and screws; undertightening can result in electrical shorts or other damage if screws or components come loose.

NOTE: Toshiba recommends that you use an electric screwdriver for quick and easy operations.

- M2 (2mm) 0.167 N·m(1.7 kgf·cm)
- M2.5 (2.5mm) 0.294 N·m(3.0 kgf·cm)
- M3 (3mm) 0.549 N·m(5.6 kgf·cm)

NOTE: To prevent damage to THIN HEAD screws, use type 0 bit philips screwdriver. Press along the axis of the screwdriver while turning the screw. This is because the contact area between the screw and driver is less than for a pan head screw (standard panshaped screw head).



Grip Color

Some screws have a colored grip area to help you determine the length of the screw.

[Normal grip]

- Even numbered length screws: Brown
- Odd numbered length screws: White
- Special length screw: Blue

[Special grip]

- Even numbered length screws: Yellow
- Odd numbered length screws: Pink
- Special length screw: Green

"Special length screw" means screws whose length is indicated in an integral number to the first decimal places such as 2.5 mm, 2.6 mm and so on.

Screw Notation

To make maintenance of the computer easier, markings of the kinds of the screws including the types and lengths of the screws are indicated on the computer body.

Format:

Screw type + Screw length (mm)

Screw type

- B: Bind screw
- F: Flat head screw
- S: Super thin head screw
- T: Tapping screw
- U: Other screws (Unique screws: pan head, stud, etc.)

Example: **B6** ... 6mm Bind screw

Screw color/material

- B: Black/Nickel
- C: Silver/Non-Hexavalent Chromate
- U: Other screws (Unique screws: such as stud, etc.)





4.2 Battery pack

Removing the Battery pack

To remove the battery pack, follow the steps below and refer to Figure 4-1.

CAUTION: Take care not to short circuit the terminals when removing the battery pack. Similarly, do not drop, knock, scratch, disassemble, twist, or bend the battery pack.

- 1. Turn off the power of the computer.
- 2. Disconnect the AC adapter and other external devices from the computer.
- 3. Turn the computer face down.
- 4. Pull out the **battery pack** while releasing the **battery latches** as shown below.

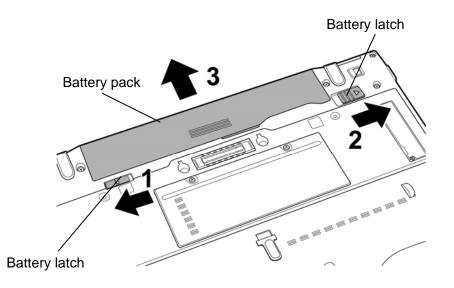


Figure 4-1 Removing the battery pack

NOTE: Dispose of the used battery pack in accordance with the laws and ordinances of your local authority.

Installing the Battery pack

To install the battery pack, follow the steps below and refer to Figure 4-1.

CAUTION: There is a danger that the lithium ion battery pack may explode if not fitted, operated, handled, or disposed correctly. Dispose always the used battery pack in accordance with the laws and ordinances of your local authority. Use only the batteries approved by Toshiba.

NOTE: Check the battery's terminals visually. If they are dirty, wipe them clean with a dry *cloth.*

- 1. Turn off the power of the computer.
- 2. Disconnect the AC adapter and all other external devices from the computer.
- 3. Turn the computer face down.
- 4. Install the **battery pack** into the battery slot.
- 5. Make sure the battery is locked.

4.3 SIM card

Removing the SIM card

To remove the SIM card, follow the steps below and refer to Figure 4-2.

CAUTION: Insert or remove an SIM card in accordance with any instructions in the SIM card manual or the manuals of the computer system you are using.

- 1. Slide the SIM card **latch** to release the card.
- 2. Push the **SIM card** and release it. It will pop out of the slot.

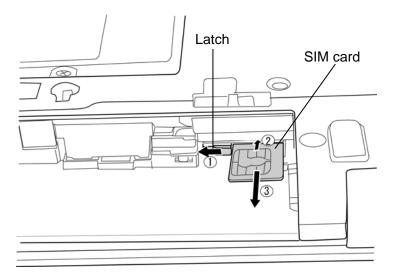


Figure 4-2 Removing the SIM card

Installing the SIM card

To install the SIM card, follow the steps below and refer to Figure 4-2.

- 1. Slide a **SIM card** into the SIM card slot with the metal connectors facing up.
- 2. Push the SIM card gently until it clicks into place.
- 3. Slide the SIM card **latch** right to secure the card in the slot.

4.4 ExpressCard

Removing the ExpressCard

To remove the ExpressCard, follow the steps below and refer to Figure 4-3

CAUTION: Insert or remove an ExpressCard in accordance with any instructions in the ExpressCard manual or the manuals of the computer system you are using.

- 1. Press the **ExpressCard** in order to eject the ExpressCard partially out of the computer.
- 2. Grasp the ExpressCard and pull it out.

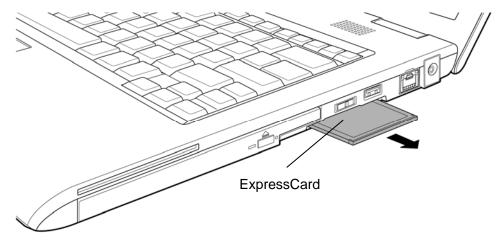


Figure 4-3 Removing the ExpressCard

Installing the ExpressCard

To install the ExpressCard, follow the steps below and refer to Figure 4-3.

- 1. Insert the **ExpressCard** into the ExpressCard slot.
- 2. Press ExpressCard carefully to ensure a firm connection.

4.5 SD/SDHC memory card

Removing the SD/SDHC memory card

To remove the SD/SDHC memory card, follow the steps below and refer to Figure 4-4.

CAUTION: Insert or remove a SD/SDHC memory card in accordance with any instructions in the SD/SDHC memory card manual or the manuals of the computer system you are using.

- 1. Press the **SD/SDHC memory card** and release it to pop the card out.
- 2. Grasp the SD/SDHC memory card and pull it out.

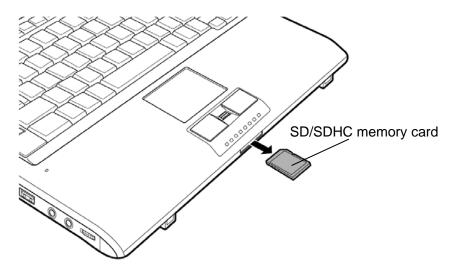


Figure 4-4 Removing the SD/SDHC memory card

Installing the SD/SDHC memory card

To install the SD/SDHC memory card, follow the steps below and refer to Figure 4-4.

1. Insert the **SD/SDHC memory card** in the card slot and push it carefully to ensure a firm connection.

4.6 Smart card

Removing the Smart card

To remove the Smart card, follow the steps below and refer to Figure 4-5.

CAUTION: Insert or remove a Smart card in accordance with any instructions in the Smart card manual or the manuals of the computer system you are using.

1. Pull out the **Smart card** from the card slot.

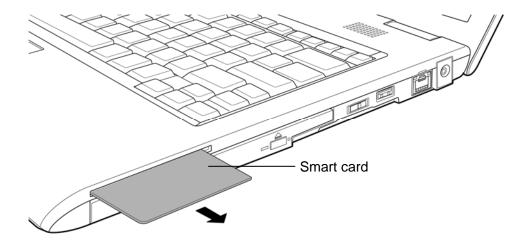


Figure 4-5 Removing the Smart card

Installing the Smart card

To install the Smart card, follow the steps below and refer to Figure 4-5.

- 1. Insert the **Smart card** into the card slot.
- 2. Push it carefully to ensure a firm connection.

4.7 Memory module

Removing the Memory module

To remove the memory module, make sure the computer is powered off, follow the steps below and refer to Figure 4-6 and 4-7.

CAUTION: When removing the memory module, make sure the computer is powered off. Removing a memory module with the power on might damage the module or the computer itself.

> Do not touch the connectors on the memory module or on the computer. Dust and stains on the connectors may cause memory access problems.

Never press hard or bend the memory module.

1. Loosen two screws and remove the MEM COV ASSY.

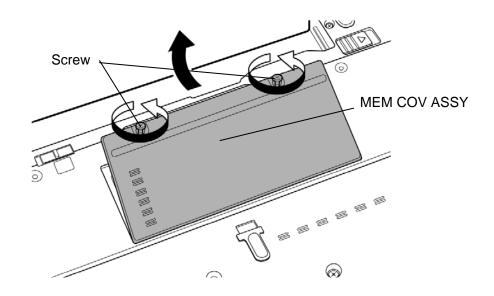
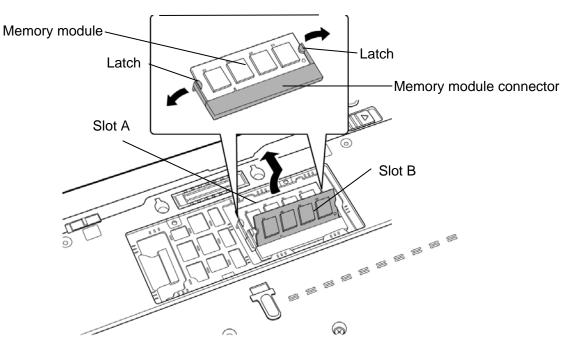


Figure 4-6 Removing the memory module (1)

2. Press two **latches** outward to release them (The memory module stands slantwise).



3. Remove the memory module from the memory module connector.

Figure 4-7 Removing the memory module (2)

[CONFIDENTIAL]

Installing the Memory module

To install the memory module, make sure that the computer is powered off, follow the steps below and refer to Figure 4-6 and 4-7.

NOTE: The slot A is reserved for the first memory module. Use the slot B for expanded memory. If only one module is installed, use the slot A.

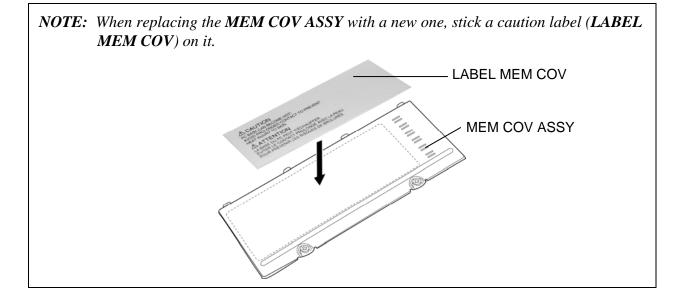
1. Insert the **memory module** into the **memory module connector** slantwise.

NOTE: Align the notch of the Memory card to the guide of the memory module connector.

2. Press down the memory module gently until it is latched.

CAUTION: After installing the memory module, make sure that the memory module is secured with the left and right latches.

3. Set the **memory cover** and secure it with two **screws**.



NOTE: When the power of the computer is turned on, the computer checks automatically the memory size. Confirm that the new memory is detected correctly. If the memory is not detected, check that it is connected correctly.

4.8 FIN COVER ASSY

NOTE: When repairing the computer, clean the cooling fin with a vacuum cleaner.

Do not use cotton sticks and tweezers to remove dusts. It may cause the cooling module problem or dusts stuffed.

Removing the FIN COVER ASSY

To remove the FIN COVER ASSY, follow the steps below and refer to Figure 4-8.

- 1. Loosen the screw securing the FIN COVER ASSY.
- 2. Insert your finger into the slit and remove the FIN COVER ASSY up.

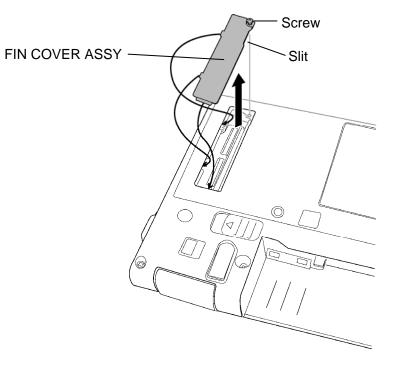


Figure 4-8 Removing the FIN COVER ASSY

Installing the FIN COVER ASSY

To install the FIN COVER ASSY, follow the steps below and refer to Figure 4-8.

- 1. Set the **FIN COVER ASSY** into the slot.
- 2. Secure the FIN COVER ASSY with the screw.

4.9 Optical disk drive (DVD-Super Multi drive)

Removing the Optical disk drive

To remove the Optical disk drive, follow the steps below and refer to Figure 4-9 to 4-10.

CAUTION: When the optical disk inside the optical disk drive can not be ejected because of some failure, open the disc tray by inserting a slender object (about 15 mm) such as a straightened paper clip into the eject hole near the eject button.

- 1. Remove the following screws securing the ODD ASSY.
 - M2.5×6C FLAT HEAD screw ×2
- 2. Remove the **ODD ASSY** from the slot while pushing it in the direction as shown in the figure below.

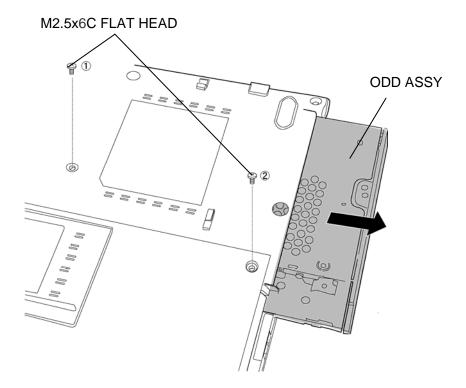


Figure 4-9 Removing the Optical disk drive (1)

NOTE: The circled number shows the order to drive the screws.

- 3. Remove the following screws and ODD REAR BRKT.
 - M2.0×2.7C STEP screw ×2
- 4. Remove the following screw and ODD SIDE BRKT.
 - M2.0×3C S-THIN HEAD screw ×1

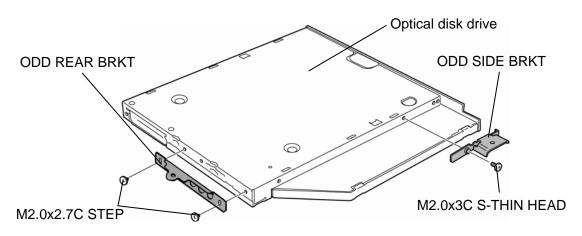


Figure 4-10 Removing the Optical disk drive (2)

Installing the Optical disk drive

To install the Optical disk drive, follow the steps below and refer to Figure 4-9 to 4-10.

- 1. Set the **ODD REAR BRKT** to the **optical disk drive** and secure them with the following **screws**.
 - M2.0×2.7C STEP screw ×2
- 2. Set the **ODD SIDE BRKT** to the optical disk drive and secure them with the following **screw**.
 - M2.0×3C S-THIN HEAD screw ×1
- 3. Insert the **ODD ASSY** into the slot to connect it to the connector on the system board and secure optical disk drive assembly with the following **screws**.
 - M2.5×6C FLAT HEAD screw ×2

CAUTION: Drive the screws in the order shown in the Figure 4-9.

4.10 Keyboard

Removing the Keyboard

To remove the keyboard, follow the steps below and refer to Figure 4-11 to 4-12.

CAUTION: As the keytop may fall out, when handling the keyboard always hold it by the frame and do not touch the keytop.

- 1. Turn over the computer and open the display.
- 2. Insert your fingers into the **slit** and remove **KB HOLDER** while releasing the latches.
- 3. Remove the following screws securing the keyboard.
 - M2.0×4B BIND screw ×2
- 4. Lift the top edge of the **keyboard** and turn the keyboard face down on the palm rest portion of COVER ASSY.

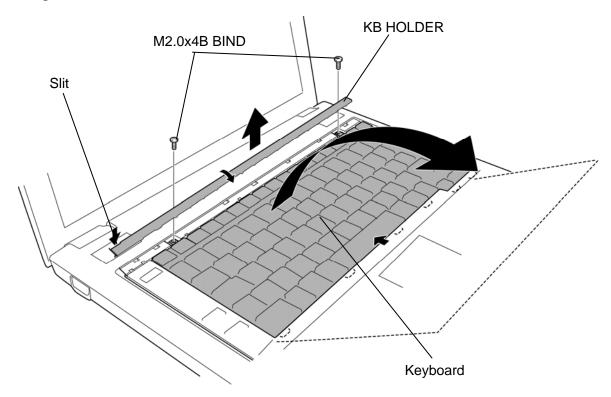


Figure 4-11 Removing the keyboard (1)

- 5. Remove the following **screw** and slide the **KB SUP PLT ASSY** as shown below to remove.
 - M2.5×3C S-THIN screw ×1
- 6. Disconnect the **keyboard flexible cable** from the connector **CN3230** on the system board and remove the **keyboard**.

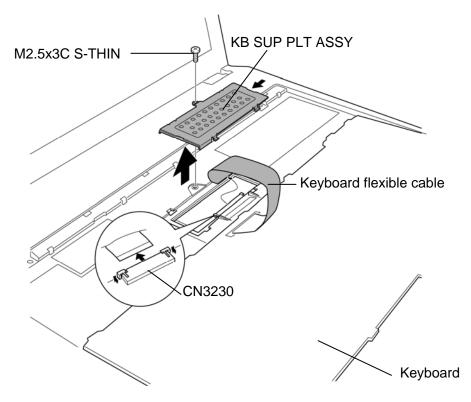


Figure 4-12 Removing the keyboard (2)

Installing the Keyboard

To install the keyboard, follow the steps below and refer to Figure 4-11 to 4-12.

- 1. Set the **keyboard** on the palm rest of the COVER ASSY with the upside down.
- 2. Connect the **keyboard flexible cable** to the connector **CN3230** on the system board and remove the keyboard.
- 3. Set the **KB SUP PLT ASSY** and secure it the following screw.
 - M2.5×3C S-THIN screw ×1
- 4. Turn the keyboard face up and set it in place.
- 5. Secure the keyboard with the following **screw**s.
 - M2.0×4B BIND screw ×2
- 6. Set the **KB HOLDER** while latching it.

4.11 BASE ASSY

Removing the BASE ASSY

To remove the BASE ASSY, follow the steps below and refer to Figure 4-13 to 4-15.

- 1. Remove the INSU LCD HNS UP from the COVER ASSY
- 2. Disconnect the LCD harness from the connector CN5000 on the system board.
- 3. Remove the following screws securing the COVER ASSY.
 - M2.5×6C FLAT HEAD screw ×2

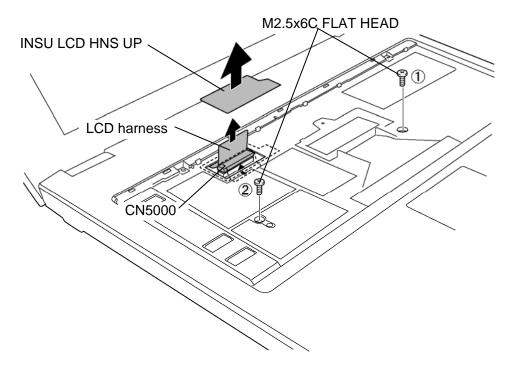


Figure 4-13 Removing the BASE ASSY (1)

NOTE: The circled number shows the order to drive the screws.

- 4. Turn the computer upside down.
- 5. Disconnect the **ExpressCard slot FPC** from the connector **CN2520** on the system board.

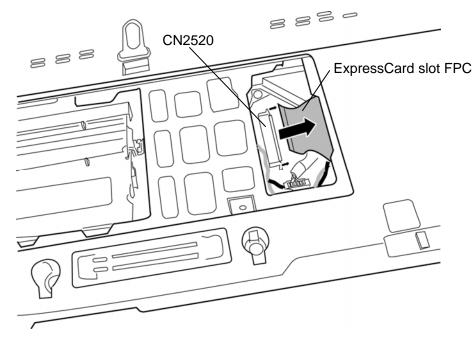


Figure 4-14 Removing the BASE ASSY (2)

6. Remove the following **screws** securing the BASE ASSY.

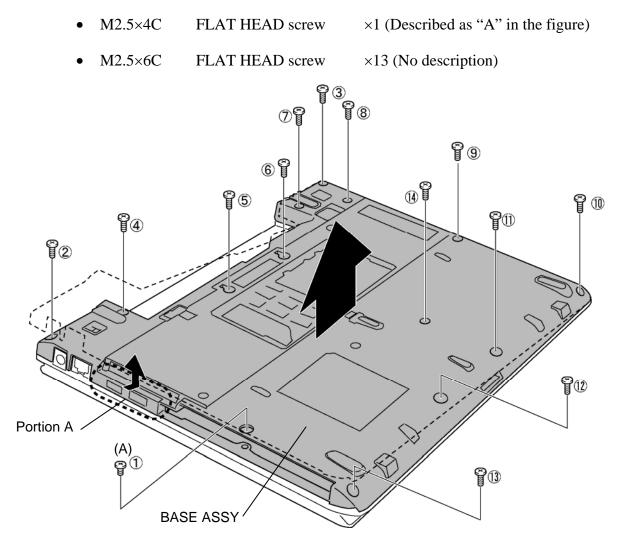


Figure 4-15 Removing the BASE ASSY (3)

NOTE: The circled number shows the order to drive the screws.

7. Remove the **BASE ASSY** while lifting the LAN connector side first.

NOTE: When removing the BASE ASSY, lift the LAN connector side up while pushing the *Portion A*.

Installing the BASE ASSY

To install the BASE ASSY, follow the steps below and refer to Figure 4-13 to 4-15.

- 1. Set the **BASE ASSY** in place while setting the RGB connector side first. (See figure 4-15).
- 2. Secure the BASE ASSY with the following **screw**s.
 - M2.5×6C FLAT HEAD screw ×13 (No description)
 - M2.5×4C FLAT HEAD screw ×1 (Described as "A" in the figure)

CAUTION: Drive the fourteen screws in the order shown in the Figure 4-15.

- 3. Connect the ExpressCard slot FPC to the connector CN2520 on the system board.
- 4. Turn the computer upside down.
- 5. Connect the **LCD harness** to the connector **CN5000** on the system board.
- 6. Stick the **INSU LCD HNS UP** on the **COVER ASSY** in place.

CAUTION: Do not reuse the removed INSU LCD HNS UP. Use a new one.

- 7. Secure the BASE ASSY with following screws.
 - M2.5×6C FLAT HEAD screw ×2

CAUTION: Drive the two screws in the order shown in the Figure 4-13.

4.12 ExpressCard slot/KILL SW HOL ASSY

Removing the ExpressCard slot/KILL SW HOL ASSY

NOTE: Before starting, make sure that a dummy card is removed.

To remove the ExpressCard slot (EXPRESSCARD CONNECTOR WITH FPC) /KILL SW HOL ASSY, follow the steps below and refer to Figure 4-16 to 4-17.

- 1. Turn over the **BASE ASSY**.
- 2. Remove the following **screw**s securing the ExpressCard slot.
 - M2.0×5B S-THIN HEAD screw ×4
- 3. Remove the **ExpressCard slot** from the **BASE ASSY**.
- 4. Peel off the **INSU EXP SLOT UP** from the **ExpressCard slot**.

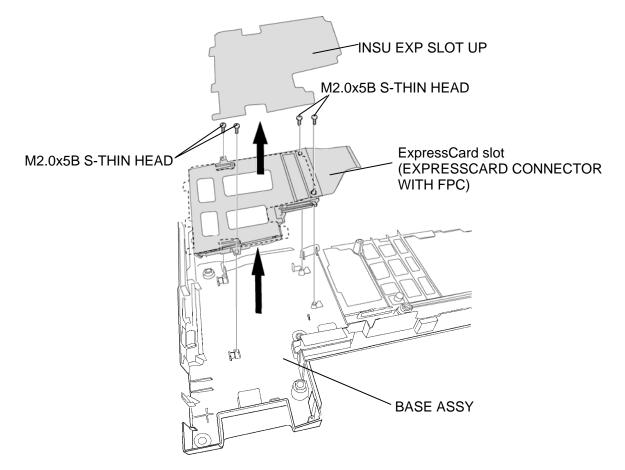
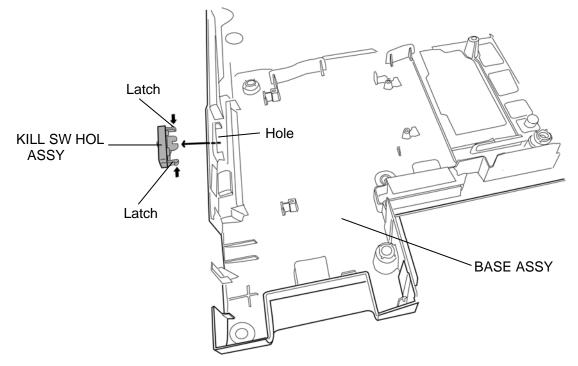


Figure 4-16 Removing the ExpressCard slot



5. Remove the **KILL SW HOL ASSY** from the **BASE ASSY** while releasing the **latches**.

Figure 4-17 Removing the KILL SW HOL ASSY

Installing the ExpressCard slot/KILL SW HOL ASSY

To install the ExpressCard slot (EXPRESSCARD CONNECTOR WITH FPC) /KILL SW HOL ASSY, follow the steps below and refer to Figure 4-16 to 4-17.

1. Push the **KILL SW HOL ASSY** into the **hole** until it is latched.

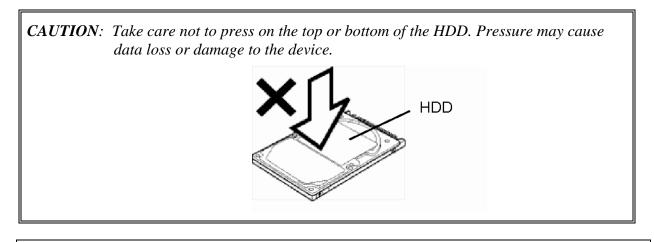
CAUTION: Do not mistake the top for bottom of KILL SW HOL ASSY. As it is mounted slantwise, if mistaking, only the switch projects and the SW function (on/off) does not work.

2. Stick the **INSU EXP SLOT UP** on the **ExpressCard slot** in place.

CAUTION: When the INSU EXP SLOT UP is deformed or broken, do not reuse it.

- 3. Set the **ExpressCard slot** on the **BASE ASSY** and secure it with the following **screws**.
 - M2.0×5B S-THIN HEAD screw ×4

4.13 HDD/SSD



NOTE: The procedures for removing/installing the SSD are the same with HDD.

Removing the moving HDD/SSD

To remove the HDD/SSD, follow the steps below and refer to Figure 4-18.

- 1. Disconnect the HDD/SSD FPC from the connector CN1900 on the system board.
- 2. Remove the **HDD/SSD** from the slot.
- 3. Disconnect the HDD/SSD FPC from the HDD/SSD connector.

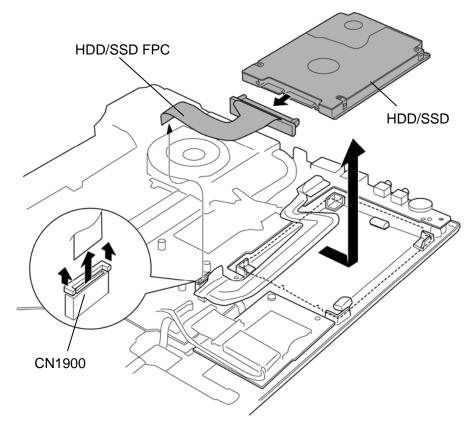


Figure 4-18 Removing the HDD/SSD

Installing the HDD/SSD

To install the HDD/SSD, follow the steps below and refer to Figure 4-18.

- 1. Connect the **HDD/SSD FPC** to HDD/SSD connector.
- 2. Set the **HDD/SSD** in the slot in place.
- 3. Connect the HDD/SSD FPC to the connector CN1900 on the system board.

4.14 Wireless LAN card

CAUTION: Do not touch the connectors on the Wireless LAN card. Debris on the connectors may cause the wireless LAN card access problems.

Removing the Wireless LAN card

To remove the wireless LAN card, follow the steps below and refer to Figure 4-19.

- 1. Disconnect two Wireless LAN antenna cables from the wireless LAN card.
- 2. Remove the following screws securing wireless LAN card.
 - M2.0×4B S-THIN HEAD screw ×2
- 3. Disconnect the Wireless LAN card from the connector CN2600 on the system board.

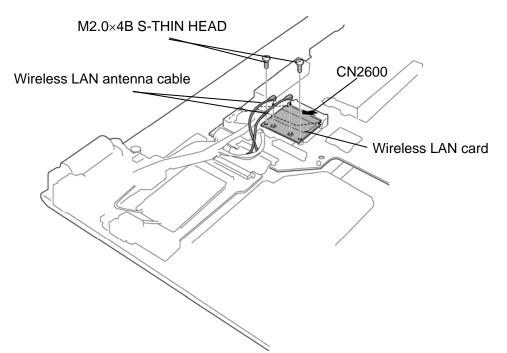


Figure 4-19 Removing the Wireless LAN card

Installing the Wireless LAN card

To install the Wireless LAN card, follow the steps below and refer to Figure 4-19.

1. Insert the **Wireless LAN card** to the connector **CN2600** on the system board slantwise and press it to connect firmly.

NOTE: Align the notch of the Wireless LAN card to the guide of the connector.

- 2. Secure the Wireless LAN card with the following screws.
 - M2.0×4B S-THIN HEAD screw ×2
- 3. Connect two Wireless LAN antenna cables to the connectors on the wireless LAN card.

4.15 RTC battery

CAUTION: Risk of explosion if battery is replaced by an incorrect type. Dispose of used batteries according to the laws and ordinances of your local authority.

Removing the RTC battery

To remove the RTC battery, follow the steps below and refer to Figure 4-20-1 to 4-20-2.

- 1. Disconnect the **ODD FPC** from connector **CN1950** on the system board and remove the following screw to remove the **ODD CONN HOLD BRKT** from the BASE ASSY.
 - M2.5×4C FLAT HEAD screw ×1
- 2. Disconnect the **RTC battery harness** from the connector **CN9300** on the system board.
- 3. Remove the **INSU RTC BATT** fixed to the **SD board** with the double-sided tape.
- 4. Open the cover of INSU RTC BATT while peeling adhered portion with the double-sided tape and remove the **RTC battery** from the INSU RTC BATT.

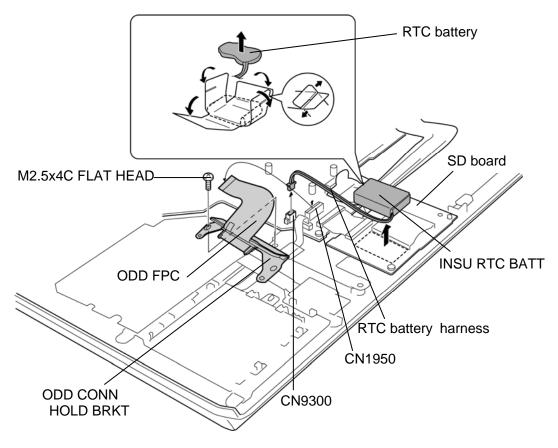


Figure 4-20-1 Removing the RTC battery (1)

5. Remove following screws to separate the ODD FPC from the ODD CONN HOLD BRKT.

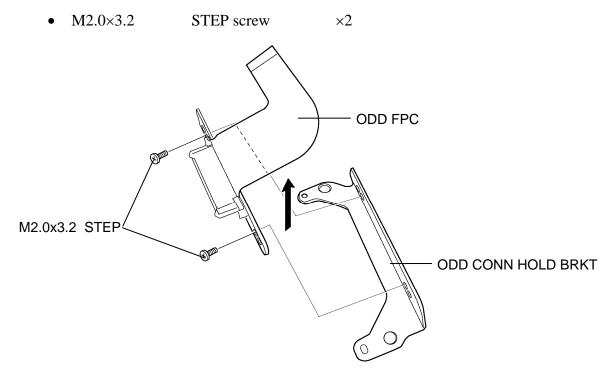


Figure 4-20-2 Removing the RTC battery (2)

Installing the RTC battery

To install the RTC battery, follow the steps below and refer to Figure 4-20.

- 1. Set the **RTC battery** into the **INSU RTC BATT** and close of the cover portion of INSU RTC BATT. (The cover INSU RTC BATT is adhered with the double-sided tape.)
- 2. Stick the INSU RTC BATT on the **SD board** in place.
- 3. Connect the **RTC battery harness** to the connector **CN9300** on the system board.
- 4. Secure the **ODD FPC** to the **ODD CONN HOLD BRKT** with following screws.
 - M2.0×3.2 STEP screw ×2
- 5. Secure the ODD CONN HOLD BRKT with the following screw to the BASE ASSY.
 - M2.5×4C FLAT HEAD screw ×1
- 6. Connect the **ODD FPC** to the connector **CN1950** on the system board.

4.16 DC-IN HARNESS/RJ45 WIRE HARNESS

Removing the DC-IN HARNESS/RJ45 WIRE HARNESS

To remove the DC-IN HARNESS/RJ45 WIRE HARNESS, follow the steps below and refer to Figure 4-21 to 4-23.

- 1. Disconnect the **DC-IN HARNESS** from the connector **CN8800** on the system board.
- 2. Remove the DC-IN HARNESS from the slot.

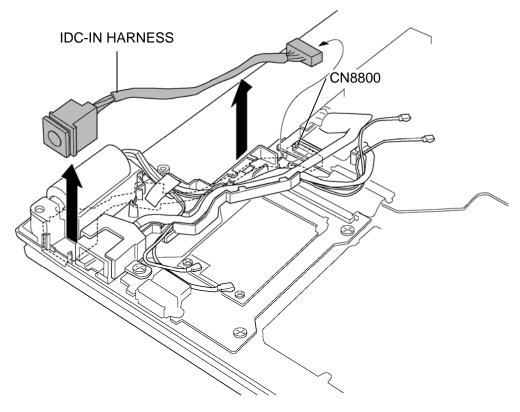


Figure 4-21 Removing the DC-IN HARNESS/RJ45 WIRE HARNESS (1)

- 3. Remove the **acetate tape**.
- 4. Disconnect the **CAMERA HARNESS** from the connector **CN9540** on the system board and two **3G antenna cables** from the terminals on the **3G card**.
- 5. Disconnect the **RJ45 WIRE HARNESS** from the connector **CN4100** on the system board.
- 6. Take the harness of RJ45 WIRE HARNESS, CAMERA HARNESS, the 3G antenna cables and wireless LAN antenna cables out of the guides on the HARNESS HOLDER R.

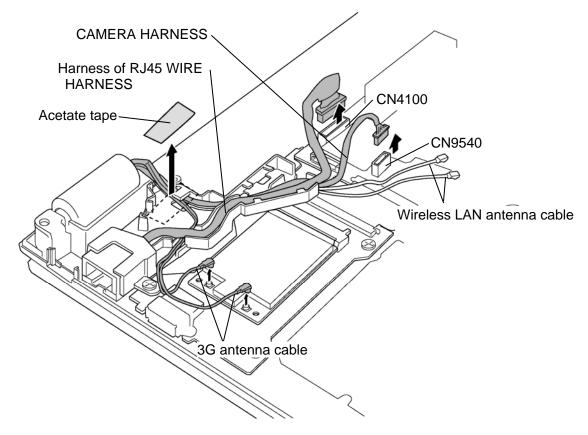


Figure 4-22 Removing the DC-IN HARNESS/RJ45 WIRE HARNESS (2)

- 7. Remove the following screws and remove the **HARNESS HOLDER R** from the slot while releasing **three latches** (pulling two latches and pushing one inside as shown in the figure).
 - M2.5×6C FLAT HEAD screw ×1
- 8. Remove the **RJ45 WIRE HARNESS** from the HARNESS HOLDER R.

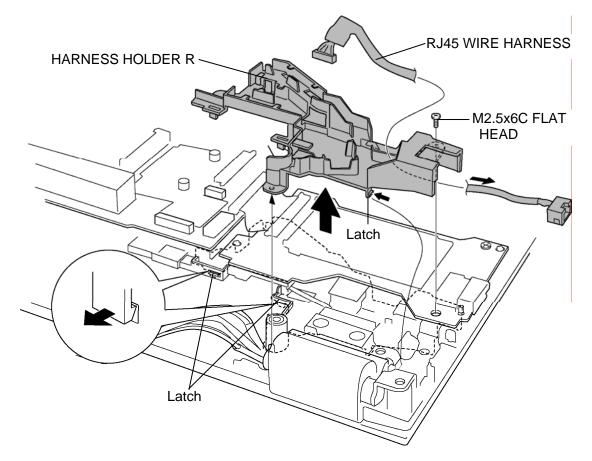


Figure 4-23 Removing the DC-IN HARNESS/RJ45 WIRE HARNESS (3)

Installing the DC-IN HARNESS/RJ45 WIRE HARNESS

To install the DC-IN HARNESS/RJ45 WIRE HARNESS, follow the steps below and refer to Figure 4-21 to 4-23.

- 1. Set the **RJ45 WIRE HARNESS** into the HARNESS HOLDER R.
- 2. Set the **HARNESS HOLDER R** in the slot in place and secure it with following screws.
 - M2.5×6C FLAT HEAD screw ×1
- 3. Arrange the **3G antenna cables**, **Wireless LAN antenna cables**, **RJ45 WIRE HARNESS** and **CAMERA HARNESS** on the HARNESS HOLDER R.
- 4. Connect the two **3G antenna cables** to the terminals on the **3G card**, **RJ45 WIRE HARNESS** to the connector **CN4100** on the system board and **CAMERA HARNESS** to the connector **CN9540** on the system board.
- 5. Stick the **acetate tape** in place.
- 6. Set the **DC-IN HARNESS** in the slot in place and connect the **DC-IN HARNESS** to the connector **CN8800** on the system board.

4.17 3G card/SIM board

CAUTION: Do not touch the connectors on the 3G card. Debris on the connectors may cause the 3G card access problems.

Removing the 3G card/SIM board

To remove the 3G card/SIM board, follow the steps below and refer to Figure 4-24 to 4-25.

1. Remove the following screws and the **3G card** from the connector **CN2610** on the **SIM board**.

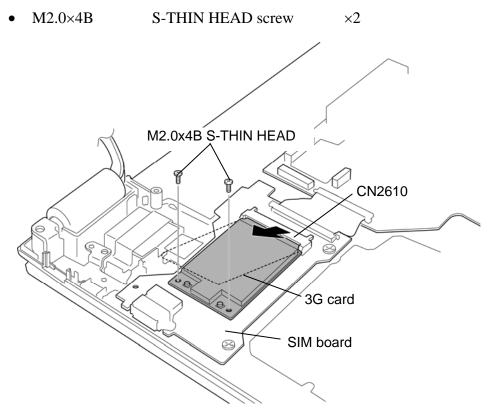


Figure 4-24 Removing the3G card/SIM board (1)

- 2. Remove the following **screws** and the SIM board from the connector **CN9580** on the system board.
 - M2.5×4C FLAT HEAD screw ×2
- 3. Remove the **SIM board FPC** from the connector **CN9880** on the SIM board.

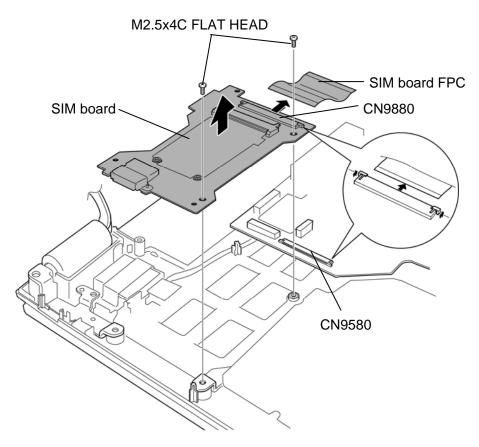


Figure 4-25 Removing the3G card/SIM board (2)

Installing the 3G card/SIM board

To install the 3G card/SIM board, follow the steps below and refer to Figure 4-24 to 4-25.

- 1. Connect the **SIM board FPC** to the connector **CN9880** on the SIM board.
- 2. Secure **SIM board** with the following screws.
 - M2.5×4C FLAT HEAD screw ×2
- 3. Connect the SIM board FPC to the connector CN9580 on the system board.
- 4. Insert the **3G card** slantwise into the connector **CN2610** on the SIM card.

NOTE: Insert the dent of the 3G card to the guide of the connector.

- 5. Secure the 3G card with the following screws.
 - M2.0×4B S-THIN HEAD screw ×2

4-44

4.18 Bluetooth module

Removing the Bluetooth module

To remove the Bluetooth module, follow the steps below and refer to Figure 4-26.

- 1. Lift the **hook** of **BT HOLDER** up and slide it to remove.
- 2. Remove the **Bluetooth module** from the COVER ASSY.
- 3. Disconnect the **BT HARNESS** carefully from the connector of Bluetooth module.

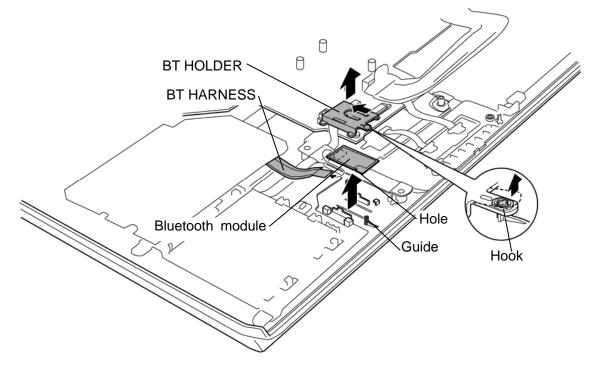


Figure 4-26 Removing the Bluetooth module

Installing the Bluetooth module

To install the Bluetooth module, follow the steps below and refer to Figure 4-26.

- 1. Connect the **BT HARNESS** to the connector on the Bluetooth module.
- 2. Set the **Bluetooth module** on the COVER ASSY while inserting the **hole** into the **guid**e.
- 3. Slide the **BT HOLDER** under the four **guides** until the hook is latched.

CAUTION: When connecting the *BT HARNESS* to Bluetooth module, insert it carefully not to damage the Bluetooth module.

4-46

4.19 Smart card slot

Removing the Smart card slot

To remove the Smart card slot, follow the steps below and refer to Figure 4-27.

- 1. Peel the INSU FPC SC on the TPAD PLT ASSY.
- 2. Disconnect the **FPC of Smart card slot** from the connector **CN2170** on the system board.
- 3. Lift the **hook** of Smart card slot and slide it to the left to remove.

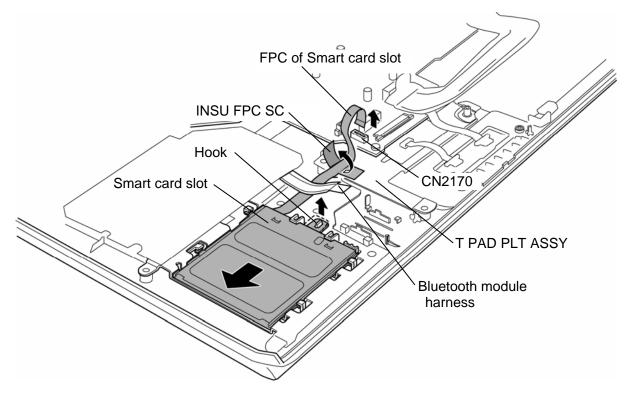


Figure 4-27 Removing the Smart card slot

Installing the Smart card slot

To install the Smart media slot, follow the steps below and refer to Figure 4-27.

- 1. Insert the **Smart card slot** under the guides until the **hook** is latched.
- 2. Pass the **FPC of Smart card slot** under the **Bluetooth module harness** and fix it with **INSU FPC SC**.
- 3. Connect FPC of Smart card slot to the connector **CN2170** on the system board.

4.20 SD board

Removing the SD board

To remove the SD board, follow the steps below and refer to Figure 4-28.

- 1. Disconnect the SD BOARD FPC from the connector CN9530 on the system board.
- 2. Remove the following screws and SD board.
 - M2.5×4C FLAT HEAD ×2
- 3. Disconnect SD BOARD FPC from the SD board.

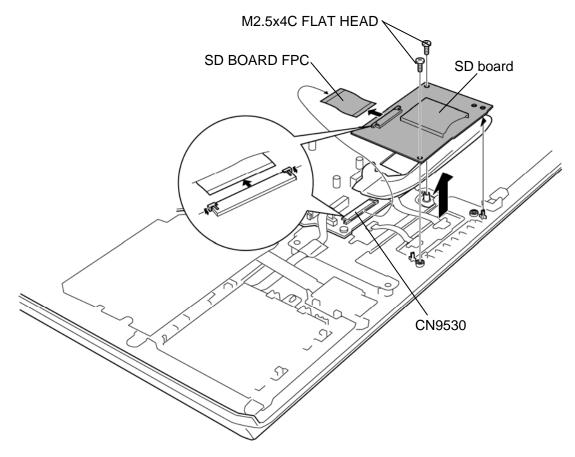


Figure 4-28 Removing the SD board

Installing the SD board

To install the SD board, follow the steps below and refer to Figure 4-28.

- 1. Connect the SD BOARD FPC to the SD board
- 2. Secure the SD board with the following **screw**s.
 - M2.5×4C FLAT HEAD $\times 2$
- 3. Connect SD BOARD FPC to the connector CN9530 on the system board.

4.21 RGB HARNESS

Removing the RGB HARNESS

To remove the RGB HARNESS, follow the steps below and refer to Figure 4-29.

- 1. Remove the following **screw**s to remove the **RGB HARNESS** from the slot.
 - #4-40×5C UNIFIED screw ×2
- 2. Peel the **INSU RGB HNS** fixing the RGB HARNESS to the DC-FAN.
- 3. Disconnect the RGB HARNESS from the connector CN9510 on the system board.

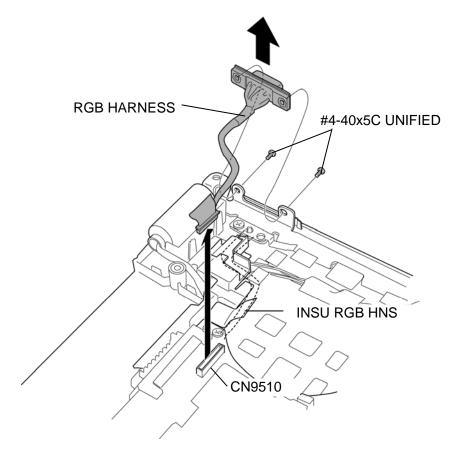


Figure 4-29 Removing the RGB HARNESS

Installing the RGB HARNESS

To install the RGB HARNESS, follow the steps below and refer to Figure 4-29.

- 1. Set the **RGB HARNESS** in the slot in place and secure it with the following **screws**.
 - #4-40×5C UNIFIED screw ×2
- 2. Connect the RGB HARNESS to the connector **CN9510** on the system board.
- 3. Fix the RGB HARNESS to the DC FAN with the **INSU RGB HNS**.

4.22 DC FAN

CAUTION: Do not apply pressure to the DC FAN.

Removing the DC FAN

To remove the DC FAN, follow the steps below and refer to Figure 4-30 to 4-32.

- 1. Remove the following **screws** to remove **H SINK PLT** and screws fixing the **VGA PLATE HOLDER** (only for external graphics chip model).
 - M1.6×4C OTHER screw ×4
 - M1.6×4C OTHER screw ×2 (for external Graphics chip)

NOTE: When removing the H SINK PLT or VGA PLATE HOLDER, be sure to remove the screws in the reverse order of the number marked on the heat.

- 2. Disconnect the DC FAN harness from the connector CN8771 on the system board.
- 3. Peel the **INSU RGB HNS** fixing the RGB harness to DC FAN and remove the **DC FAN assembly** from the system board.

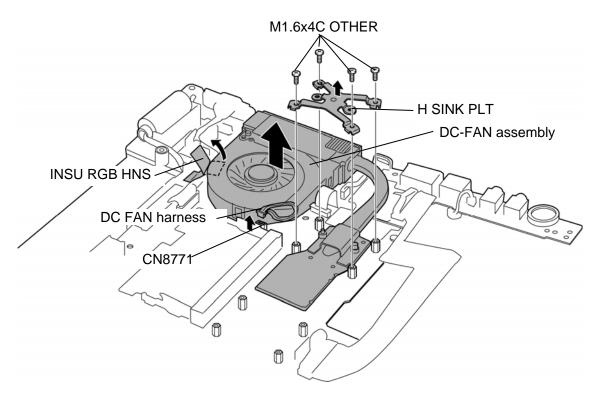


Figure 4-30 Removing the DC FAN (1)

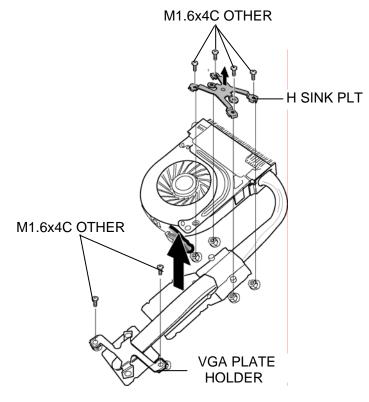


Figure 4-31 Removing the DC FAN (2) (for external graphics chip model)

- 4. Turn over the DC FAN assembly and peel off the INSU FIN UP.
- 5. Remove the following screws and separate the DC FAN and FIN.

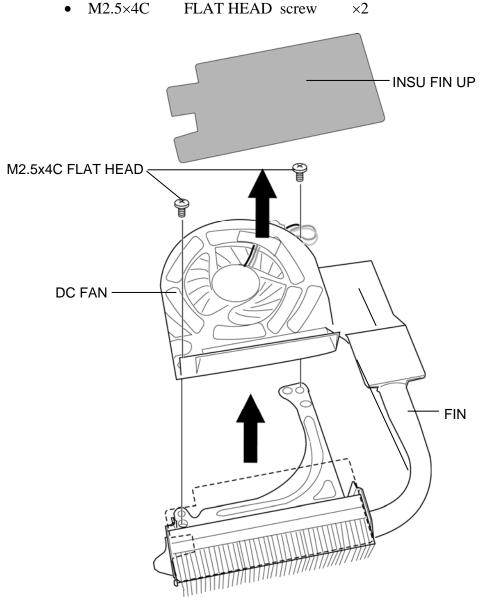


Figure 4-32 Removing the DC FAN(3)

Installing the DC FAN

To install the DC FAN, follow the steps below and refer to Figure 4-30 to 4-33.

- 1. Secure the **DC FAN** to the **FIN** with the following screws.
 - M2.5×4C FLAT HEAD screw ×2
- 2. Stick the **INSU FIN UP** on the DC FAN and FIN.

CAUTION: When the removed INSU FIN UP is deformed or broken. Use a new one.

- 3. Turn over the **DC FAN assembly**.
- 4. When silicon grease is already applied to the CPU or FIN, wipe them off with a cloth in advance.
- 5. Apply new **GREASE** (**DENKA GFC-F1**) on the CPU using a special **syringe** as shown in the following figure. Apply quarter of scale (0.25ml) of grease evenly on the CPU chip.

CAUTION: Apply the silicon grease to cover the chip surface using the special applicator to cover the chip surface. Use a spatula to spread new grease.

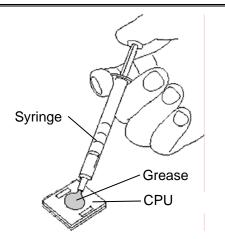


Figure 4-33 Applying new grease

- 6. If there is already a COOL SHEET on the FIN, North Bridge chip, or external graphics chip, remove the COOL SHEET.
- 7. Stick a new COOL SHEET on the North Bridge chip and external graphics chip in place.

CAUTION: Do not reuse the removed cool sheet. Be sure to use a new COOL SHEET.

- 8. Secure the **H SINK PLT** and **VGA PLATE HOLDER** (only for external graphics chip model) with the following **screws**.
 - M1.6×4C OTHER screw ×4
 - M1.6×4C OTHER screw ×2 (for external Graphics chip)

NOTE: When securing the *H* SINK PLT and VGA PLATE HOLDER, be sure to secure the screws in the order of the number marked on the plate.

- 9. Set the **DC FAN assembly** in place and connect the **DC FAN harness** to the connector **CN8771** on the system board.
- 10. Fix the **RGB harness** to the DC FAN with **INSU RGB HNS**.

4.23 Sound/USB board and MIC HARNESS

Removing the Sound/USB board and MIC HARNESS (Internal microphone)

To remove the Sound/USB board and MIC HARNESS, follow the steps below and refer to Figure 4-34.

- 1. Remove the following screw securing the Sound/USB board.
 - M2.0×4B BIND screw ×1
- 2. Disconnect the **SOUND/USB HARNESS** from the connector **CN9520** on the system board.
- 3. Disconnect the **SOUND/USB HARNESS**, **Speaker harness** and **MIC HARNESS** from the connector **CN9820**, **CN6180** and **CN6050** on the Sound/USB board.
- 4. Remove the **Sound/USB board** from the slot.
- 5. Remove the **MIC HARNESS** from the slot.

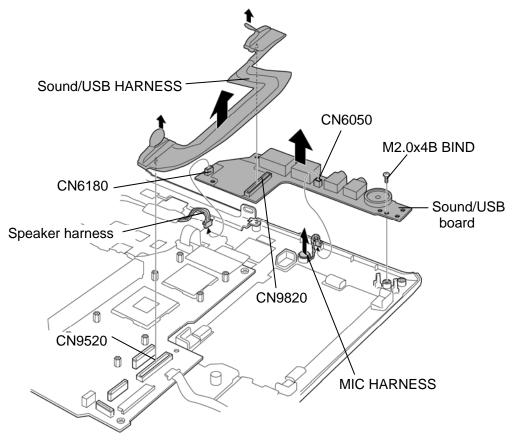


Figure 4-34 Removing the Sound/USB board and MIC HARNESS

Installing the Sound/USB board and MIC HARNESS (Internal microphone)

To install the Sound/USB board and MIC HARNESS, follow the steps below and refer to Figure 4-34.

- 1. Set the **MIC HARNESS** to the slot in place.
- 2. Set the **Sound/USB board** in place and secure it with the following **screw**.
 - M2.0×4B BIND screw ×1
- 3. Connect the **SOUND/USB HARNESS**, **speaker harness** and **MIC HARNESS** to the connector **CN9820**, **CN6180** and **CN6050** on the Sound/USB board.
- 4. Connect the **SOUND/USB HARNESS** to the connector **CN9520** on the system board.

4.24 System board

Removing the System board

To remove the system board, follow the steps below and refer to Figure 4-35.

- 1. Disconnect the **SW board FFC** and **Touch pad FFC** from the connector **CN9500** and **CN9550** on the system board.
- 2. Peel the **INSU ODD UPPER** to release the **Bluetooth module harness**.
- 3. Remove the following **screw**s securing the system board.
 - M2.5×4C FLAT HEAD ×3
- 4. Remove the **system board**.
- 5. Turn over the system board and disconnect the **Bluetooth module harness** from the connector **CN4440** on the system board.

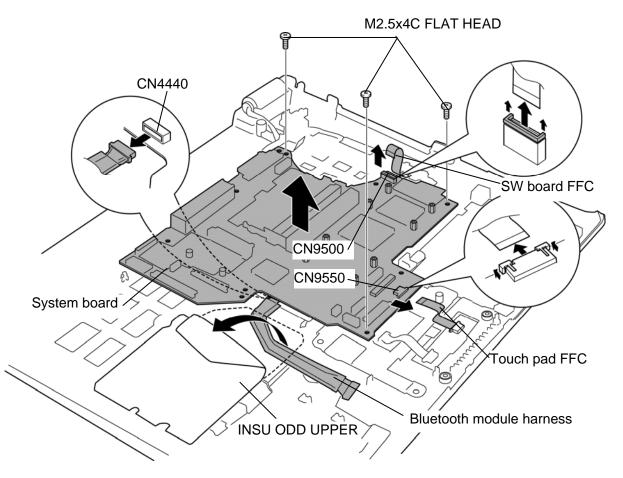


Figure 4-35 Removing the system board

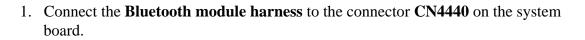
[CONFIDENTIAL]

Installing the System board

CN 5000

To install the system board, follow the steps below and refer to Figure 4-35.

NOTE: When replacing with a new system board, stick **INSU LCD CONN** on the system board as shown below.



- 2. Turn over the **system board** and set in place.
- 3. Secure the system board with the following **screw**s.
 - M2.5×4C FLAT HEAD ×3
- 4. Open the **INSU ODD UPPER** and set **Bluetooth module harness** under the INSU ODD UPPER to fix it.
- 5. Connect the SW board FFC and Touch pad FFC to the connector CN9500 and CN9550 on the system board.

4.25 SPEAKER ASSY

Removing the SPEAKER ASSY

To remove the SPEAKER ASSY, follow the steps below and refer to Figure 4-36 to 4-37.

1. Slide the **HARNESS HOLDER L** in the direction as shown below to remove it.

NOTE: There are four latches. They are released by sliding the HARNESS HOLDER L in the direction as shown below.

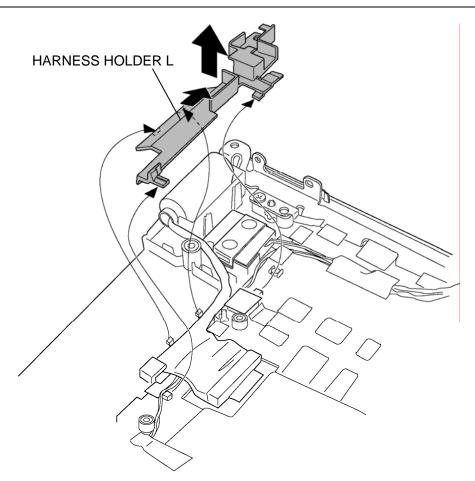


Figure 4-36 Removing the speaker (1)

- 2. Peel off three acetate tapes fixing the harness of SPEAKER ASSY.
- 3. Remove the right and left **SPEAKER PLT**s while releasing latches.
- 4. Take out the **SPEAKER ASSY** from the right and left slots.

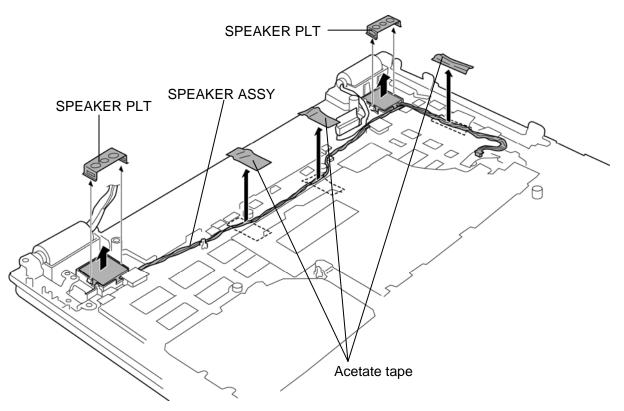


Figure 4-37 Removing the speaker (2)

Installing the Speaker

To install the speaker, follow the steps below and refer to Figure 4-36 to 4-37.

1. Set the right and left speaker of **SPEAKER ASSY** into the slots.

CAUTION: When setting the SPEAKER ASSY, do not crush the cushion.

- 2. Set the **SPEAKER PLT**s on the right and left speakers of **SPEAKER ASSY**.
- 3. Arrange the harness of **SPEAKER ASSY** in place and stick **acetate tapes** in place to fix the speaker harness.
- 4. Install the **HARNESS HOLDER L** while sliding it in the opposite direction when removing.

4.26 LCD COVER ASSY

Removing the LCD COVER ASSY

To remove the LCD COVER ASSY, follow the steps below and refer to Figure 4-38.

- 1. Open the LCD COVER ASSY at angle of 90 degree to the COVER ASSY.
- 2. Set the COVER ASSY on a flat desk as shown below.
- 3. Remove the following **screws** fixing the **BH L ASSY** and **BH R ASSY** (right and left hinges). (The **GND SPG FIN** is secured together with the BH L ASSY)
 - M2.5×6C TAPPING Screw $\times 2$ (1 each)
- 4. Remove LCD COVER ASSY with the BH L ASSY and BH R ASSY from the COVER ASSY.

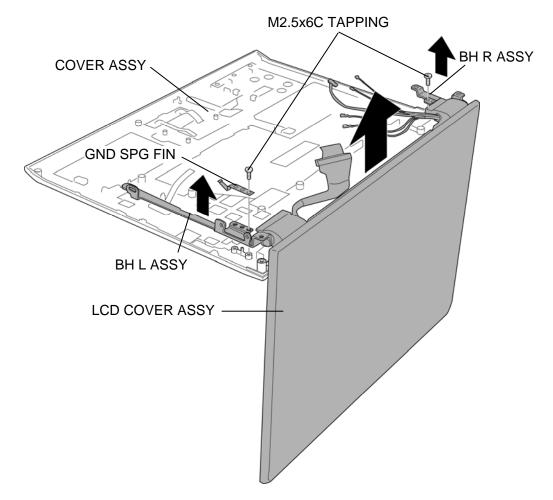


Figure 4-38 Removing the LCD COVER ASSY

Installing the LCD COVER ASSY

To install the LCD COVER ASSY, follow the steps below and refer to Figure 4-38.

- 1. Place the **COVER ASSY** on the flat desk.
- 2. Set the **LCD COVER ASSY** on the COVER ASSY in place.
- 3. Secure the **GND SPG FIN**, **BH L ASSY** and **BH R ASSY** to the COVER ASSY with the following **screw**s.
 - M2.5×6C TAPPING Screw $\times 2$ (1 each)

4.27 MEMBRANE SW

Removing the MEMBRANE SW

To remove the MEMBRANE SW, follow the steps below and refer to Figure 4-39 to 4-41.

- 1. Peel off the INSU BTN COV HLD.
- 2. Remove the **BUTTON COV ASSY**.

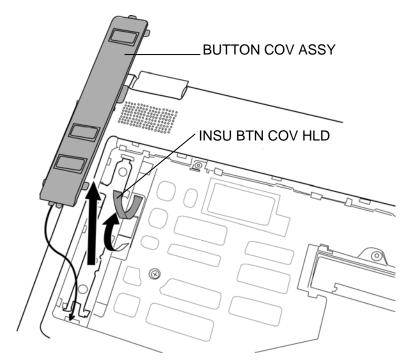


Figure 4-39 Removing the MEMBRANE SW(1)

- 3. Turn over the COVER ASSY.
- 4. Lift up the **hook** of **MEMB HOLD ASSY** and slide the MEMB HOLD ASSY as shown below to remove it.

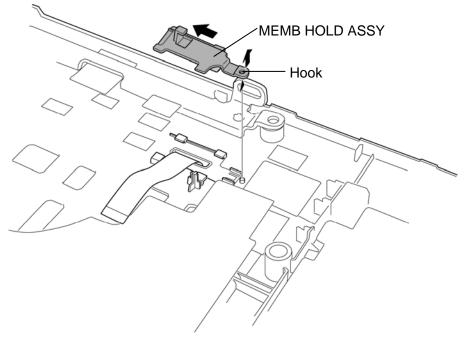


Figure 4-40 Removing the MEMBRANE SW (2)

- 5. Remove the **INSU SQUARE** (on the back).
- 6. Turn over the COVER ASSY.
- 7. Press down the **hook** of COVER ASSY and slide the **MEMBRANE SW** as shown below to remove it.

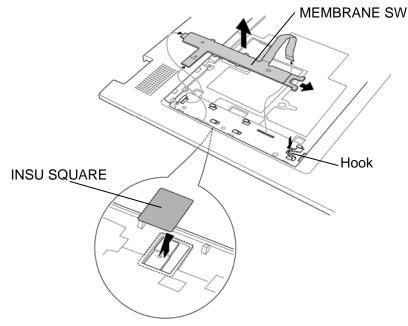


Figure 4-41 Removing the MEMBRANE SW (3)

Installing the MEMBRANE SW

To install the MEMBRANE SW, follow the steps below and refer to Figure 4-39 to 4-41.

- 1. Set the **MEMBRANE SW** in the slot in place and slide it until the **hook** is latched.
- 2. Turn over the COVER ASSY.
- 3. Stick a new INSU SQUARE on the COVER ASSY in place.

CAUTION: Do not reuse the removed INSU SQUAER. Use a new one.

- 4. Set the **MEMB HOLD ASSY** on the COVER ASSY in place and slide it until the **hook** is latched.
- 5. Turn over the COVER ASSY.
- 6. Set the **BUTTON COV ASSY** on the COVER ASSY.
- 7. Stick the **INSU BTN COV HLD** to secure the BUTTON COV ASSY.

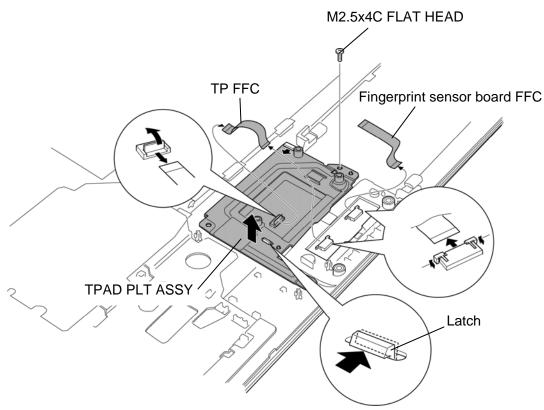
4.28 TOUCH PAD/Fingerprint sensor board

CAUTION: Do not reuse the removed the TOUCH PAD, TP SPILL CUSHION, Fingerprint sensor board and D STICK TAPE TP. When replacing the TP SPILL CUSHION, Fingerprint sensor board and TOUCH PAD, remove the double-sided tape left on the Fingerprint sensor board and COVER ASSY in advance.

Removing the TOUCH PAD/Fingerprint sensor board

To remove the TOUCH PAD/Fingerprint sensor board, follow the steps below and refer to Figure 4-42 to 4-45.

- 1. Disconnect the **TP FFC** from the connector on the **TOUCH PAD** and **Fingerprint** sensor board.
- 2. Disconnect the **Fingerprint sensor board FFC** from the connector on the Fingerprint sensor board.
- 3. Remove the following screw and TPAD PLT ASSY while releasing the latch.



• M2.5×4C FLAT HEAD $\times 1$

Figure 4-42 Removing the TOUCH PAD/Fingerprint sensor board (1)

4. Peel off the **TOUCH PAD**.

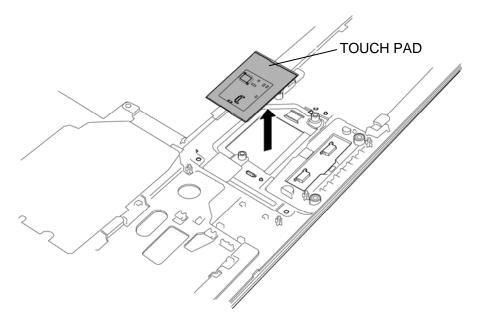


Figure 4-43 Removing the TOUCH PAD/Fingerprint sensor board (2)

- 5. Turn over the COVER ASSY.
- 6. Remove **TP BTN COV ASSY** while releasing latches.

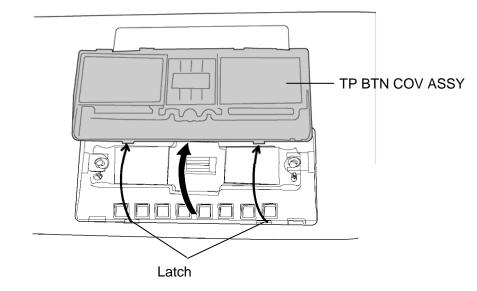


Figure 4-44 Removing the TOUCH PAD /Fingerprint sensor board (3)

- 7. Remove the following **screw**s and peel off the **Fingerprint sensor board**.
 - M2.0×4C S-THIN HEAD $\times 2$
- 8. Remove the **TP SPILL CUSHION** from the Fingerprint sensor board.
- 9. Remove the **D STICK TAPE TP**.

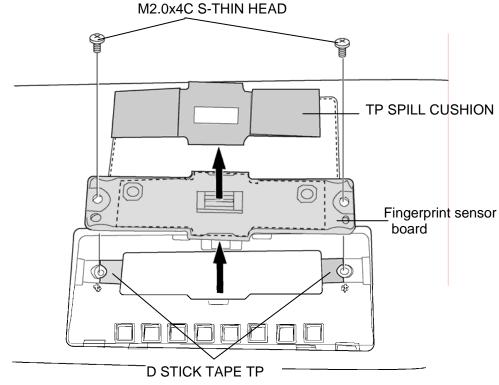


Figure 4-45 Removing the TOUCH PAD /Fingerprint sensor board (4)

Install the TOUCH PAD /Fingerprint sensor board

To install the TOUCH PAD /Fingerprint sensor board, follow the steps below and refer to Figure 4-42 to 4-45.

- 1. Stick a new TP SPILL CUSHION on a new Fingerprint sensor board in place.
- 2. Stick a new **D STICK TAPE TP** in place.
- 3. Stick the Fingerprint sensor board in place on the COVER ASSY and secure it with the following **screw**s.
 - M2.0×4C S-THIN HEAD ×2
- 4. Set the **TP BTN COV ASSY** in place while engaging the latches.
- 5. Turn over the COVER ASSY.
- 6. Stick a new **TOUCH PAD** in place.
- 7. Set the **TPAD PLT ASSY** while engaging the latch and secure it with following screw.
 - M2.5×4C FLAT HEAD $\times 1$
- 8. Connect the **TP FFC** to the connector on the **TOUCH PAD** and **Fingerprint sensor board**.
- 9. Connect the **Fingerprint sensor board FFC** to the connector on the Fingerprint sensor board.

4.29 LCD unit

Removing the LCD unit

To remove the LCD unit, follow the steps below and refer to Figure 4-46 to 4-50.

- 1. Peel off four LCD CUSHIONs and two MASK SEALs (black) from the LCD MASK ASSY.
- 2. Peel off two MASK SEALs (silver) from the LCD COV CAP L and LCD COV CAP R.
- 3. Remove the following screws securing the LCD COV CAP L and LCD COV CAP R.
 - M2.0×8C OTHER screw ×2 (1 each)
- 4. Remove the following screws secure the LCD MASK ASSY.

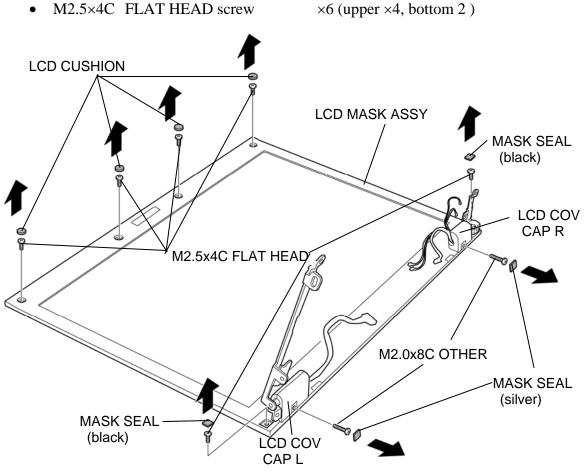


Figure 4-46 Removing the LCD unit (1)

5. Remove the LCD COV CAP L and LCD COV CAP R while releasing latches.

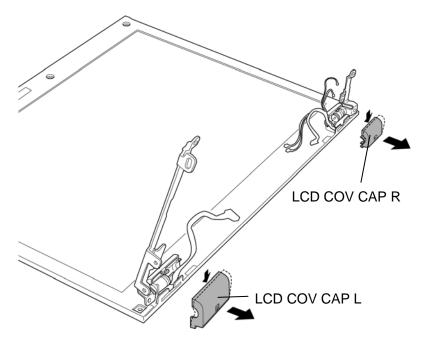


Figure 4-47 Removing the LCD unit (2)

6. Remove the LCD MASK ASSY from the LCD COVER ASSY while releasing the latches.

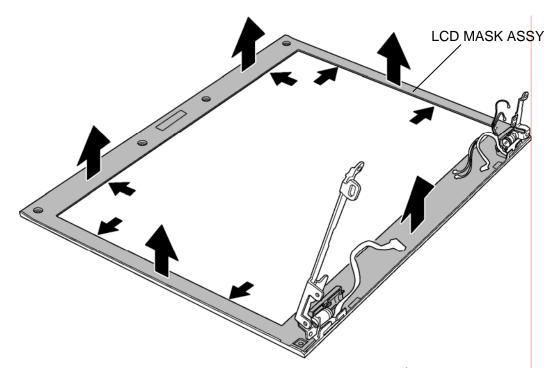


Figure 4-48 Removing the LCD unit (3)

7. Remove the **LCD unit** from the LCD COVER ASSY.

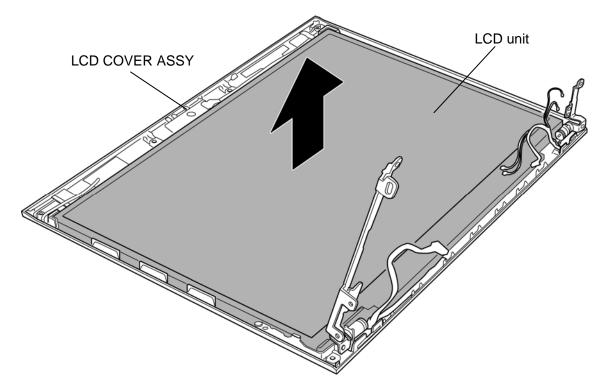


Figure 4-49 Removing the LCD unit (4)

- 8. Peel off the **INSU HNS CONN**.
- 9. Disconnect the LCD harness from the connector on the LCD unit.

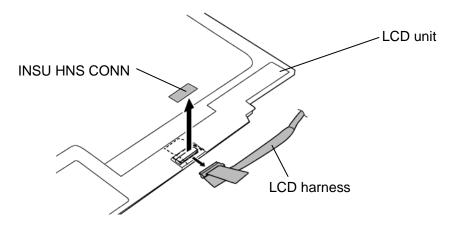
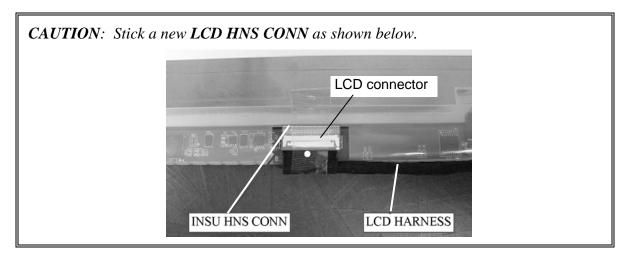


Figure 4-50 Removing the LCD unit (5)

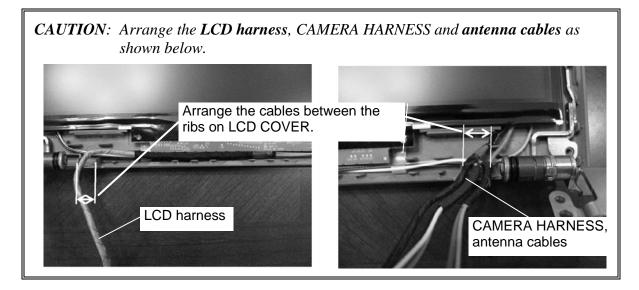
Installing the LCD unit

To install the LCD unit, follow the steps below and refer to Figure 4-46 to 4-50.

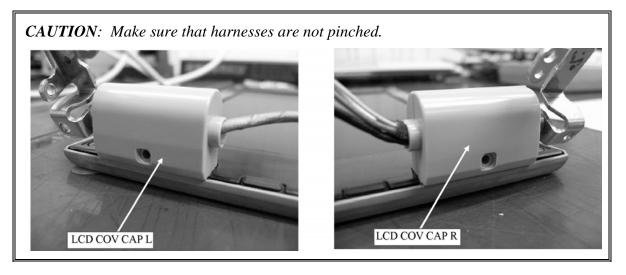
- 1. Connect the **LCD harness** to the connector of the LCD unit.
- 2. Stick a new **INSU HNS CONN** on the LCD connector and LCD HARNESS (connector).



3. Install the LCD unit to the LCD COVER ASSY in place.



4. Set the LCD COV CAP L and LCD COV CAP R while engaging the latches.



- 5. Secure the LCD COV CAP L and LCD COV CAP R with the following screws.
 - M2.0×8C OTHER screw ×2 (1 each)
- 6. Stick two MASK SEALs (silver) on the LCD COV CAP L and LCD COV CAP R.
- 7. Set the **LCD MASK ASSY** on the LCD COVER ASSY and secure it with following crews.
 - M2.5×4C FLAT HEAD screw ×6 (upper ×4, bottom 2)
- 8. Stick four LCD CUSHONs and two MASK SEALs (black) on the LCD mask.

4.30 CAMERA MODULE/Antenna

Removing the CAMERA MODULE/Antenna

To remove the CAMERA MODULE/Antenna, follow the steps below and refer to Figure 4-51 to 4-52.

- 1. Peel the **INSU ANT HOLD S** fixing the CAMERA HARNESS. (only for CAMERA model)
- 2. Peel off the **CAMERA MODULE** from the LCD COVER ASSY.
- 3. Disconnect the CAMERA HARNESS from the CAMERA MODULE.

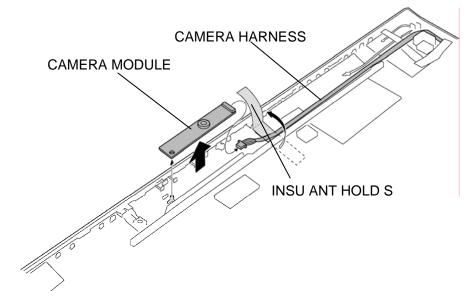
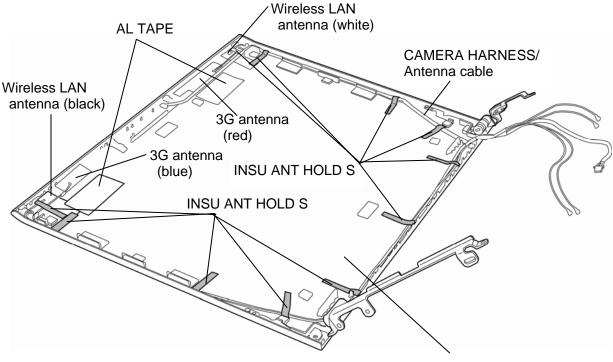


Figure 4-51 Removing the CAMERA MODULE/Antenna (1)

- 4. Peel off the INSU ANT HOLD Ss fixing the CAMERA HARNESS/antennas.
- 5. Peel off the wireless LAN antennas and 3G antennas from the LCD COVER ASSY.



LCD COVER ASSY

Figure 4-52 Removing the CAMERA MODULE/Antenna (2)

NOTE: The AL TAPE is only for 3G MODELs.

Installing the CAMERA MODULE/Antenna

To install the CAMERA MODULE/antennas, follow the steps below and refer to Figure 4-51 to 4-53.

CAUTION: Do not reuse the removed CAMERA MODULE/antennas and INSU ANT HOLD Ss. Use new ones.

1. Stick new INSU ANT HOLD Ss on the LCD COVER ASSY aligning to the guide lines (dotted lines) as shown below.

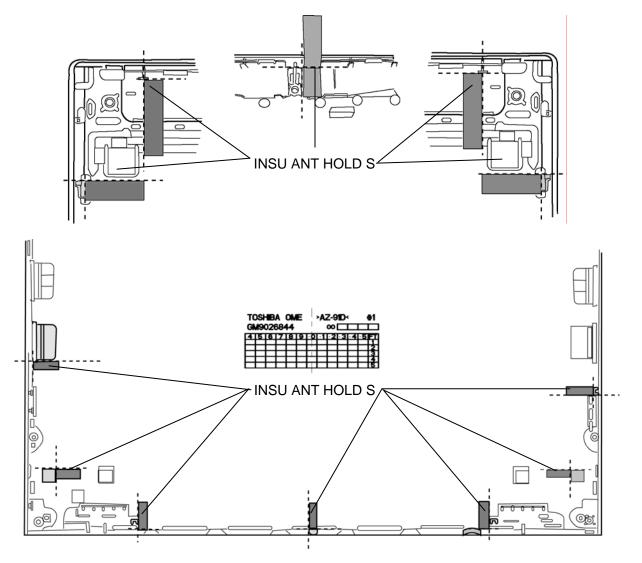
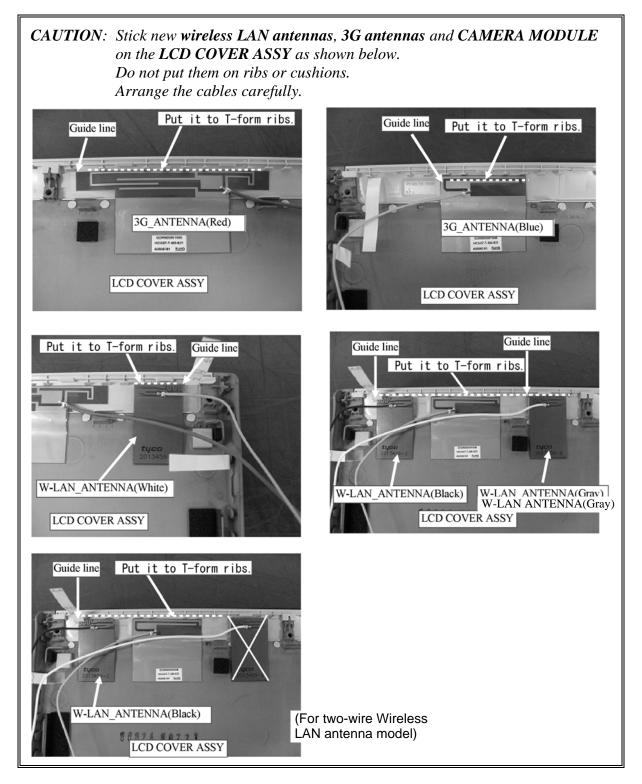
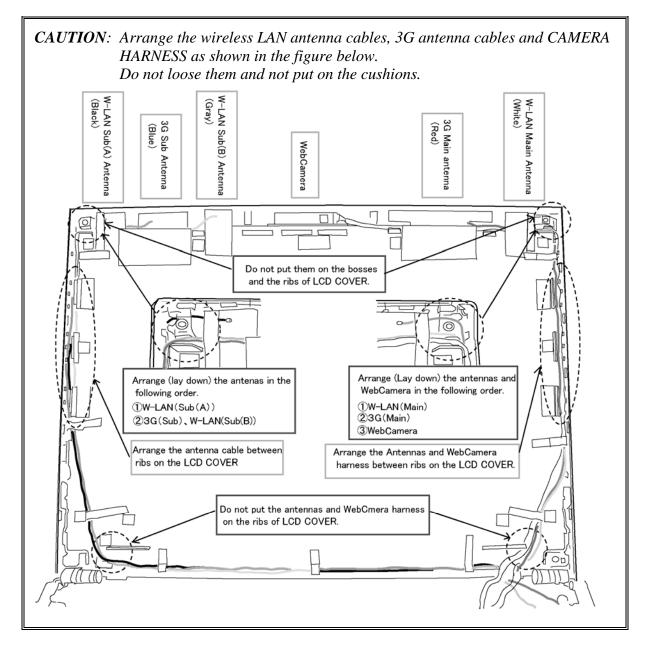


Figure 4-53 Removing the CAMERA MODULE/Antenna (3)

2. Stick new wireless LAN antennas, 3G antennas and CAMERA MODULE on the LCD COVER ASSY in place.



- 3. Connect the CAMERA HARNESS to the CAMERA MODULE.
- 4. FIX the CAMERA HARNESS with the **INSU ANT HOLD S**.
- 5. Arrange the CAMERA HARNESS, 3G antenna cables and wireless LAN antenna cables in place.
- 6. Fix the CAMERA HARNESS, 3G antenna cables and wireless LAN antenna cables with the INSU ANT HOLD Ss.



4.31 Hinge

Removing the Hinge (BH L ASSY/BH R ASSY)

To remove the hinges, follow the steps below and refer to Figure 4-54.

- 1. Remove the following **screw**s securing the hinges.
 - M2.5×4B S-THIN HEAD \times 4 (2 each)
- 2. Remove the **hinge**s (**BH L ASSY/BH R ASSY**) from the **LCD COVER ASSY**.

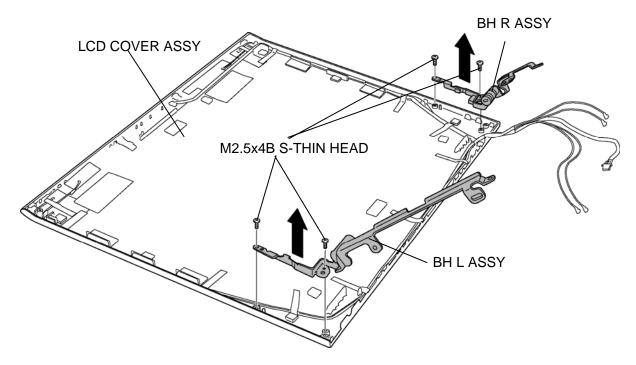
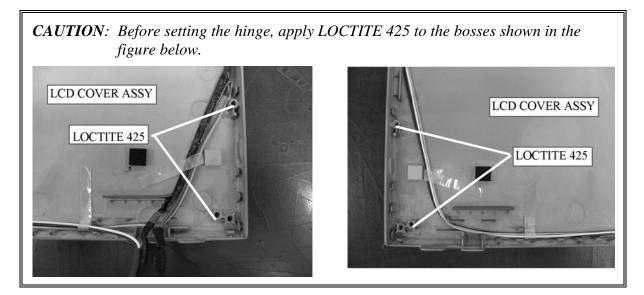


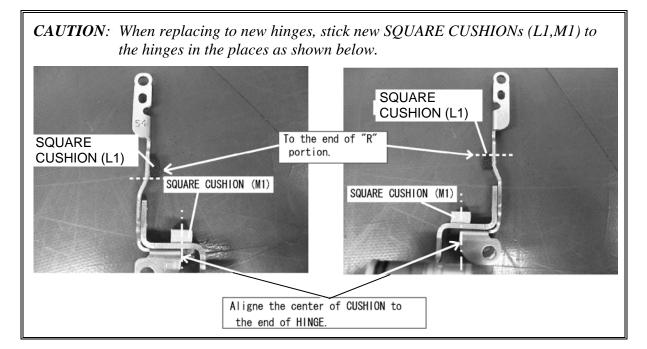
Figure 4-54 Removing the hinge

Installing the Hinge

To install the hinge, follow the steps below and refer to Figure 4-54.



- 1. Set the **hinges** (**BH L ASSY/BH R ASSY**) on the **LCD COVER ASSY** in place and secure them with the following **screw**s.
 - M2.5×4B S-THIN HEAD ×4 (2 each)



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[CONFIDENTIAL]

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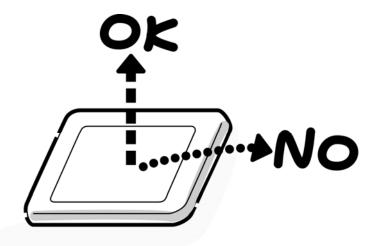
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Appendix A Handling the LCD Module

Precautions for handling the LCD module

The LCD module can be easily damaged during assembly or disassembly. Observe the following precautions when handling the LCD module:

1. When installing the LCD module in the LCD cover, be sure to seat it so that it is properly aligned and maximum visibility of the display is maintained.



2. Be careful to align the holes at the four corners of the LCD module with the corresponding holes in the LCD cover before securing the module with screws. Do not force the module into place, because stress can affect its performance.

Also, the panel's polarized surface is easily scarred, so be careful when handling it.





3. If the panel's surface gets dirty, wipe it with cotton or a soft cloth. If it is still dirty, try breathing on the surface to create a light condensate and wipe it again.

If the surface is very dirty, we recommend a CRT cleaning agent. Apply the agent to a cloth and then wipe the panel's surface. Do not apply cleanser directly to the panel.



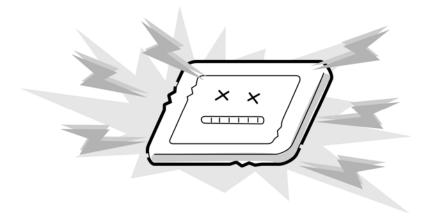
4. If water or other liquid is left on the panel's surface for a long period, it can change the screen's tint or stain it. Be sure to quickly wipe off any liquid.



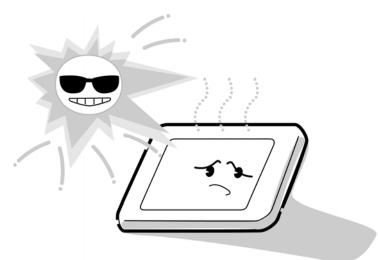
5. Glass is used in the panel, so be careful not to drop it or let it strike a hard object, which could cause breakage or cracks.



6. CMOS-LSI circuits are used in the module, so guard against damage from electrostatic discharge. Be sure to wear a wrist or ankle ground when handling the module.



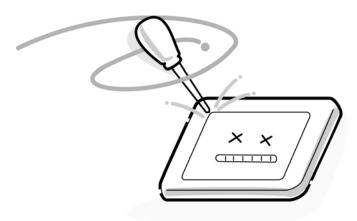
7. Do not expose the module to direct sunlight or strong ultraviolet rays for long periods.



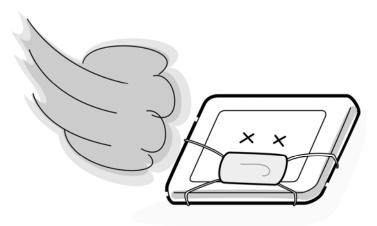
8. Do not store the module at temperatures below specifications. Cold can cause the liquid crystals to freeze, lose their elasticity or otherwise suffer damage.



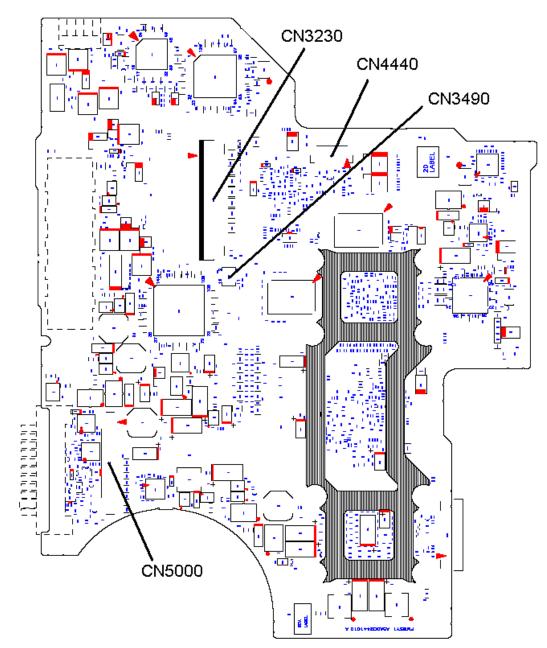
9. Do not disassemble the LCD module. Disassembly can cause malfunctions.



10. If you transport the module, do not use packing material that contains epoxy resin (amine) or silicon glue (alcohol or oxide). These materials can release gas that can damage the panel's polarization.



Appendix B Board Layout



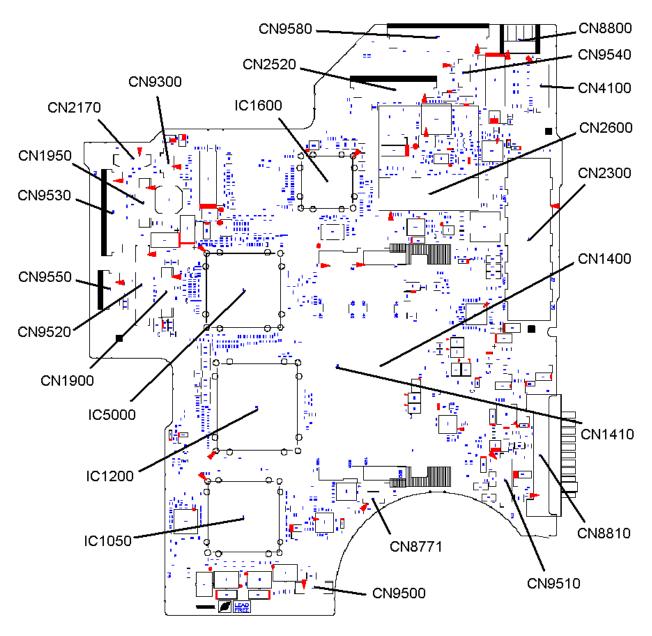
B.1 System board (FMWSY*) Front View

Figure B-1 System board(FMWSY*) layout (front)

Number	Name
CN3230	Keyboard I/F connector
CN3490	It is debugging port for development only
CN4440	Bluetooth I/F connector
CN5000	LCD I/F connector

Table B-1 S	System board(FMWSY*)	connectors and	ICs (front)
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B-2



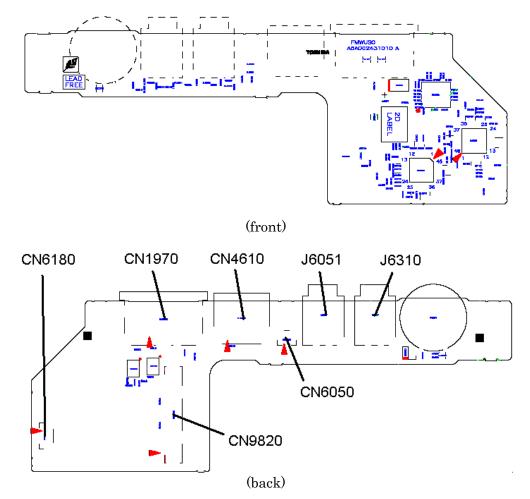
B.2 System board (FMWSY*) Back View

Figure B-2 System board(FMWSY*) layout (back)

Number	Name
CN1400	Memory connector 1
CN1410	Memory connector 2
CN1900	SATA HDD I/F connector
CN1950	SATA ODD I/F connector
CN2170	Smart Card I/F Connector
CN2300	Docking I/F connector
CN2520	EXPRESSCARD I/F connector
CN2600	PCI-E MINI CARD I/F connector
CN4100	LAN I/F connector
CN8771	FAN I/F connector
CN8800	DC-IN connector
CN8810	Battery connector
CN9300	RTC battery connector
CN9500	Switch I/F connector
CN9510	RGB unit I/F connector
CN9520	FMWUS* board I/F connector
CN9530	FMWSD* board I/F connector
CN9540	WebCam I/F connector
CN9550	FMWTP* board I/F connector
CN9580	FMWPE* board I/F connector
IC1050	CPU
IC1200	North Bridge Cantiga-GS
IC1600	South Bridge ICH9M
IC5000	GPU UNB9M

Table B-2 System board (FMWSY*) connectors and ICs (back)

B.3 Sound/USB board (FMWUS*) View



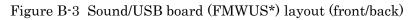


Table B-3	Sound/USB	board (FMWUS*)	connector (back)
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Number	Name
CN1970	eSATA/USB I/F connector
CN4610	USB(Port5) I/F connector
CN6050	Ext MIC I/F connector
CN6180	Speaker I/F connector
CN9820	System board I/F connector
J6051	Microphone I/F connector
J6310	Head Phone I/F connector

B.4 SD board (FMWSD*) View

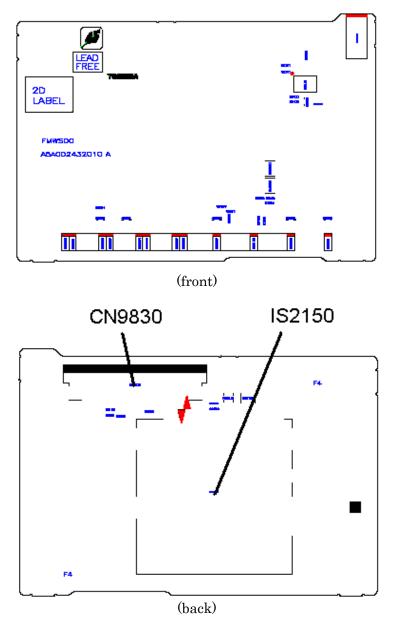


Figure B-4 SD board (FMWSD*) layout (front/back)

Table B-4	SD	board	(FMWSD*)	connector	(back)
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Number	Name
CN9830	System board I/F connector
IS2150	SD Card I/F connector

B.5 Touch PAD board (FMWTP*) View

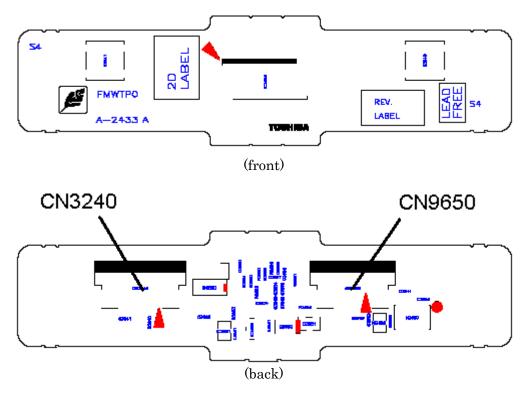
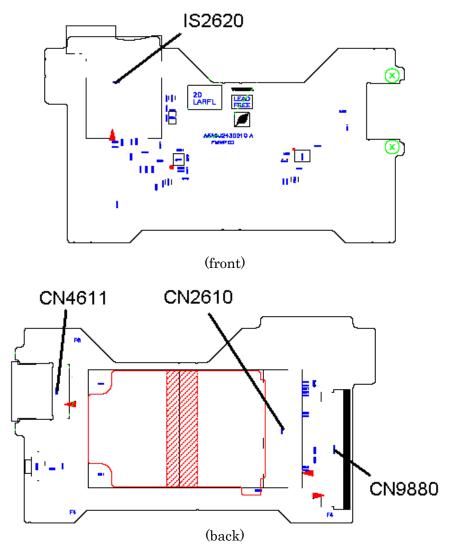


Figure B-5 Touch PAD board (FMWTP*) layout (front/back)

Table B-5 Touch PAD board (FMWTP*)connector (back	Table B-5	Touch PAD	board	(FMWTP*)connector(back)
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Number	Name
CN3240	Dual Point I/F connector
CN9650	System board I/F connector



B.6 SIM/Mini PCI Express board (FMWPE*) View

Figure B-6 SIM/Mini PCI Express board (FMWPE*) layout (front/back)

Table B-6 SIM/Mini PCI Express board (FMWPE*) connector (front/back)

Number	Name
CN2610	PCI-E Mini I/F connector
CN4611	USB (Port0) I/F connector
CN9880	System board I/F connector
IS2620	SIM Card I/F connector

B.7 SATA HDD FPC (FMWHF*) View

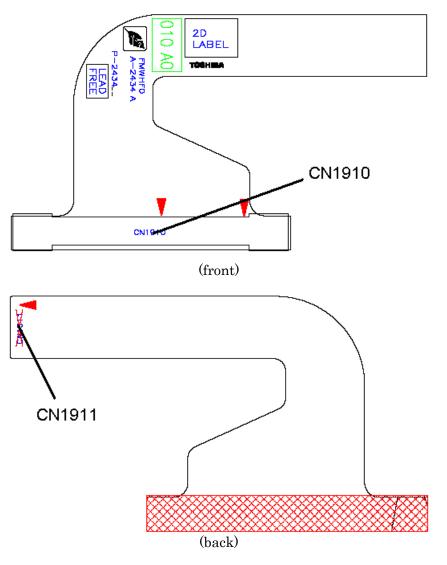


Figure B-7 SATA HDD FPC (FMWHF) layout (front/back)*

Table B-7 SAT	A HDD I	FPC (FMWHF*)	connector	(front/back)
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Number	Name
CN1910	HDD I/F connector
CN1911	System board I/F connector

B.8 SATA ODD FPC (FMWOF*) View

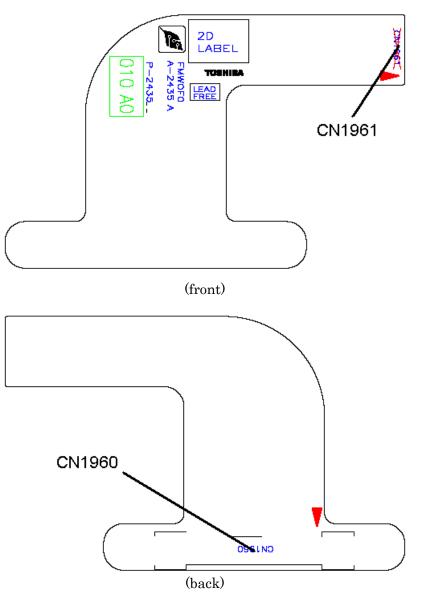


Figure B-8 SATA ODD FPC (FMWOF*) layout (front/back)

Table B-8	SATA	ODD	FPC	(FMWOF*)	connector	(front/back)
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Number	Name
CN1960	SATA ODD I/F connector
CN1961	System board I/F connector

Appendix C Pin Assignments

System board (FMWSY *)

C.1 CN1400 Memory connector 1 (200-pin)

Table C-1 Memory connector 1 (200-pin) (1/3)
--

Pin No.	Signal Name	Pin No.	Signal Name
1	MRVREF-B0V	2	GND
3	GND	4	ADQ05-B1P
5	ADQ00-B1P	6	ADQ07-B1P
7	ADQ04-B1P	8	GND
9	GND	10	ADM0-B1P
11	ADQS0-B1N	12	GND
13	ADQS0-B1P	14	ADQ03-B1P
15	GND	16	ADQ06-B1P
17	ADQ02-B1P	18	GND
19	ADQ01-B1P	20	ADQ15-B1P
21	GND	22	ADQ09-B1P
23	ADQ13-B1P	24	GND
25	ADQ10-B1P	26	ADM1-B1P
27	GND	28	GND
29	ADQS1-B1N	30	XMCK0-B1P
31	ADQS1-B1P	32	XMCK0-B1N
33	GND	34	GND
35	ADQ08-B1P	36	ADQ12-B1P
37	ADQ11-B1P	38	ADQ14-B1P
39	GND	40	GND
41	GND	42	GND
43	ADQ21-B1P	44	ADQ18-B1P
45	ADQ23-B1P	46	ADQ19-B1P
47	GND	48	GND
49	ADQS2-B1N	50	TSDIMA-P3N
51	ADQS2-B1P	52	ADM2-B1P
53	GND	54	GND
55	ADQ17-B1P	56	ADQ22-B1P
57	ADQ16-B1P	58	ADQ20-B1P
59	GND	60	GND

Pin No.	Signal Name	Pin No.	Signal Name
61	ADQ26-B1P	62	ADQ27-B1P
63	ADQ24-B1P	64	ADQ29-B1P
65	GND	66	GND
67	ADM3-B1P	68	ADQS3-B1N
69	NC	70	ADQS3-B1P
71	GND	72	GND
73	ADQ30-B1P	74	ADQ25-B1P
75	ADQ31-B1P	76	ADQ28-B1P
77	GND	78	GND
79	MCKE0-B1P	80	MCKE1-B1P
81	1R8-B1V	82	1R8-B1V
83	NC	84	NC
85	ABS2-B1P	86	AMA14-B1P
87	1R8-B1V	88	1R8-B1V
89	AMA12-B1P	90	AMA11-B1P
91	AMA09-B1P	92	AMA07-B1P
93	AMA08-B1P	94	AMA06-B1P
95	1R8-B1V	96	1R8-B1V
97	AMA05-B1P	98	AMA04-B1P
99	AMA03-B1P	100	AMA02-B1P
101	AMA01-B1P	102	AMA00-B1P
103	1R8-B1V	104	1R8-B1V
105	AMA10-B1P	106	ABS1-B1P
107	ABS0-B1P	108	ARAS-B1N
109	AWE-B1N	110	MCS0-B1N
111	1R8-B1V	112	1R8-B1V
113	ACAS-B1N	114	MODT0-B1P
115	MCS1-B1N	116	AMA13-B1P
117	1R8-B1V	118	1R8-B1V
119	MODT1-B1P	120	NC
121	GND	122	GND
123	ADQ39-B1P	124	ADQ34-B1P
125	ADQ32-B1P	126	ADQ37-B1P
127	GND	128	GND
129	ADQS4-B1N	130	ADM4-B1P
131	ADQS4-B1P	132	GND

Table C-1Memory connector 2 (200-pin) (2/3)

Pin No.	Signal Name	Pin No.	Signal Name
133	GND	134	ADQ35-B1P
135	ADQ38-B1P	136	ADQ36-B1P
137	ADQ33-B1P	138	GND
139	GND	140	ADQ41-B1P
141	ADQ47-B1P	142	ADQ42-B1P
143	ADQ40-B1P	144	GND
145	GND	146	ADQS5-B1N
147	ADM5-B1P	148	ADQS5-B1P
149	GND	150	GND
151	ADQ45-B1P	152	ADQ43-B1P
153	ADQ44-B1P	154	ADQ46-B1P
155	GND	156	GND
157	ADQ49-B1P	158	ADQ54-B1P
159	ADQ55-B1P	160	ADQ53-B1P
161	GND	162	GND
163	NC	164	XMCK1-B1P
165	GND	166	XMCK1-B1N
167	ADQS6-B1N	168	GND
169	ADQS6-B1P	170	ADM6-B1P
171	GND	172	GND
173	ADQ52-B1P	174	ADQ51-B1P
175	ADQ48-B1P	176	ADQ50-B1P
177	GND	178	GND
179	ADQ60-B1P	180	ADQ57-B1P
181	ADQ58-B1P	182	ADQ63-B1P
183	GND	184	GND
185	ADM7-B1P	186	ADQS7-B1N
187	GND	188	ADQS7-B1P
189	ADQ59-B1P	190	GND
191	ADQ56-B1P	192	ADQ62-B1P
193	GND	194	ADQ61-B1P
195	SMBDT1-E3P	196	GND
197	SMBCK1-E3P	198	GND
199	P3V	200	M-E3V
1T	GND	2T	GND

Table C-1	Memory connecto	r 2	(200-pin)	(3/3)
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C.2 CN1410 Memory connector 2 (200-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	MRVREF-B0V	2	GND
3	GND	4	BDQ04-B1P
5	BDQ05-B1P	6	BDQ01-B1P
7	BDQ00-B1P	8	GND
9	GND	10	BDM0-B1P
11	BDQS0-B1N	12	GND
13	BDQS0-B1P	14	BDQ02-B1P
15	GND	16	BDQ03-B1P
17	BDQ06-B1P	18	GND
19	BDQ07-B1P	20	BDQ13-B1P
21	GND	22	BDQ09-B1P
23	BDQ08-B1P	24	GND
25	BDQ12-B1P	26	BDM1-B1P
27	GND	28	GND
29	BDQS1-B1N	30	XMCK3-B1P
31	BDQS1-B1P	32	XMCK3-B1N
33	GND	34	GND
35	BDQ11-B1P	36	BDQ14-B1P
37	BDQ10-B1P	38	BDQ15-B1P
39	GND	40	GND
41	GND	42	GND
43	BDQ21-B1P	44	BDQ20-B1P
45	BDQ17-B1P	46	BDQ16-B1P
47	GND	48	GND
49	BDQS2-B1N	50	TSDIMB-P3N
51	BDQS2-B1P	52	BDM2-B1P
53	GND	54	GND
55	BDQ19-B1P	56	BDQ18-B1P
57	BDQ23-B1P	58	BDQ22-B1P
59	GND	60	GND

Table C-2Memory connector 2 (200-pin) (1/3)

Pin No.	Signal Name	Pin No.	Signal Name
61	BDQ28-B1P	62	BDQ25-B1P
63	BDQ24-B1P	64	BDQ27-B1P
65	GND	66	GND
67	BDM3-B1P	68	BDQS3-B1N
69	NC	70	BDQS3-B1P
71	GND	72	GND
73	BDQ29-B1P	74	BDQ30-B1P
75	BDQ26-B1P	76	BDQ31-B1P
77	GND	78	GND
79	MCKE3-B1P	80	MCKE4-B1P
81	1R8-B1V	82	1R8-B1V
83	NC	84	NC
85	BBS2-B1P	86	BMA14-B1P
87	1R8-B1V	88	1R8-B1V
89	BMA12-B1P	90	BMA11-B1P
91	BMA09-B1P	92	BMA07-B1P
93	BMA08-B1P	94	BMA06-B1P
95	1R8-B1V	96	1R8-B1V
97	BMA05-B1P	98	BMA04-B1P
99	BMA03-B1P	100	BMA02-B1P
101	BMA01-B1P	102	BMA00-B1P
103	1R8-B1V	104	1R8-B1V
105	BMA10-B1P	106	BBS1-B1P
107	BBS0-B1P	108	BRAS-B1N
109	BWE-B1N	110	MCS2-B1N
111	1R8-B1V	112	1R8-B1V
113	BCAS-B1N	114	MODT2-B1P
115	MCS3-B1N	116	BMA13-B1P
117	1R8-B1V	118	1R8-B1V
119	MODT3-B1P	120	NC
121	GND	122	GND
123	BDQ32-B1P	124	BDQ37-B1P
125	BDQ33-B1P	126	BDQ36-B1P
127	GND	128	GND
129	BDQS4-B1N	130	BDM4-B1P
131	BDQS4-B1P	132	GND

Table C-1	Memory	connector 2	(200-pin)	(2/3)
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Pin No.	Signal Name	Pin No.	Signal Name
133	GND	134	BDQ39-B1P
135	BDQ38-B1P	136	BDQ35-B1P
137	BDQ34-B1P	138	GND
139	GND	140	BDQ45-B1P
141	BDQ44-B1P	142	BDQ41-B1P
143	BDQ40-B1P	144	GND
145	GND	146	BDQS5-B1N
147	BDM5-B1P	148	BDQS5-B1P
149	GND	150	GND
151	BDQ43-B1P	152	BDQ46-B1P
153	BDQ47-B1P	154	BDQ42-B1P
155	GND	156	GND
157	BDQ53-B1P	158	BDQ54-B1P
159	BDQ48-B1P	160	BDQ51-B1P
161	GND	162	GND
163	NC	164	XMCK4-B1P
165	GND	166	XMCK4-B1N
167	BDQS6-B1N	168	GND
169	BDQS6-B1P	170	BDM6-B1P
171	GND	172	GND
173	BDQ52-B1P	174	BDQ55-B1P
175	BDQ50-B1P	176	BDQ49-B1P
177	GND	178	GND
179	BDQ61-B1P	180	BDQ57-B1P
181	BDQ56-B1P	182	BDQ58-B1P
183	GND	184	GND
185	BDM7-B1P	186	BDQS7-B1N
187	GND	188	BDQS7-B1P
189	BDQ60-B1P	190	GND
191	BDQ63-B1P	192	BDQ59-B1P
193	GND	194	BDQ62-B1P
195	SMBDT1-E3P	196	GND
197	SMBCK1-E3P	198	GND
199	P3V	200	M-E3V
1T	GND	2T	GND

Table C-1 Memory connector 2 (200-pin) (3/3)

C.3 CN1900 SATA HDD interface connector (20-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	GND
3	GND	4	GND
5	GND	6	GND
7	NC	8	P5V
9	P5V	10	P5V
11	P5V	12	P5V
13	NC	14	GND
15	ZSTRFD-P1P	16	ZSTRHD-P1N
17	GND	18	ZSTTHD-P1N
19	ZSTTHD-P1P	20	GND
1T	GND	2T	GND

Table C-3 SATA HDD interface connector (20-pin)

C.4 CN1950 SATA ODD interface connector (20-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	GND
3	GND	4	GND
5	GND	6	GND
7	NC	8	P5V
9	P5V	10	P5V
11	P5V	12	P5V
13	NC	14	GND
15	ZSTROD-P1P	16	ZSTROD-P1N
17	GND	18	ZSTTOD-P1N
19	ZSTTOD-P1P	20	GND
1T	GND	2T	GND

Table C-4 SATA ODD interface connector (20-pin)

C.5 CN2170 Smart Card interface connector (10-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	EGATE-P3N	2	NC
3	SCIO-PYP	4	GND
5	SCDET-P3N	6	SCVCC-PYV
7	SCRST-PYN	8	GND
9	SCCLK-PYP	10	SCC4-PYP
1T	GND	2T	GND
3T	GND	4T	GND

Table C-5 Smart Card interface connector (10-pin)

C.6 CN2300 Docking interface connector (140-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	DCOUT	2	DCOUT
3	DOCDT1-S3N	4	GND
5	BT2VD	6	BT2VD
7	PSCL-S5P	8	PSDA-S5P
9	GND	10	ZUSBDC-E3P
11	ZUSBDC-E3N	12	GND
13	GND	14	NC
15	NC	16	GND
17	NC	18	NC
19	GND	20	GND
21	GND	22	ZDVTX2-P3P
23	ZDVTX2-P3N	24	GND
25	ZDVTX1-P3P	26	ZDVTX1-P3N
27	GND	28	DVIDET-P3N
29	NC	30	NC
31	NC	32	NC
33	NC	34	NC
35	NC	36	DCOUT
37	DCOUT	38	NC
39	NC	40	DBT2OV-S5N
41	BTMP2	42	GND
43	CDCHG2-S5P	44	GND
45	DPCONF-S5P	46	GND
47	GND	48	XDVCLK-P3N
49	XDVCLK-P3P	50	GND
51	NC	52	NC
53	GND	54	ZDVTX0-P3P
55	ZDVTX0-P3N	56	GND
57	GND	58	GND
59	GND	60	DVISCL-P5P
61	DVISDA-P5P	62	LAN-E3V
63	LINK-E3N	64	NC
65	NC	66	NC
67	ZBIDDP-EXP	68	ZBIDDN-EXN
69	ZBIDCN-EXN	70	ZBIDCP-EXP

Table C-6 Docking interface connector (140-pin) (1/3)

Pin No.	Signal Name	Pin No.	Signal Name
71	DCOUT	72	DCOUT
73	PWRSW-S3N	74	DOCVON-S3P
75	NC	76	NC
77	GND	78	GND
79	GND	80	NC
81	GND	82	GND
83	GND	84	GND
85	NC	86	GND
87	NC	88	GND
89	GND	90	DBLUE-PXP
91	GND	92	DRED-PXP
93	GND	94	GND
95	SCRTSD-P3P	96	SCRTSC-P3P
97	GND	98	ACT-E3N
99	NC	100	NC
101	NC	102	ZBIDBN-EXN
103	ZBIDBP-EXP	104	ZBIDAN-EXN
105	ZBIDAP-EXP	106	DCOUT
107	DCOUT	108	EJCTRQ-S3N
109	M5V	110	NC
111	NC	112	GND
113	DHSYNC-P3P	114	DVSYNC-P3P
115	GND	116	GND
117	ZSTTDC-P1P	118	ZSTTDC-P1N
119	GND	120	GND
121	GND	122	ZSTRDC-P1N
123	ZSTRDC-P1P	124	GND
125	GND	126	DGREEN-PXP
127	GND	128	GND
129	GND	130	PSCL-S5P
131	PSDA-S5P	132	GND
133	DOCDT2-S3N	134	NC
135	NC	136	NC
137	NC	138	NC
139	NC	140	NC

Table C-6 Docking	interface connector (140-pin) (2/3)
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Pin No.	Signal Name	Pin No.	Signal Name
A1	GND	A2	GND
A3	DSKDC	A4	PVBAT2
1T	GND	2T	GND
3T	GND	4T	GND
5T	GND	6T	GND
7T	GND	8T	GND
9T	GND	10T	GND
11T	GND	12T	GND
13T	GND	14T	GND
15T	GND	16T	GND
17T	GND	18T	GND
19T	GND	20T	GND

Table C-6 Docking	interface connector	· (140-pin) (3/3)
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C.7 CN2520 Expresscard interface connector (40-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	GND
3	GND	4	GND
5	ZETCRD-P1P	6	ZETCRD-P1N
7	GND	8	GND
9	GND	10	GND
11	ZERCRD-P1P	12	ZERCRD-P1N
13	GND	14	GND
15	GND	16	GND
17	XPECRD-P0P	18	XPECRD-P0N
19	NC	20	CPPE-E3N
21	CRDCRQ-E3N	22	CRD-P3V
23	CRD-P3V	24	CRD-P3V
25	CRDRST-E3N	26	CRD-E3V
27	PEWAKE-E3N	28	CRD1R5-P1V
29	CRD1R5-P1V	30	CRD-E3V
31	CRD-E3V	32	NC
33	NC	34	CPUSB-E3N
35	ZUSBEX-E3P	36	ZUSBEX-E3N
37	GND	38	GND
39	GND	40	GND
1T	GND	2T	GND

Table C-7 Expresscard interface connector (40-pin)

C.8 CN2600 PCI-E MINI CARD interface connector (52-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	PEWAKE-E3N	2	WLAN-E3V
3	WCHDAT-P3P	4	GND
5	WCHCLK-P3P	6	1R5-P1V
7	WLXRQ-P3N	8	NC
9	GND	10	NC
11	XPEWL-PON	12	NC
13	XPEWL-P0P	14	NC
15	GND	16	NC
17	NC	18	GND
19	NC	20	WLRFON-S3N
21	GND	22	PLTRS0-E3N
23	ZERWL-P1N	24	WLAN-E3V
25	ZERWL-P1P	26	WLWMDT-P3N
27	GND	28	1R5-P1V
29	GND	30	NC
31	ZETWL-P1N	32	NC
33	ZETWL-P1P	34	GND
35	GND	36	ZUSBWM-E3N
37	GND	38	ZUSBWM-E3P
39	WLAN-E3V	40	GND
41	WLAN-E3V	42	WLAN-E3V
43	GND	44	NC
45	XCLK1-E1P	46	NC
47	CLDAT1-E1P	48	1R5-P1V
49	CLRST1-E3N	50	GND
51	NC	52	WLAN-E3V
1T	GND	2T	GND

 Table C-8 PCI-E MINI CARD interface connector (52-pin)

C.9 CN3230 Keyboard interface connector (25-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	NUMLED-P5N	2	ARWLED-P5N
3	CAPLED-P5N	4	P5V
5	KBRT06-S3N	6	KBRT02-S3N
7	KBRT03-S3N	8	KBRT05-S3N
9	KBRT01-S3N	10	KBRT04-S3N
11	KBRT07-S3N	12	KBRT00-S3N
13	KBSC00-S3N	14	KBSC09-S3N
15	KBSC03-S3N	16	KBSC02-S3N
17	KBSC05-S3N	18	KBSC04-S3N
19	KBSC06-S3N	20	KBSC08-S3N
21	KBSC10-S3N	22	KBSC01-S3N
23	KBSC11-S3N	24	KBSC07-S3N
25	KBSC15-S3N	26	KBSC12-S3N
27	KBSC13-S3N	28	KBSC14-S3N
29	P5V	30	NC
31	NC	32	NC
33	NC	34	NC
1T	GND	2T	GND

Table C-9 Keyboard interface connector (25-pin)

C.10 CN4100 LAN interface connector (14-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	ZMDI1N-EYN	2	ZMDI1P-EYP
3	ZMDION-EYN	4	ZMDI0P-EYP
5	ZMDI2P-EYP	6	ZMDI2N-EYN
7	ZMDI3P-EYP	8	ZMDI3N-EYN
9	NC	10	NC
11	LAN-E3V	12	LAN-E3V
13	LINK-E3N	14	ACT-E3N
1T	NC	2T	NC

Table C-10 LAN interface connector (14-pin)

C.11 CN4400 Bluetooth interface connector (10-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	GND
3	P3V	4	WCHDAT-P3P
5	BTRST-S3N	6	BTMDL-P3N
7	WCHCLK-P3P	8	ZUSBBT-E3N
9	ZUSBBT-E3P	10	GND

 Table C-11 Bluetooth interface connector (10-pin)

C.12 CN5000 LCD interface connector (40-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	LEDBL6-GND	2	LEDBL5-GND
3	LDEBL4-GND	4	LEDBL3-GND
5	LEDBL2-GND	6	LEDBL1-GND
7	NC	8	LEDBL-PYV
9	LEDBL-PYV	10	LEDBL-PYV
11	NC	12	PNL-P3V
13	PNL-P3V	14	P3V
15	TSCL-P3P	16	TSDA-P3P
17	XLTXCB-PYP	18	XLTXCB-PYN
19	GND	20	ZLTDB2-PYP
21	ZLTDB2-PYN	22	GND
23	ZLTDB1-PYP	24	ZLTDB1-PYN
25	GND	26	ZLTDB0-PYP
27	ZLTDB0-PYN	28	GND
29	XLTXCA-PYP	30	XLTXCA-PYN
31	GND	32	ZLTDA2-PYP
33	ZLTDA2-PYN	34	GND
35	ZLTDA1-PYP	36	ZLTDA1-PYN
37	GND	38	ZLTDA0-PYP
39	ZLTDA0-PYN	40	GND
1T	GND	2T	GND
3T	GND	4T	GND
5T	GND	6T	GND

Table C-12 LCD interface connector (40-pin)

C.13 CN8771 FAN interface connector (4-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	E5V	2	FANG0-E3P
3	GND	4	FPWM0-S3P
1T	GND	2T	GND

 Table C-13 FAN interface connector (4-pin)

C.14 CN8800 DC-IN connector (4-pin)

Table C-14 DC-IN connector (4-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	ADPDC	2	ADPDC
3	GND	4	GND

C.15 CN8810 Battery connector (10-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	(Q8811-1)	2	BTMP1
3	(Q8811-4)	4	M5V
5	PSCL-S5P	6	PSDA-S5P
7	GND	8	DBT1OV-S5N
9	GND	10	GND

Table C-15 Battery connector (10-pin)

C.16 CN9300 RTC battery connector (3-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	ZS_PWCHKF	2	NC
3	GND		
1T	GND	2T	GND

 Table C-16 RTC battery connector (3-pin)

C.17 CN9500 Switch interface connector (13-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GPBTNB-S3N	2	NC
3	NC	4	GPBTNA-S3N
5	NC	6	NC
7	PWRSW-S3N	8	NC
9	NC	10	GND
11	NC	12	S3V
13	PNLOFF-S3N		
1T	GND	2T	GND

 Table C-17 Switch interface connector (13-pin)

C.18 CN9510 RGB unit interface connector (14-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	NC	2	P5V
3	CRTSDA-P5P	4	CRTSCL-P5P
5	GND	6	MVSYNC-P3P
7	MHSYNC-P3P	8	GND
9	MBLUE-PXP	10	GND
11	MGREEN-PXP	12	GND
13	MRED-PXP	14	GND
1T	GND	2T	GND

Table C-18 RGB unit interface connector (14-pin)

C.19 CN9520 FMWUS* board interface connector (40-pin)

		ī.	
Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	ZSRRP4-P1P
3	ZSTTP4-P1N	4	GND
5	ZSTRP4-P1P	6	ZSTRP4-P1N
7	GND	8	ZUSBES-E3N
9	ZUSBES-E3P	10	GND
11	ZUSBP6-E3N	12	ZUSBP6-E3P
13	GND	14	USBOC1-E3N
15	1R8-P1V	16	USBON2-E5N
17	GND	18	USBON1-E5N
19	E5V	20	E5V
21	E5V	22	E5V
23	E5V	24	SNDMUT-S3N
25	P3V	26	ROTENA-P3N
27	ROTENB-P3N	28	SND-GND
29	SND-GND	30	ATBEEP-P3P
31	P5V	32	P5V
33	AZSDI0-P3P	34	GND
35	AZRST0-E3N	36	AZSYC0-P3P
37	GND	38	XAZBC0-P3P
39	AZSDO0-P3P	40	GND
1T	GND	2T	GND
3Т	GND	4T	GND

Table C-19 FMWUS* board interface connector (40-pin)

C.20 CN9530 FMWSD* board interface connector (40-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	WANLED-E3P
3	GND	4	FMPWR0-P3P
5	RFLED-S3P	6	P3V
7	P3V	8	P3V
9	P3V	10	P3V
11	FMLED-P3N	12	GND
13	GND	14	GND
15	SATLED-P3N	16	P5V
17	BAT2GR-S5N	18	GND
19	BAT2OR-S5N	20	BAT1GR-S5N
21	BAT1OR-S5N	22	PWLEGR-S3P
23	GND	24	PWLEOR-S3P
25	M5V	26	DCINGR-S5N
27	DCINOR-S5N	28	GND
29	SDWP-P3P	30	SDCD-P3N
31	GND	32	SDDAT1-P3P
33	SDDAT0-P3P	34	GND
35	SDDAT2-P3P	36	SDCLK-P3P
37	GND	38	SDDAT3-P3P
39	SDCMD-P3P	40	GND
1T	GND	2T	GND

Table C-20 FMWSD* board interface connector (40-pin)

C.21 CN9540 WebCam interface connector (6-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	P5V	2	ZUSBCM-E3N
3	ZUSBCM-E3P	4	GND
5	GND	6	CAMDET-P3N
1T	GND	2T	GND

Table C-21WebCam interface connector (6-pin)

C.22 CN9550 FMWTP* board interface connector (10-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	P3V	2	FGSPON-S3N
3	GND	4	ZUSBFS-E3N
5	ZUSBFS-E3P	6	GND
7	IPDDAT-P5P	8	P5V
9	IPDCLK-P5P	10	GND
1T	GND	2T	GND

Table C-22 FMWTP* board interface connector (10-pin)

C.23 CN9580 FMWPE* board interface connector (50-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	3GWAKE-S3N
3	CLRST2-E3N	4	CLDAT2-E1P
5	XCLCK2-E1P	6	GND
7	ZETMP2-P1P	8	ZETMP2-P1N
9	GND	10	ZERMP2-P1P
11	ZERMP2-P1N	12	GND
13	ZUSBM2-E3P	14	ZUSBM2-E3N
15	GND	16	MP2DET-P3N
17	PLTRS3-E3N	18	GND
19	M2RFON-S3N	20	E3V
21	E3V	22	E3V
23	E3V	24	E3V
25	E3V	26	MP2PON-S3N
27	GND	28	XPEMP2-P0P
29	XPEMP2-P0N	30	GND
31	MP2LED-E3P	32	1R5-P1V
33	1R5-P1V	34	MP2XRQ-P3N
35	WCHCL1-P3P	36	WCHDA1-P3P
37	PEWAKE-E3N	38	GND
39	ZUSBP0-E3P	40	ZUSBP0-E3N
41	GND	42	TMPMP2-SXP
43	TMPMP2-GND	44	RESWON-S3N
45	GND	46	USBON0-E5N
47	E5V	48	E5V
49	E5V	50	USBOC0-E3N
1T	GND	2T	GND

Table C-23 FMWPE* board interface connector (50-pin)

Sound/USB board (FMWUS*)

C.24 CN1970 eSATA/USB interface connector (11-pin)

Pin No.	Signal Name	Pin No.	Signal Name
P1	USB1PS-E5V	P2	ZUSBES-E3N
P3	ZUSBES-E3P	P4	GND
P5	GND	P6	ZSTTES-P1P
P7	ZSTTES-P1N	P8	GND
P9	ZSTRES-P1N	P10	ZSTRES-P1P
P11	GND		
1T	GND	2T	GND
3T	GND	4T	GND

Table C-24 eSATA/USB interface connector (11-pin)

C.25 CN4610 USB(Port5) interface connector (4-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	USB2PS-E5V	2	ZUSBP6-E3N
3	ZUSBP6-E3P	4	GND
1T	GND	2T	GND
3T	GND		

Table C-25 USB(Port5) interface connector (4-pin)

C.26 CN6050 Ext MIC interface connector (2-pin)

Table C-26 Ext MIC interface connector (2-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	IMICIN-PXP	2	GND
1T	GND	2T	GND

C.27 CN6180 Speaker interface connector (4-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	SPOTL-PXN	2	SPOTL-PXP
3	SPOTR-PXP	4	SPOTR-PXN
1T	GND	2T	GND

 Table C-27 Speaker interface connector (4-pin)

C.28 CN9820 System board interface connector (40-pin)

Pin No.	Signal Name	Pin No.	Signal Name
			<u> </u>
1	GND	2	AZSDO0-P3P
3	XAZBC0-P3P	4	GND
5	AZSYC0-P3P	6	AZRST0-E3N
7	GND	8	AZSDI0-P3P
9	P5V	10	P5V
11	ATBEEP-P3P	12	GND
13	GND	14	ROTENB-P3N
15	ROTENA-P3N	16	P3V
17	SNDMUT-S3N	18	E5V
19	E5V	20	E5V
21	E5V	22	E5V
23	USBON1-E5N	24	GND
25	USBON2-E5N	26	1R8-P1V
27	USBOC1-E3N	28	GND
29	ZUSBP6-E3P	30	ZUSBP6-E3N
31	GND	32	ZUSBES-E3P
33	ZUSBES-E3N	34	GND
35	ZSTRP4-P1N	36	ZSTRP4-P1P
37	GND	38	ZSTTP4-P1N
39	ZSTTP4-P1P	40	GND
1T	GND	2T	GND
3T	GND	4T	GND

Table C-28 System board interface connector (40-pin)

C.29 J6051 Microphone interface connector (6-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	EMICIN-PXP
3	EMICB-P2V	4	GND
5	DETCTA-P4N	6	EMICB-P2V

 Table C-29 Microphone interface connector (6-pin)

C.30 J6310 Head Phone interface connector (6-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	HEADL-PXP
3	HEADR-PXP	4	GND
5	DETCTA-P4N	6	NC

Table C-30 Head Phone interface connector (6-pin)

SD board (FMWSD*)

C.31 CN9630 System board interface connector (40-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	SDCMD-P3P
3	SDDAT3-P3P	4	GND
5	SDCLK-P3P	6	SDDAT2-P3P
7	GND	8	SDDAT0-P3P
9	SDDAT1-P3P	10	GND
11	SDCD-P3N	12	SDWP-P3P
13	GND	14	DCINOR-S5N
15	DCINGR-S5N	16	M5V
17	PWLEOR-S3P	18	GND
19	PWLEGR-S3P	20	BAT1OR-S5N
21	BAT1GR-S5N	22	BAT2OR-S5N
23	GND	24	BAT2GR-S5N
25	P5V	26	SATLED-P3N
27	GND	28	GND
29	GND	30	FMLED-P3N
31	P3V	32	P3V
33	P3V	34	P3V
35	P3V	36	RFLED-S3P
37	FMPWR0-P3P	38	GND
39	WANLED-E3P	40	FM-P3V
1T	GND	2T	GND

 Table C-31 System board interface connector (40-pin)

C.32 IS2150 SD Card interface connector (12-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	SDDAT3-P3P	2	SDCMD-P3P
3	GND	4	FM-P3V
5	SDCLK-P3P	6	GND
7	SDDAT0-P3P	8	SDDAT1-P3P
9	SDDAT2-P3P	10	SDCD-P3N
11	GND	12	SDWP-P3P
1T	GND	2T	GND
3T	GND	4T	GND

 Table C-32 SD Card interface connector (12-pin)

Touch PAD board (FMWTP*)

C.33 CN3240 Dual Point interface connector (12-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	TPBTNR-P5N
3	TPBTNR-P5N	4	NC
5	NC	6	NC
7	NC	8	NC
9	GND	10	IPDCLK-P5P
11	IPDDAT-P5P	12	P5V
1T	GND	2T	GND

Table C-33	Dual Point	interface	connector	(12-pin)
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C.34 CN9650 System board interface connector (10-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	IPDCLK-P5P
3	P5V	4	IPDDAT-P5P
5	GND	6	ZUSBFS-E3P
7	ZUSBFS-E3N	8	GND
9	FGSPON-S3N	10	AT-E3V
1T	GND	2T	GND

Table C-34 System board interface connector (10-pin)

SIM/Mini PCI Express board (FMWPE*)

C.35 CN2610 PCI-E Mini interface connector (52-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	PEWAKE-E3N	2	MP2-E3V
3	WCHDAT-P3P	4	GND
5	WCHCLK-P3P	6	1R5-P1V
7	MP2XRQ-P3N	8	UIMPWR-E3V
9	GND	10	UIMDAT-E3P
11	XPEMP2-P0N	12	UIMCLK-E3P
13	XPEMP2-P0P	14	UIMRST-E3P
15	GND	16	NC
17	NC	18	GND
19	NC	20	M2RFON-S3N
21	GND	22	PLTRS0-E3N
23	ZERMP2-P1N	24	MP2-E3V
25	ZERMP2-P1P	26	MP2DET-P3N
27	GND	28	1R5-P1V
29	GND	30	NC
31	ZETMP2-P1N	32	NC
33	ZETMP2-P1P	34	GND
35	GND	36	ZUSBM2-E3N
37	GND	38	ZUSBM2-E3P
39	MP2-E3V	40	GND
41	MP2-E3V	42	MP2-E3V
43	GND	44	NC
45	NC	46	NC
47	NC	48	1R5-P1V
49	3GWAKE-S3N	50	GND
51	NC	52	MP2-E3V
1T	GND	2T	GND

Table C-35 PCI-E Mini interface connector (52-pin)

C.36 CN4611 USB(Port0) interface connector (4-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	USBOPS-E5V	2	ZUSBP0-E3N
3	ZUSBP0-E3P	4	GND
1T	GND	2T	GND
3T	GND	4T	GND

Table C-36 USB(Port0) interface connector (4-pin)

C.37 CN9880 System board interface connector (50-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	USBOC0-E3N	2	E5V
3	E5V	4	E5V
5	USBON0-E5N	6	GND
7	RFSWON-S3N	8	TMPMP2-GND
9	TMPMP2-SXP	10	GND
11	ZUSBP0-E3N	12	ZUSBP0-E3P
13	GND	14	PEWAKE-E3N
15	WCHDAT-P3P	16	WCHCLK-P3P
17	MP2XRQ-P3N	18	1R5-P1V
19	1R5-P1V	20	MP2LED-E3P
21	GND	22	XPEMP2-P0N
23	XPEMP2-P0P	24	GND
25	MP2P0N-S3N	26	E3V
27	E3V	28	E3V
29	E3V	30	E3V
31	E3V	32	M2RFON-S3N
33	GND	34	PLTRS0-E3N
35	MP2DET-P3N	36	GND
37	ZUSBM2-E3N	38	ZUSBM2-E3P
39	GND	40	ZERMP2-P1N
41	ZERMP2-P1P	42	GND
43	ZETMP2-P1N	44	ZETMP2-P1P
45	GND	46	XCLCK1-E1P
47	CLDAT1-E1P	48	CLRST1-E3N
49	3GWAKE-S3N	50	GND
1T	GND	2T	GND

Table C-37 System board interface connector (50-pin)

C.38 IS2620 SIM Card interface connector (12-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	UIMPWR-E3V	2	UIMRST-E3P
3	UIMCLK-E3P	4	NC
5	GND	6	NC
7	UIMDAT-E3P	8	NC
9	NC	10	NC
11	NC	12	NC
1T	GND	2T	GND

Table C-38 SIM Card interface connector (12-pin)

SATA HDD board (FMWHF*)

C.39 CN1910 HDD interface connector (22-pin)

Pin No.	Signal Name	Pin No.	Signal Name
S1	GND	S2	ZSTTHD-P1P
S3	ZSTTHD-P1N	S4	GND
S5	ZSTRHD-P1N	S6	ZSTRHD-P1P
S7	GND		
P1	NC	P2	NC
P3	NC	P4	GND
P5	GND	P6	GND
P7	P5V	P8	P5V
P9	P5V	P10	GND
P11	GND	P12	GND
P13	NC	P14	NC
P15	NC		
1T	GND	2T	GND

Table C-39 HDD interface connector (22-pin)

C.40 CN1911 System board interface connector (20-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	GND
3	GND	4	GND
5	GND	6	GND
7	NC	8	P5V
9	P5V	10	P5V
11	P5V	12	P5V
13	NC	14	GND
15	ZSTRHD-P1P	16	ZSTRHD-P1N
17	GND	18	ZSTTHD-P1N
19	ZSTTHD-P1P	20	GND

Table C-40 System board interface connector (20-*pin*)

SATA ODD FPC (FMWOF*)

C.41 CN1960 SATA ODD interface connector (13-pin)

Pin No.	Signal Name	Pin No.	Signal Name
S1	GND	S2	ZSTTOD-P1P
S3	ZSTTOD-P1N	S4	GND
S5	ZSTROD-P1N	S6	ZSTROD-P1P
S7	GND		
P1	NC	P2	P5V
P3	P5V	P4	NC
P5	GND	P6	GND
1T	GND	2T	GND

Table C-41 SATA ODD interface connector (13-pin)

C.42 CN1961 System board interface connector (20-pin)

Pin No.	Signal Name	Pin No.	Signal Name
1	GND	2	GND
3	GND	4	GND
5	GND	6	GND
7	NC	8	P5V
9	P5V	10	P5V
11	P5V	12	P5V
13	NC	14	GND
15	ZSTROD-P1P	16	ZSTROD-P1N
17	GND	18	ZSTTOD-P1N
19	ZSTTOD-P1P	20	GND

Table C-42 System board interface connector (20-pin)

Appendix D Keyboard Scan/Character Codes

D.1 Scan Codes

Сар	Keytop	Code	set 1	C	Code set 2	2	Note
No.	кеутор	Make	Break	Make	Bre	eak	Note
01	'~	29	A9	0E	F0	0E	
02	1 !	02	82	16	F0	16	
03	2@	03	83	1E	F0	1E	
04	3 #	04	84	26	F0	26	
05	4 \$	05	85	25	F0	25	
06	5 %	06	86	2E	F0	2E	
07	6 ^	07	87	36	F0	36	
08	7&	08	88	3D	F0	3D	*2
09	8 *	09	89	3E	F0	3E	*2
10	9 (0A	8A	46	F0	46	*2
11	0)	0B	8B	45	F0	45	
12		0C	8C	4E	F0	4E	
13	= +	0D	8D	55	F0	55	
15	BkSp	0E	8E	66	F0	66	
16	Tab	0F	8F	0D	F0	0D	
17	Q	10	90	15	F0	15	
18	W	11	91	1D	F0	1D	
19	Е	12	92	24	F0	24	
20	R	13	93	2D	F0	2D	
21	Т	14	94	2C	F0	2C	
22	Y	15	95	35	F0	35	
23	U	16	96	3C	F0	3C	*2
24	I	17	97	43	F0	43	*2
25	0	13	98	44	F0	44	*2
26	Р	19	99	4D	F0	4D	*2
27	[{	1A	9A	54	F0	54	
28] }	1B	9B	5B	F0	5B	

Table D-1 Scan codes (set 1 and set 2) (1/4)

Сар	Kautan	Code	set 1	C	Code set 2	2	Nata
No.	Keytop	Make	Break	Make	Bre	ak	Note
29	\	2B	AB	5D	F0	5D	*5
30	Caps Lock	ЗA	BA	58	F0	58	
31	А	1E	9E	1C	F0	1C	
32	S	1F	9F	1B	F0	1B	
33	D	20	A0	23	F0	23	
34	F	21	A1	2B	F0	2B	
35	G	22	A2	34	F0	34	
36	Н	23	A3	33	F0	33	
37	J	24	A4	3B	F0	3B	*2
38	К	25	A5	42	F0	42	*2
39	L	26	A6	4B	F0	4B	*2
40	; :	27	A7	4C	F0	4C	*2
41	، ۱۱	28	A8	52	F0	52	
43	Enter	1C	9C	5A	F0	5A	*3
44	Shift (L)	2A	AA	12	F0	12	
45	No.102 key	56	D6	61	F0	61	
46	Z	2C	AC	1A	F0	1A	
47	Х	2D	AD	22	F0	22	
48	С	2E	AE	21	F0	21	
49	V	2F	AF	2A	F0	2A	
50	В	30	B0	32	F0	32	
51	N	31	B1	31	F0	31	
52	М	32	B2	ЗA	F0	ЗA	*2
53	, <	33	B3	41	F0	41	*2
54	. >	34	B4	49	F0	49	*2
55	/ ?	35	B5	4A	F0	4A	*2
57	Shift (R)	36	B6	59	F0	59	

Сар	Kautan		Code	set 1			C	code s	et 2		Note
No.	Keytop	Ma	ake	Br	eak	Ma	ake		Brea	k	Note
58	Ctrl	1	D	g	D	14		F0		14	*3
60	Alt (L)		38	F	38		11	F0		11	*3
61	Space		39		39		29	F0		29	Ũ
62	ALT (R)	E0	38	E0	B8	E0		E0	F0		
75	Ins	E0	52	E0	D2	E0	70	E0	F0	70	*1
76	Del	E0	53	E0	D3	E0	71	E0	F0	71	*1
79	\leftarrow	E0	4B	E0	СВ	E0	6B	E0	F0	6B	*1
80	Home	E0	47	E0	C7	E0	6C	E0	F0	6C	*1
81	End	E0	4F	E0	CF	E0	69	E0	F0	69	*1
83	\uparrow	E0	48	E0	C8	E0	75	E0	F0	75	*1
84	\downarrow	E0	50	E0	D0	E0	72	E0	F0	72	*1
85	PgUp	E0	49	E0	C9	E0	7D	E0	F0	7D	*1
86	PgDn	E0	51	E0	D1	E0	7A	E0	F0	7A	*1
89	\rightarrow	E0	4D	E0	CD	E0	74	E0	F0	74	*1
110	Esc		01		81		76	F0		76	
112	F1	:	3B		BB		05	F0		05	
113	F2	;	3C	I	BC		06	F0		06	
114	F3	:	3D	1	BD		04	F0		04	
115	F4	:	3E		BE		0C	F0		0C	
116	F5		3F	l	BF		03	F0		03	
117	F6		40		C0		0B	F0		0B	
118	F7		41		C1		83	F0		83	
119	F8		42		C2		0A	F0		0A	
120	F9		43	(C3		01	F0		01	
121	F10		44		C4		09	F0		09	*3

Сар	Kouton	Cod	e set 1		Code set 2		Note	
No.	Keytop	Make	Break	Make	Break		Note	
122	F11	57	D7	78	F0 78		*3	
123	F12	58	D8	07	F0 07		*3	
124	PrintSc	*6	*6	*6	*6		*6	
126	Pause	*7	*7	*7	*7		*7	
202	Fn	_	—	—	_		*4	
203	Win	E0 5B	E0 DB	E0 1F	E0 F0	1F		
204	Арр	E0 5D	E0 DD	E0 2F	E0 F0	2F		

Notes:

- 1. * Scan codes differ by mode.
- 2. * Scan codes differ by overlay function.
- 3. * Combined with the **Fn** key makes different codes.
- 4. * **Fn** key does not generate a code by itself.
- 5. * This key corresponds to key No. 42 in a 102-key model.
- 6. * Refer to Table D-6, No. 124 key scan code.
- 7. * Refer to Table D-7, No. 126 key scan code.

Сар	Key			C	ode	set '	1			Code set 2									
No.	top		Ма	ke			Bre	ak				Make	•		Break				
55	/	E0	AA	E0	35	E0	B5	E0	2A	E0	F0	12	E0	4A	E0	F0	4A	E0	12
75	INS	E0	AA	E0	52	E0	D2	E0	2A	E0	F0	12	E0	70	E0	F0	70	E0	12
76	DEL	E0	AA	E0	53	E0	D3	E0	2A	E0	F0	12	E0	71	E0	F0	71	E0	12
79	\leftarrow	E0	AA	E0	4B	E0	СВ	E0	2A	E0	F0	12	E0	6B	E0	F0	6B	E0	12
80	Home	E0	AA	E0	47	E0	C7	E0	2A	E0	F0	12	E0	6C	E0	F0	6C	E0	12
81	End	E0	AA	E0	4F	E0	CF	E0	2A	E0	F0	12	E0	69	E0	F0	69	E0	12
83	\uparrow	E0	AA	E0	48	E0	C8	E0	2A	E0	F0	12	E0	75	E0	F0	75	E0	12
84	\downarrow	E0	AA	E0	50	E0	D0	E0	2A	E0	F0	12	E0	72	E0	F0	72	E0	12
85	PgUp	E0	AA	E0	49	E0	C9	E0	2A	E0	F0	12	E0	7D	E0	F0	7D	E0	12
86	PgDn	E0	AA	E0	51	E0	D1	E0	2A	E0	F0	12	E0	7A	E0	F0	7A	E0	12
89	\rightarrow	E0	AA	E0	4D	E0	CD	E0	2A	E0	F0	12	E0	74	E0	F0	74	E0	12
203	Win	E0	AA	E0	5B	E0	DB	E0	2A	E0	F0	12	E0	1F	E0	F0	1F	E0	12
204	Арр	E0	AA	E0	5D	E0	DD	E0	2A	E0	F0	12	E0	2F	E0	F0	2F	E0	12

Table D-2 Scan codes with left Shift key

Note : The table above shows scan codes with the left **Shift** key. In combination with the right **Shift** key, scan codes are changed as listed below:

	With left Shift	With right Shift
Set 1	E0 AA	E0 B6
	E0 2A	E0 36
Set 2	E0 F0 12	E0 F0 59
	E0 12	E0 59

Сар	Key		Code set 1								Code set 2								
No.	top		Ма	ike			Br	eak			Ma	ake		Break					
75	INS	E0	2A	E0	52	E0	D2	E0	AA	E0	12	E0	70	E0	F0	70	E0	F0	12
76	DEL	E0	2A	E0	53	E0	D3	E0	AA	E0	12	E0	71	E0	F0	71	E0	F0	12
79	←	E0	2A	E0	4B	E0	СВ	E0	AA	E0	12	E0	6B	E0	F0	6B	E0	F0	12
80	Home	E0	2A	E0	47	E0	C7	E0	AA	E0	12	E0	6C	E0	F0	6C	E0	F0	12
81	End	E0	2A	E0	4F	E0	CF	E0	AA	E0	12	E0	69	E0	F0	69	E0	F0	12
83	\uparrow	E0	2A	E0	48	E0	C8	E0	AA	E0	12	E0	75	E0	F0	75	E0	F0	12
84	\downarrow	E0	2A	E0	50	E0	D0	E0	AA	E0	12	E0	72	E0	F0	72	E0	F0	12
85	PgUp	E0	2A	E0	49	E0	C9	E0	AA	E0	12	E0	7D	E0	F0	7D	E0	F0	12
86	PgDn	E0	2A	E0	51	E0	D1	E0	AA	E0	12	E0	7A	E0	F0	7A	E0	F0	12
89	\rightarrow	E0	2A	E0	4D	E0	CD	E0	AA	E0	12	E0	74	E0	F0	74	E0	F0	12
203	Win	E0	2A	E0	5B	E0	DB	E0	AA	E0	12	E0	1F	E0	F0	1F	E0	F0	12
204	Арр	E0	2A	E0	5D	E0	DD	E0	AA	E0	12	E0	2F	E0	F0	2F	E0	F0	12

 Table D-3
 Scan codes in Numlock mode

Table D-4 Scan codes with Fn key

Сар			Code	set 1		Code set 2						
No.	Keytop	Ν	lake	В	reak	М	ake	Break				
43	ENT	E0	1C	E0	9C	E0	5A	E0	F0	5A		
58	CTRL	E0	1D	E0	9D	E0	14	E0	F0	14		
60	LALT	E0	E0 38		B8	E0	11	E0	F0	11		
121	ARROW		45		C5		77) .	77		
122	NUMERIC	45			C5		77) .	77		
123	Scrl		46		C5	-	7E	F0 7		7E		

Сар	Ka	ytop		Cod	e set 1			C	ode set	2	
No.	Ne	ytop	Ма	ake	Break		Make		Break		
09	8	(8)	2	48	С	8	7	5	F0		75
10	9	(9)	2	49	С	9	7	D	F0		7D
11	0	(*)	3	37	В	7	7	С	F0		7C
23	U	(4)	4	1B	С	В	6	В	F0		6B
24	Т	(5)	4	łC	С	С	7	3	F0		73
25	0	(6)	4	1D	С	D	7	4	F0		74
26	Р	(-)	4	1A	С	A	7	В	F0		7B
37	J	(1)	2	4F	С	F	6	9	F0		69
38	к	(2)	5	50	D	0	7	2	F0		72
39	L	(3)	5	51	D	1	7.	A	F0		7A
40	;	(+)	4	1E	С	E	7	9	F0		79
52	М	(0)	52		D2		70		F0		70
54		(.)	5	53	D	3	7	1	F0		71
55	/	(/)	E0	35	E0	B5	40	4A	E0	F0	4A

Table D-5 Scan codes in overlay mode

Table D-6 No.124 key scan code

Key	Shift				Code	e set '	1							Code	set 2	2			
top	Shint	Make			Break			Make			Break								
Prt Sc	Common	E0	2A	E0	37	E0	B7	E0	AA	E0	12	E0	7C	E0	F0	7C	E0	F0	12
	Ctrl +		E0	37			E0	B7			E0	7C			E0	F0	7C		
	Shift +		E0	37			E0	B7			E0	7C			E0	F0	7C		
	Alt +			54			D4					84			F0	B4			

Key top	Shift	Code set 1				Code set 2									
top		Make						Make							
Pause	Common*	E1	1D	45	E1	9D	C5	E1	14	77	E1	F0	14	F0	77
	Ctrl*	E0	46	E0	C6			E0	7E	E0	F0	7E			

Table D-7 No.126 key scan code

*: This key generates only make codes.

Appendix E Key Layout

E.1 United Kingdom (UK) Keyboard

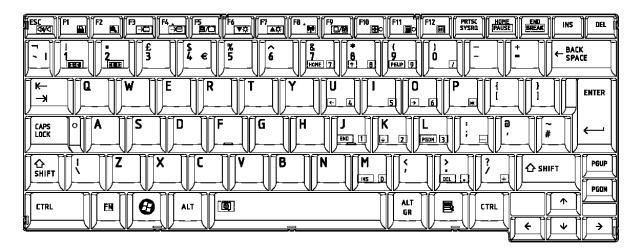


Figure E-1 UK keyboard

E.2 United States (US) Keyboard

$ \begin{array}{c c c c c c c c c c c c c c c c c c c $	
	_
SHIFT Z X C V B N M ;	PGUP

Figure E-2 US keyboard

E.3 Thai Keyboard

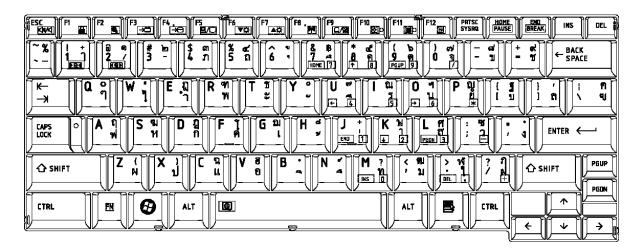


Figure E-3 Thai keyboard

E.4 Canadian French Keyboard

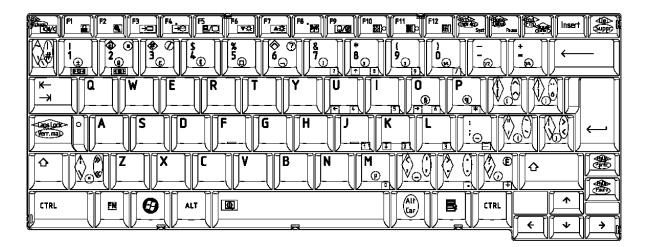
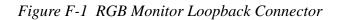


Figure E-4 Canadian French keyboard

Appendix F Wiring diagrams

F.1 RGB Monitor Loopback Connector

(1) RED	 RED	(1)
(2) GREEN	 GREEN	(2)
(3) BLUE	 BLUE	(3)
(4) MNTID2	 MNTID2	(4)
(5) GND	 GND	(5)
(6) GND	 GND	(6)
(7) GND	 GND	(7)
(8) GND	 GND	(8)
(9) NC	 NC	(9)
(10) GND	 GND	(10)
(11) MNTID1	 MNTID1	(11)
(12) MNTIDO	 MNTIDO	(12)
(13) HSYNC	 HSYNC	(13)
(14) VSYNC	 VSYNC	(14)
(15) MNTID3	 MNTID3	(15)



F.2 LAN Loopback Connector

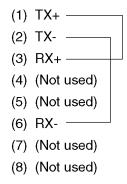


Figure F-2 LAN Loopback Connector

F-2

Appendix G BIOS Rewrite Procedures

This Appendix explains how to rewrite the system BIOS program when you update the system BIOS.

Tools

To rewrite the BIOS, you need the following tool:

□ BIOS/EC/KBC rewriting disk

Rewriting the BIOS

- 1. Set the system to boot mode.
- 2. Turn off the power to the computer.
- 3. Remove the external cables and cards.
- 4. Connect an external FDD and insert the BIOS rewriting disk into the external FDD.
- 5. Turn on the power while holding down the tilde character key until a beep sounds.

For example



- 6. The BIOS rewriting starts.
- 7. When the process is completed, it beeps and the system automatically reboots.

NOTE: 1. Connect the AC adapter to the computer when you rewrite the BIOS.

- 2. Do not turn off the power while you are rewriting the BIOS. If the rewrite fails, it might be impossible to start up the computer.
- 3. If you fail to rewrite BIOS, then when you next turn on the power, a message may be displayed that the contents of the BIOS have been erased. In this case, insert the BIOS rewriting disk and the BIOS will be rewritten.

Appendix H EC/KBC Rewrite Procedures

This Appendix explains how to rewrite the EC/KBC system program when you update the EC/KBC system.

It is necessary to rewrite the EC/KBC system program when the following changes are made.

- 1. Replacing of system board
- 2. Replacing of LCD

Tools

To rewrite the EC/KBC, you need the following tool:

EC/KBC rewriting disk for the computer

Rewriting the EC/KBC

NOTE:	1.	Rewrite the EC/KBC only when instructed by a diagnostic disk release notice.
	2.	Connect the AC adaptor to the computer when you rewrite the EC/KBC.
	3.	Do not turn off the power while you are rewriting the EC/KBC. If the rewrite fails, it might be impossible to start up the computer.
	4.	If you fail to rewrite EC/KBC, then when you next turn on the power, a message may be displayed that the contents of the EC/KBC have been erased. In this case, insert the EC/KBC rewriting disk, and the EC/KBC will be rewritten.
	5.	Normally it takes about 30 seconds to rewrite the EC/KBC. It may take 3 minutes (maximum), depending on the conditions of the computer or ICs. The computer is not hung up. Allow sufficient time. Never reboot or turn off the power to the computer before the rewriting is completed.
1. Set	the	system to boot mode.
2. Tu	rn o	ff the power to the computer.

- 3. Remove the external cables and cards.
- 4. Connect an external FDD and insert the EC/KBC rewriting disk into the external FDD.
- Turn on the power while holding down the **Tab** key. (Keep holding down the key until a beep sounds.) The EC/KBC rewriting starts.
- 6. When the EC/KBC rewrite is completed, the system is automatically turned off.

Appendix I Reliability

Appendix I Reliability

The following table shows MTBF (Mean Time Between Failures) in maximum configuration.

Table I-1 MTBF

Time (hours)	
5,007 h	

I-2